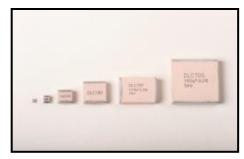






Passive Plus (PPI) specializes in Magnetic & Non-Magnetic HI-Q Components, supplying reliable quality components to the Aerospace, Telecommunications, Medical Semiconductor, and Military industries.



Marking shown for illustration purposes only. Actual marking may differ.

PPI is an American (New York), Woman owned Business.

- PPI is ISO9001:2015 certified.
- S level reliability
- Mil C 55681
- Mil C 123
- EAR 99 Compliant
- No ITAR Issues
- Export Compliant
- RoHS and REACH Compliant

PPI has been audited by some of the largest and most successful companies in the world and has received extremely high audit ratings. We believe our audit ratings are best in class. PPI isknown for Outstanding Customer Service and RF Engineering Support.





#### **Product Features**

- High Q
- High Power
- Low ESR/ESL
- Low Noise
- High Self-Resonance
- Ultra Stable Performance

## Product Applications

#### **Typical Functional Applications:**

- Tuning Bypass Coupling
- Feedback D.C. Blocking
- Impedance Matching

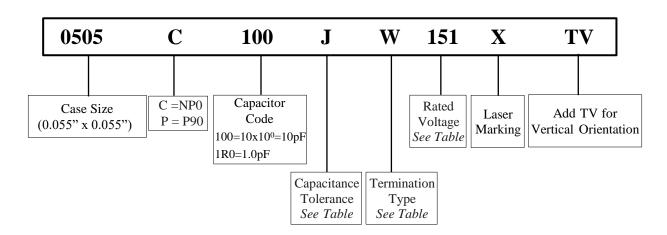
# SECTION SECTIO

Marking shown for illustration purposes only. Actual marking may differ.

#### **Typical Circuit Applications:**

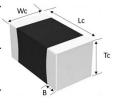
- UHF/Microwave RF Power Amplifiers
- Mixers Oscillators Filter Networks
- Low Noise Amplifiers Timing Circuits and Delay Lines

# Part Numbering



# **‡** Case Size (Chip) Dimensions

	0505	1111	2225	3838	6040	7676
Length (L <sub>c</sub> )	0.055 + 0.015 to -0.010 (1.40 +0.38 to -0.25)	0.110 + 0.020 to -0.010 (2.79 +0.51 to -0.25)	0.225 -0.010+0.25 (5.72 -0.25+ 0.64)	0.380 -0.010+0.015 (9.65 -0.25+0.38)	0.614 -0.010+0.015 (15.6 -0.25+0.38)	0.760 -0.010+0.015 (19.3 -0.25+0.38)
Width (W <sub>c</sub> )	$0.055 \pm .010$ $(1.40 \pm 0.25)$	$0.110 \pm 0.010$ $(2.79 \pm 0.25)$	$0.250 \pm 0.015$ $(6.35 \pm 0.38)$	0.380 ±0.010 (9.65±0.25)	0.433±0.010 (11.0±0.25)	0.760±0.010 (19.3±0.25)
Thickness (T <sub>c</sub> )	0.057 (1.45 max)	0.10 (2.54 max)	0.165 (4.19) max	0.170 (4.32) max	0.154±0.008 (3.90±0.20) max	0.154±0.008 (3.90±0.20) max
Overlap (B)	0.02 (0.51max)	0.024 (0.60max)	0.020~0.047 (0.50~1.20) max	0.024~0.059 (0.60~1.50)	0.063 (1.60)	0.063 (1.60)







## **Temperature Coefficient**

C: -55°C to 125°C  $0\pm30$ ppm/°C; >125 °C to 200°C  $0\pm60$ ppm/°C

 $P: +90\pm20 ppm/^{\circ}C$ 

## **Rated Capacitance**

Capacitance is less than 10pF; for example: 1R0=1.0pF, R denotes decimal point Capacitance greater than 10pF; for example: 101=100pF, the third number is the power of 10

### **Tolerance**

Capacitance Tolerance								
Code	A	В	C	D	F	G	J	K
Tolerance	±0.05pF	±0.1pF	±0.25pF	±0.5pF	±1%	±2%	±5%	±10%

# **Termination Types and Codes**

		Magnetic		$\bigcirc$		Non-Magne	tic 🔗
Termir Coo		Туре	Magnetic Termination	Termina Code		Туре	Non-Magnetic Terminations
W	RóH	Chip	100% Sn Solder over Nickel Plating	P	RoHS	Chip	100% Sn Solder over Copper Plating
L		Chip	90% Sn10%Pb Tin/Lead Solder	MN	RoHS	Microstrip	_
			over Nickel Plating	AN	RoHS	Axial Ribbon	<ul><li>Silver-Plated</li></ul>
M	S ROH	Microstrip	_	FN	RoHS	Radial Ribbon	Copper
Al	R KoH	Axial Ribbon		RN	RoHS	Axial Wire	_
RI	RoH	Radial Ribbon	Silver-Plated Copper	BN	RoHS	Radial Wire	_
RV	V ROHS	Axial Wire					
AV	V ROHS	Radial Wire	_				





## **≠** Voltages

Code	Rated Voltage	Code	Rated Voltage
500	50V	152	1500V
101	100V	202	2000V
151	150V	252	2500V
201	200V	302	3000V
301	300V	362	3600V
501	500V	502	5000V
102	1000V	722	7200V

# **‡** Laser Marking

An "X" at the end of the part number indicates the part is marked.

# **†** Packing Orientation Option

TV: Tape carrier packaging Vertical Orientation.

Vertical orientation means that if the part is lifted from the tape without any rotation and placed on a substrate, its electrodes will be perpendicular to the substrate plane. This impacts the frequency of First Parallel Resonance (suckout).

# **÷** Performance Requirements

Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.

All products are in compliance with RoHS instruction.





# 0505C/P (0.055" x 0.055")

#### **Product Features**

- High Q
- High Power
- Low ESR/ESL
- Low Noise
- High Self-Resonance
- Ultra Stable Performance
- Capacitance Range: 0.1pF to 1000pF
- Working Voltage: 150V
- Extended Voltage: 300V

# **Product Applications**

#### **Typical Functional Applications:**

- Tuning Bypass Coupling
- Feedback D.C. Blocking
- Impedance Matching

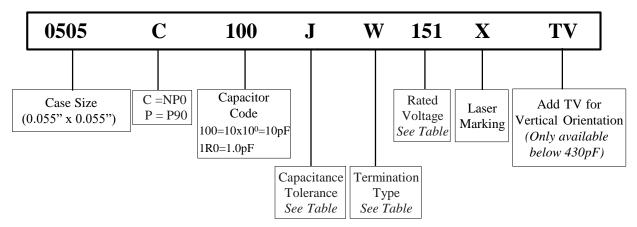
#### **Typical Circuit Applications:**

- UHF/Microwave RF Power Amplifiers
- Mixers Oscillators Filter Networks
- Low Noise Amplifiers Timing Circuits and Delay Lines



Marking shown for illustration purposes only. Actual marking may differ.

# **Part Numbering**



# **Capacitance Tolerance Codes**

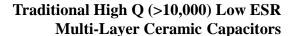
Code	A	В	C	D	F	G	J	K
Tol.	±0.05pF	±0.1pF	±0.25pF	±0.5pF	±1%	±2%	±5%	±10%

# **Voltage Codes**

Voltage	Code	Voltage	Code
50V	500	200V	201
100V	101	250V	251
150V	151	300V	301

Please note that the contents of this document are subject to change at any time at PPI's sole discretion. The most up-to-date version of this document is available at www.passiveplus.com







# **≠** 0505C/P Capacitance Values

- NP0=C; P90=P
- Maximum Capacitance: 0505P=100pF; 0505C=1000pF
- \* Available in NP0 only.

Special capacitances, tolerances and WVDC are available. Please contact PPI.



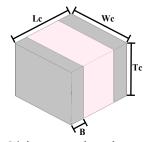
pF         Code         Tol.         Std.         Ext.         pF         Code         Tol.	Rated WVDC
0.2         0R2         0R2         2.7         2R7         3.0         3R0         3R0         3.0         3R0         24         240         240         200         201*         F,G, J,K         220         221*         250V         270         270         270         271*         270         270         271*         270         271*         270         271*         270         271*         270         271*         270         271*         270         271*         270         271*         300V         300V         36         360         360         301*         300V         36         360         361*         330         331* <t< th=""><th>Std. Ext.</th></t<>	Std. Ext.
0.3         0R3         0R4         0R4         0R4         0R4         0R5         <	
0.4         0R4         0R4         3.3         3R3         3R3         3R3         3R3         3R6         3R6         3R6         3R6         3R6         3R6         3R9         <	
0.4         0R4         0R5         3.3         3R3         3R3         3R3         3R3         3R6         3R9         <	
0.5       0R5       0.6       0R6       3.9       3R9       389       390       390       390       390       300       301*       301*       301*       301*       301*       301*       301*       301*       301*       301*       301* <td< th=""><th>150V 200V</th></td<>	150V 200V
0.6       0R6       3.9       3R9       3	
0.7       0R7       0R8       4.3       4R3       A,B,C,D       4.7       4R7       4R7       4R7       4R7       4R7       4R7       5.1       5R1       5R6       5R6       4.7       47       470       390       391*       390       391*         1.0       1R0       1R1       1R1       A,B,C,D       1SOV or 300V       6.2       6R2       6R2       6R2       51       510       51       510       470       471*       470*       470*       470       470       470       470       470*       470	
0.8       0R8       4.7       4R7       A,B,C,D       150V or 300V       39       390       330       331*         0.9       0R9       5.1       5R1       5R6       5R6       43       430       360       361*         1.0       1R0       5.6       5R6       5R6       47       470       390       391*         1.1       1R1       A,B,C,D       150V or 300V       6.2       6R2       6R2       51       510       51       510       430       431*       F,G, 470       J,K         1.2       1R2       C,D       6.8       6R8	
0.9     0R9       1.0     1R0       1.1     1R1       1.2     1R2       1R2     C,D       5.1     5R1       5.6     5R6       47     470       47     470       47     470       43     430       43     430       47     470       51     510       56     560       470     471*       1,K	
1.0     1R0       1.1     1R1       1.2     1R2       1R2     1R2       5.6     5R6       6.2     6R2       6.2     6R2       6.3     6R2       51     510       56     560       470     470       470     471*       470     471*       470     471*       470     471*	
1.1 1R1 A,B, C,D 150V or 300V 6.8 6R8 56 560 560 431* F,G, 470 471*	
1.2 1R2 C,D SOV 6.8 6R8 56 560 470 471* J,K	4501
3007	150V N/A
<b>1.3</b> 1R3   <b>7.5</b> 7R5   <b>62</b> 620   <b>510</b> 511*	
<b>1.4</b> 1R4   <b>8.2</b> 8R2   <b>68</b> 680   <b>560</b> 561*	
1.5 1R5 9.1 9R1 75 750 620 621*	
16 186 10 100 82 820 FG 680 681*	
1.7 1R7   110   91 910   J,K   150V 200V   750 751*	
1.9 1P9 100 101 930 931* F,G,	50V 100V
10 100 F,G, 150V or 110 111*	
2.0 2R0   15 150   J,K 300V 120 121*   1000 102*	
2.0 2R0	
2.1 2R1	

\*Available in NP0 only





# **Termination Types and Codes**



Chip Termination: Codes: W, L, P

Magnetic Terminations					
<b>Termination Code</b>	Termination				
W (ROHS)	100% Tin Solder over Nickel Barrier				
L	90%Tin/10%Lead Solder over Nickel Barrie				
Non-Magnetic Terminations 🔗					
<b>Termination Code</b>	Termination				
P Rohs	100% Tin Solder over Copper Barrie				

# **Dimensions** Unit: inch (millimeter)

Magnetic Termination								
Code		Length		Width	Thickness	Overlap		
		]	Lc	Wc	Tc	В		
W/L	Chin	0.055	+0.015 -0.010	$0.055 \pm 0.010$	0.057 max	$0.014 \pm 0.006$		
W/L	Chip (1.	(1.40	+0.38 -0.25 )	$(1.40 \pm 0.25)$	(1.45 max)	$(0.356 \pm 0.152)$		

<b>②</b>		<b>⊘</b>				
Code		Length		Width	Thickness	Overlap
			Lc	Wc	Tc	В
D	Chin	0.055	+0.015 -0.010	$0.055 \pm 0.010$	0.057 max	$0.014 \pm 0.006$
P Chip	Cmp	(1.40	+0.38 -0.25 )	$(1.40 \pm 0.25)$	(1.45 max)	$(0.356 \pm 0.152)$

Note: "Non-Magnetic" means no magnetic materials.





## **#** Electrical Specifications

Quality Factor (Q)	Greater than 10,000 at 1 MHz			
Insulation Resistance (IR)	10 <sup>5</sup> MegaOhms min. @ +25°C rated WVDC 10 <sup>4</sup> MegaOhms min. @ +125°C rated WVDC			
Rated Voltage	See Rated Voltage in Capacitance Table			
Dielectric Withstanding Voltage (DWV)	250% of Rated Voltage of 5 seconds			
Operating Temperature Range	-55°C to 200°C			
Temperature Coefficient (TC)	C: -55°C to 125°C 0±30ppm/°C; >125°C to 200°C 0±60ppm/°C P: -55°C to 200°C +90±20ppm/°C			
Capacitance Drift	$\pm 0.02\%$ or $\pm 0.02$ pF, whichever is greater			
Piezoelectric Effects	None			
Termination Type	See Termination Type Table			

Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.

# **‡** Environmental Specifications

a	• 6•	4 •
Sn	ecitio	cation

#### **Test Parameters**

Thermal Shock	<b>DWV:</b> The initial Value <b>IR:</b> Shall not be less than 30% of the initial value. <b>Capacitance Change:</b>	MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 200°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles.				
Moisture Resistance	No more than 0.5% or 0.5pF, whichever is greater.	MIL-STD-202, Method 106				
Humidity (Steady State)	DWV: The initial Value IR: The initial value. Capacitance Change: No more than 0.5% or 0.5pF, whichever is greater.	MIL-STD-202, Method 103, Condition A With 1.5Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours minimum.				
Life	IR: Shall not be less than 30% of the initial value.  Capacitance Change:  No more than 2.0% or 0.5pF, whichever is greater.	MIL-STD-202, Method 108. For 2000 hours, at 200°C. Rated Voltage DC applies.				
Terminal Strength	Force: 10lbs typical, 5lbs. Minimum.  Duration Time: 5 to 10 seconds	MIL-STD-202, Method 211A, Test Condition A. Applied a force and maintained for a period of 5 to 10 seconds. The force shall be in the direction of the axes of the terminations.				



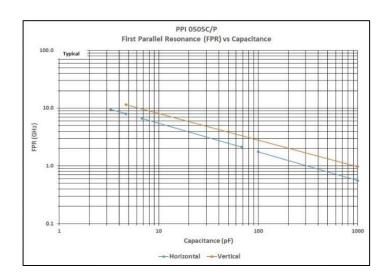


#### **FPR** -- First Parallel Resonance (FPRs)

#### **#** Definitions and Measurement Conditions

The **First Parallel Resonance**, **FPR**, is defined as the lowest frequency at which a suckout or notch appears in |S21|.

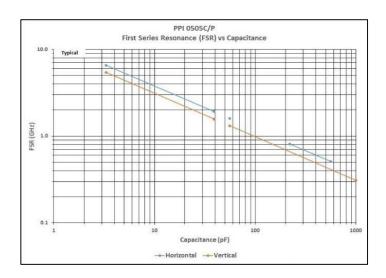
It is generally independent of substrate thickness or dielectric constant, but does depend on capacitor orientation. A horizontal orientation means the capacitor electrode planes are parallel to the plane of the substrate; a vertical orientation means the electrode planes are perpendicular to the substrate.



#### **FSR** -- First Series Resonance (FSRs)

#### **#** Definitions and Measurement Conditions

The First Series Resonance, FSR, is defined as the lowest frequency at which the imaginary part of the input impedance, Im[Zin], equals zero. Should Im[Zin] or the real part of the input impedance, Re[Zin], not be monotonic frequency at frequencies lower than those which Im[Zin] =0, the FSR shall be considered as undefined (represented as a gap in the plot). FSR is dependent internal capacitor on structure: substrate thickness and dielectric constant; capacitor orientation, as defined alongside the FPR plot; and mounting pad dimensions.



The measurement conditions are: substrate – Rogers RO4350; substrate dielectric constant = 3.66; horizontal mount substrate thickness (mils) =25; gap in microstrip trace (mils) = 15; horizontal mount microstrip trace width (mils) = 55. Reference planes at sample edges.

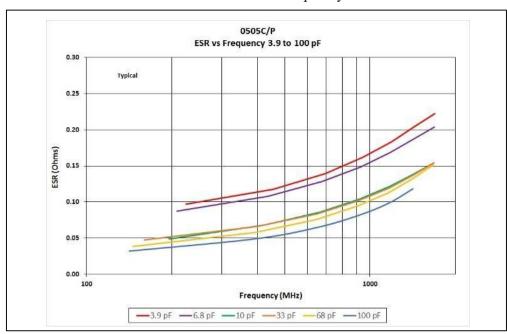
All data has been derived from electrical models created by Modelithics, Inc., a specialty vendor contracted by PPI. The models are derived from measurements on a large number of parts disposed on several different substrates.





# **=** ESR vs. Frequency





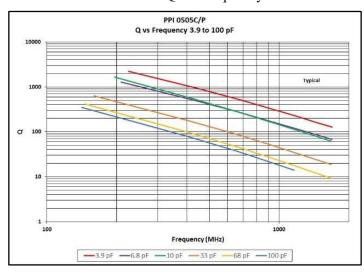
#### 0505C ESR vs Frequency



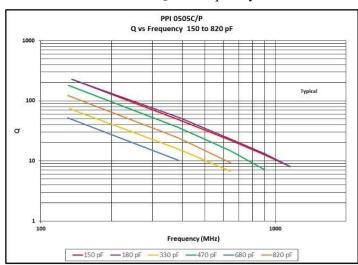


# 茾 Q vs. Frequency

0505C/P Q vs Frequency

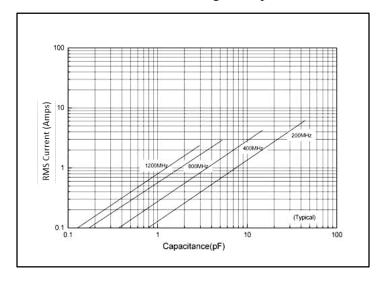


0505C Q vs Frequency

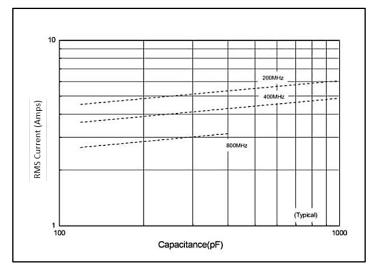


# Current Rating vs. Capacitance

#### 0505C/P Current Rating vs Capacitance



#### 0505C Current Rating vs Capacitance



Current limits can depend on two different criteria. The first Voltage Limited Current ( $I_{volt lim}$ , represented by the solid line), the second is Power Dissipation Limited Current ( $I_{pow \ diss}$ ).

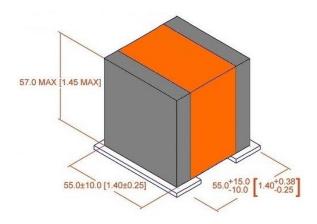
$$I_{\text{volt lim}} = \frac{\sqrt{2}}{2} I_{peak} = \frac{\sqrt{2}}{2} \times \frac{V_{rated}}{X_C} = \sqrt{2} \pi FCV_{rated}$$

 $I_{pow \ diss} = \sqrt{\frac{P_{dissipation}}{ESR}}$  (If the thermal resistance of the mounting surface is 40°C/W, then you will reach the power dissipated limit of 1.5W)



#### **†** Capacitor Application Program

PPI's brand new online Capacitor Application Program (C.A.P.) helps Engineers and Designers select capacitors according to parameters such as cap value and frequency. C.A.P. allows engineers to insert capacitors requirements (Cap value, Frequency), producing Scattering Matrices (S2P) Charts while providing options (Case Size, Terminations, Mounting), and parameters (ESR, Q, Impedance) along with Datasheets. Once engineers have determined their capacitor requirements, C.A.P. also includes online Requests For Quotes (RFQs) and/or sample requests.



# **≠** Modelithics Vendor Program

PPI offers design engineers a Free 90-Day Trial license for the Modelithics PPI Component Library. This program provides engineers access to extremely accurate scalable simulation models for Passive Plus capacitors with advanced features that enable a more precise and rapid design process.

Microwave Global Models include every part value in a series and permit users to input substrate thickness, dielectric constant, and loss tangent, as well as mounting pad layout dimensions. Selected models also include capacitor orientation – vertical or horizontal – as an input. Engineers can request FREE use of the models by visiting the https://www.modelithics.com/MVP/PPI.

# *##Modelithics*®

#### # Recommended Land Pattern Dimensions

Regarding Landing Patterns, please refer to IPC-7351B (table 3-5, 3-6).





0505C/P (0.055" x 0.055"

# **Tape & Reel Specifications**

Orientation	Measurement Unit	W	Р0	P1	T	F	Minimum Qty per Reel	Std Qty per Reel	Tape Material
Н	in.	0.315	0.157	0.157	0.009	0.138	500	3000	
	mm	8.00	4.00	4.00	0.22	3.50	500	3000	Plastic
V	in.	0.472	0.157	0.157	0.012	0.217	500	2000	Flastic
v	mm	12.00	4.00	4.00	0.30	5.50	300	2000	
-  -	<u>T</u>	PO	1						

Note: Vertical Tape & Reel not available for all values. Contact PPI for availabilty.



- Determined by component size. Typical clearance between the cavity and the component is: .50 (.002) min to .65 (.026) max for 12mm tape.
- The component cannot rotate more than 20° within the determined cavity.

# **Engineering Design Kits**

K0

PPI offers Design Kits for engineers who are building and testing prototypes. Each kit contains 16 values;10 pieces per value.



Kits are offered in Magnetic or Non-Magnetic Terminations. Kits are 100% RoHS compliant.

	Values	Value	Kit Number			
	v alues	Range	NON-MAGNETIC	MAGNETIC		
1	01 02 02 04 05 06 07 08 00 10 12 15 16 18 20mE	0.1 2.0mE	DKD0505C05	DKD0505C01		
RoHS	0.1, 0.2, 0.3, 0.4, 0.5, 0.6, 0.7, 0.8, 0.9, 1.0, 1.2, 1.5, 1.6, 1.8, 2.0pF	0.1 - 2.0pF	DKD0505P05	DKD0505P01		
-	10 12 15 10 20 22 24 27 20 22 20 47 56 60 02 10mE	1 10mE	DKD0505C06	DKD0505C02		
RoHS	1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7, 3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2, 10pF	1 - 10pF	DKD0505P06	DKD0505P02		
- 1	10 12 15 19 20 22 24 27 20 22 20 47 56 69 92 100mE	10 100-E	DKD0505C07	DKD0505C03		
RoHS	10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 82, 100pF	10 - 100pF	DKD0505P07	DKD0505P03		
00pF <b>1</b>	100, 120, 150, 180, 200, 220, 240, 270, 300, 330, 390, 470, 560, 680, 820, 100	100 - 1000pF	DKD0505C08	DKD0505C04		
ROHS	100, 120, 120, 100, 200, 220, 210, 270, 200, 220, 170, 200, 000, 020, 100	100 1000P1	2122 00 00 000	BILD OF OF CO.		





# 1111C/P (0.110"x 0.110")

#### Product Features

- High Q
- High Power
- Low ESR/ESL
- Low Noise
- High Self-Resonance
- Ultra Stable Performance
- Capacitance Range: 0.1pF to 1000pF
- Working Voltage: 500V
- Extended Voltage: 1500V

# **÷** Product Applications

#### **Typical Functional Applications:**

- Tuning Bypass Coupling
- Feedback D.C. Blocking
- Impedance Matching

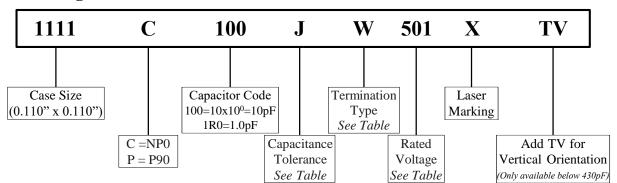
#### **Typical Circuit Applications:**

- UHF/Microwave RF Power Amplifiers
- Mixers Oscillators Filter Networks
- Low Noise Amplifiers Timing Circuits and Delay Lines



Marking shown for illustration purposes only. Actual marking may differ.

# Part Numbering



# *‡* Capacitance Tolerance Codes

Code	A	В	C	D	F	G	J	K
Tol.	±0.05pF	±0.1pF	±0.25pF	±0.5pF	±1%	±2%	±5%	±10%

# **≠** Voltage Codes

Voltage	Code	Voltage	Code
50V	500	500V	501
100V	101	600V	601
200V	201	1000V	102
300V	301	1500V	152





# 1111C/P (0.110"x 0.110")

# 1111C/P Capacitance Values

- NP0=C; P90=P
- Maximum Capacitance: 1111P=1000pF; 1111C=10000pF
- \* Available in NPO only.

Special capacitances, tolerances and WVDC are available. Please contact PPI.



Marking shown for illustration purposes only. Actual marking may differ.

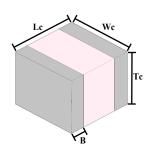
Cap.	Сар		Rated \	WVDC	Cap.	Сар		Rated \	WVDC	Cap.	Сар		Rated	WVDC	Cap.	Сар		Rated \	WVDC	
pF	Code	Tol.	Std.	Ext.	рF	Code	Tol.	Std.	Ext.	рF	Code	Tol.	Std.	Ext.	pF	Code	Tol.	Std.	Ext.	
0.1	0R1				3.3	3R3				36	360				390	391	F.C			
0.2	OR2	A,B	500V	1000V or	3.6	3R6				39	390				430	431	F,G, J,K	200V	600V	
0.3	0R3	۸,۵	3001	1500V	3.9	3R9				43	430				470	471	- ,			
0.4	0R4				4.3	4R3				47	470				510	511				
0.5	OR5				4.7	4R7	A,B			51	510		500V		560	561				
0.6	OR6				5.1	5R1		500V	1000V or	56	560	F,G,		1000V or	620	621				
0.7	OR7				5.6	5R6	C,D	1500V	62	620	J,K		1500V	680	681	F,G,	100V	200V		
0.8	OR8					6.2	6R2				68	680				750	751	J,K	1000	200 V
0.9	OR9				6.8	6R8				75	750				820	821				
1.0	1R0				7.5	7R5				82	820				910	911				
1.1	1R1				8.2	8R2				91	910				1000	102				
1.2	1R2				9.1	9R1				100	101				1100	112*				
1.3	1R3				10	100				110	111				1200	122*	F,G,	200V	N/A	
1.4	1R4	A D			11	110				120	121			1000V	1500	152*	J,K	2000	IN/A	
1.5	1R5	A,B, C,D	500V		12	120				130	131				1800	182*				
1.6	1R6	-,-		1500V	13	130				150	151	F,G, J,K	300V		2000	202*				
1.7	1R7				15	150				160	161	3,			2200	222*				
1.8	1R8				16	160	- 0		1000V	180	181				2700	272*				
1.9	1R9				18	180	F,G, J,K	500V	or	200	201				3000	302*	F,G, J,K	100V	N/A	
2.0	2R0				20	200	3,11		1500V	220	221				3300	332*	3,11			
2.1	2R1				22	220				240	241				4700	472*				
2.2	2R2				24	240				270	271	F,G,	200V	600V	5100	512*		<u> </u>		
2.4	2R4				27	270				300	301	J,K	2000	0007	5600	562*	F,G,	EOV/	NI/A	
2.7	2R7				30	300				330	331				10000	103*	J,K	1 50V N/A		
3.0	3R0				33	330				360	361									

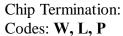
\*Available in NPO only

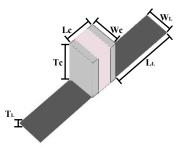


# 1111C/P (0.110"x 0.110")

# **Termination Types and Codes**







Microstrip Termination: Codes: MS, MN

Magnetic	Terminations
<b>Termination Code</b>	Termination
W ROHS	100% Tin Solder over Nickel Barrier
L	90%Tin/10%Lead Solder over Nickel Barrier
MS (ROHS)	100% Silver
Non-Magnet	ic T□r□ination□ �
	1000/ Tip

## 100% Tin Solder over Copper Barrier Silver-Plated Copper **MN**

#### **Dimensions** Unit: inch (millimeter)

	Magnetic Termination													
				Capacitor D	imensions		Lead Dimensions							
(	Code	Length		Width	Thickness	Overlap	Length	Width	Thickness					
			Lc	Wc	Tc	В	LL	WL	TL					
W/I	Chin	0.110	+0.025 -0.010	$0.110 \pm 0.010$	0.10 max	0.016 ~ 0.039		-						
W/L	Chip	(2.79	+0.36 -0.25 )	$(2.79 \pm 0.25)$	(2.54 max)	$(0.40 \sim 1.00)$	-		-					
MS	Microstrip	$0.135 \pm 0.015$		$0.110 \pm 0.010$	0.10 max	-	0.250 min	$0.093 \pm 0.010$	$0.004 \pm 0.001$					
1015		$(3.45 \pm 0.38)$		$(2.79 \pm 0.25)$	(2.54 max)	-	(6.35 min)	$(2.36 \pm 0.25)$	$(0.1 \pm 0.025)$					

<b>②</b>				Non-	Magnetic Ter	mination	_		<b>②</b>			
				Capacitor D	imensions			Lead Dimensions				
	Code	Le	ngth	Width	Thickness	Overlap	Length	Width	Thickness			
		Lc		Wc	Tc	В	LL	WL	TL			
P	Chip	0.110	+0.025 -0.010	$0.110 \pm 0.010$	0.10 max	0.016 ~ 0.039			-			
r	Cmp	(2.79	+0.36 -0.25 )	$(2.79 \pm 0.25)$	(2.54 max)	$(0.40 \sim 1.00)$	-	-				
MN	Microstrip	0.135	± 0.015	$0.110 \pm 0.010$	0.10 max	-	0.250 min	$0.093 \pm 0.010$	$0.004 \pm 0.001$			
IVIIN		(3.45	$\pm 0.38$ )	$(2.79 \pm 0.25)$	(2.54 max)	-	(6.35 min)	$(2.36 \pm 0.25)$	$(0.1 \pm 0.025)$			

Note: Non-Magnetic means no magnetic materials. All leads are attached with high temperature solder and parts are RoHS Compliant.





# **#** Electrical Specifications

Quality Factor (Q)	Greater than 10,000 at 1 MHz  0.1pF to 470pF: 10 <sup>6</sup> Megaohms min. @ +25°C rated WVDC 10 <sup>5</sup> Megaohms min. @ +125°C rated WVDC 510pF to 1000pF: 10 <sup>5</sup> Megaohms min. @ +25°C rated WVDC 10 <sup>4</sup> Megaohms min. @ +125°C rated WVDC							
Insulation Resistance (IR)								
Rated Voltage	See Rated Voltage in Capacitance Table							
Dielectric Withstanding Voltage (DWV)	250% of Rated Voltage of 5 seconds, Rated Voltage ≤ 500VDC 150% of Voltage for 5 seconds, 500VDC <rated 1250="" vdc<br="" voltage="" ≤="">120% of Voltage for 5 seconds, Rated Voltage &gt; 1250 VDC</rated>							
Operating Temperature Range	-55°C to 200°C							
Temperature Coefficient (TC)	C: -55°C to 125°C							
Capacitance Drift	±0.02% or ±0.05pF, whichever is greater							
Piezoelectric Effects	None							
Termination Type	See Termination Type Table							

Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.

# **=** Environmental Specifications

#### **Specification**

#### **Test Parameters**

	Specification	1 est 1 in unicoers					
Thermal Shock	<b>DWV:</b> The initial Value <b>IR:</b> Shall not be less than 30% of the initial value. <b>Capacitance Change:</b>	MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 200°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles.					
Moisture Resistance	No more than 0.5% or 0.5pF, whichever is greater.	MIL-STD-202, Method 106					
Humidity (Steady State)	DWV: The initial Value IR: The initial value. Capacitance Change: No more than 0.3% or 0.3pF, whichever is greater.	MIL-STD-202, Method 103, Condition A With 1.5Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours minimum.					
Life	IR: Shall not be less than 30% of the initial value.  Capacitance Change:  No more than 2.0% or 0.5pF, whichever is greater.	MIL-STD-202, Method 108. For 2000 hours, at 200°C. 200% of Voltage for Capacitors, Rated Voltage ≤ 500VDC; 120% of Voltage for Capacitors, 500VDC< Rated Voltage ≤1250VDC; 100% for Voltage for Capacitors, Rated Voltage >1250VDC					
Terminal Strength	Force: 10lbs typical, 5lbs. Minimum.  Duration Time: 5 to 10 seconds	MIL-STD-202, Method 211A, Test Condition A. Applied a force and maintained for a period of 5 to 10 seconds. The force shall be in the direction of the axes of the terminations.					



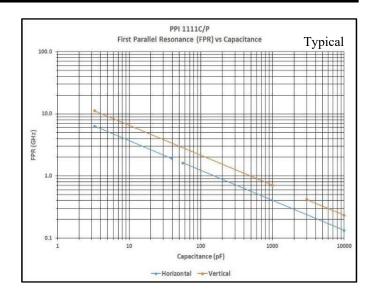
# 1111C/P (0.110"x 0.110"

#### **FPR** -- First Parallel Resonance (FPRs)

#### **Definitions and Measurement Conditions**

The First Parallel Resonance, FPR, is defined as the lowest frequency at which a suckout or notch appears in |S21|.

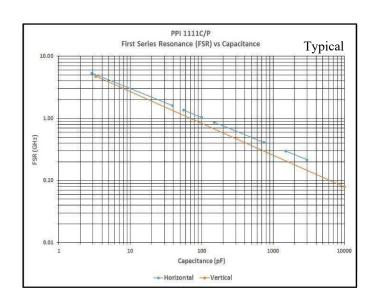
It is generally independent of substrate thickness or dielectric constant, but does depend on capacitor orientation. A horizontal orientation means the capacitor electrode planes are parallel to the plane of the substrate: a vertical orientation means the electrode planes are perpendicular to the substrate.



#### **FSR** -- First Series Resonance (FSRs)

#### **Definitions and Measurement Conditions**

The First Series Resonance, FSR, is defined as the lowest frequency at which the imaginary part of the input impedance, Im[Zin], equals zero. Should Im[Zin] or the real part of the input impedance, Re[Zin], not be monotonic frequency at frequencies lower than those which Im[Zin] =0, the FSR shall be considered as undefined (represented as a gap in the plot). FSR is dependent internal capacitor on structure: substrate thickness and dielectric constant; capacitor orientation, as defined alongside the FPR plot; and mounting pad dimensions.



The measurement conditions are: substrate – Rogers RO4350; substrate dielectric constant = 3.66; horizontal mount substrate thickness (mils) =25; gap in microstrip trace (mils) = 15; horizontal mount microstrip trace width (mils) = 55. Reference planes at sample edges.

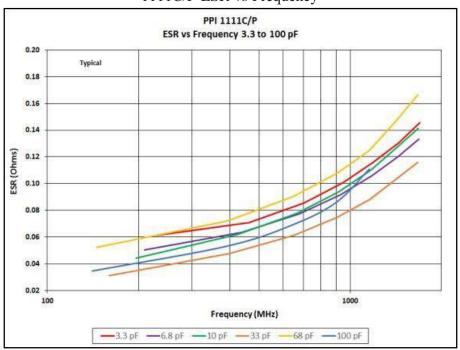
All data has been derived from electrical models created by Modelithics, Inc., a specialty vendor contracted by PPI. The models are derived from measurements on a large number of parts disposed on several different substrates.



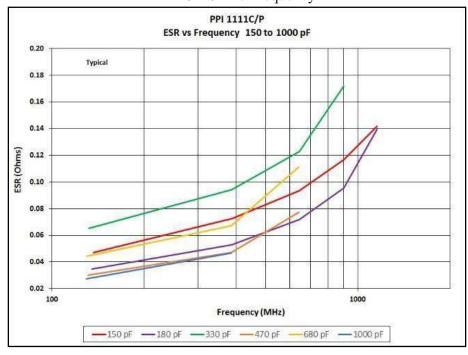


## **ESR** vs. Frequency

#### 1111C/P ESR vs Frequency



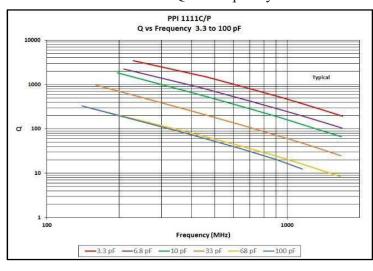
#### 1111C ESR vs Frequency



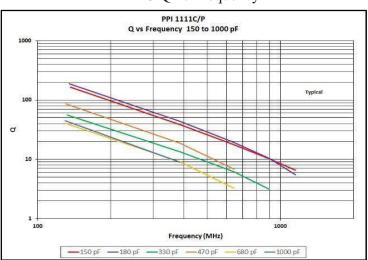


## Q vs. Capacitance

1111C/P Q vs Frequency

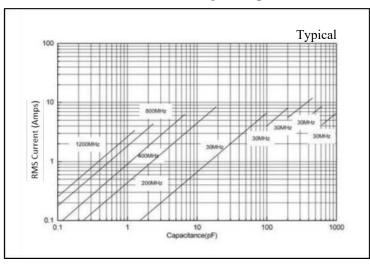


1111C Q vs Frequency

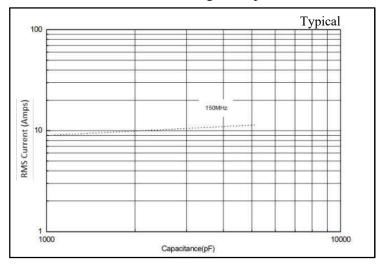


# **Current Rating vs. Capacitance**

#### 1111C/P Current Rating vs Capacitance



#### 1111C Current Rating vs Capacitance



Current limits can depend on two different criteria. The first Voltage Limited Current (Ivolt lim, represented by the solid line), the second is Power Dissipation Limited Current (Ipow diss).

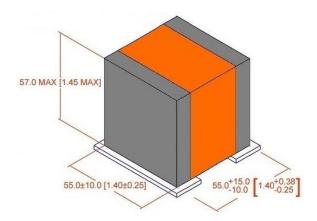
$$I_{\text{volt lim}} = \frac{\sqrt{2}}{2} I_{peak} = \frac{\sqrt{2}}{2} \times \frac{V_{rated}}{X_C} = \sqrt{2} \pi FCV_{rated}$$

 $\frac{P_{dissipation}}{ESR}$  (If the thermal resistance of the mounting surface is 20°C/W, then you will reach the power dissipated limit of 3W)



#### **#** Capacitor Application Program

PPI's brand new online Capacitor Application Program (C.A.P.) helps Engineers and Designers select capacitors according to parameters such as cap value and frequency. C.A.P. allows engineers to insert capacitors requirements (Cap value, Frequency), producing Scattering Matrices (S2P) Charts while providing options (Case Size, Terminations, Mounting), and parameters (ESR, Q, Impedance) along with Datasheets. Once engineers have determined their capacitor requirements, C.A.P. also includes online Requests For Quotes (RFQs) and/or sample requests.



# **#** Modelithics Vendor Program

PPI offers design engineers a Free 90-Day Trial license for the Modelithics PPI Component Library. This program provides engineers access to extremely accurate scalable simulation models for Passive Plus capacitors with advanced features that enable a more precise and rapid design process.

Microwave Global Models include every part value in a series and permit users to input substrate thickness, dielectric constant, and loss tangent, as well as mounting pad layout dimensions. Selected models also include capacitor orientation – vertical or horizontal – as an input. Engineers can request FREE use of the models by visiting the https://www.modelithics.com/MVP/PPI.

# **#Modelithics**®

#### **Recommended Land Pattern Dimensions**

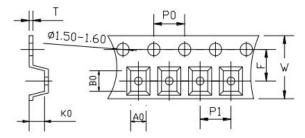
Regarding Landing Patterns, please refer to IPC-7351B (table 3-5, 3-6).





## **†** Tape & Reel Specifications

	Orientation	Measurement Unit	W	P0	P1	Т	F	Minimum Qty per Reel	Std Qty per Reel	Tape Material
•	Н	in.				0.009		500	2000	
		mm	8.00	4.00	4.00	0.22	3.50			
	V	in.	0.315	0.157	0.157	0.009	0.138	500	1500	Plastic
	v	mm	8.00	4.00	4.00	0.22	3.50	300	1500	1 lastic
	V	in.	0.472	0.157	0.157	0.016	0.217	500	1500	
	V	mm	12.00	4.00	4.00	0.40	5.50	300	1300	



#### $A_0B_0K_0$

- Determined by component size. Typical clearance between the cavity and the component is: .50 (.002) min to .65 (.026) max for 12mm tape.
- The component cannot rotate more than 20° within the determined cavity.

# **=** Engineering Design Kits

PPI offers Design Kits for engineers who are building and testing prototypes. Each kit contains 16 values;10 pieces per value.



Kits are offered in Magnetic or Non-Magnetic Terminations. Kits are 100% RoHS compliant.

Kit Number	Value	Values
MAGNETIC NON-MAGNETIC	Range	values
DKD1111C01 DKD1111C05	1.0 - 10pF	1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7, 3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2, 10pF
DKD1111P01 DKD1111P05	1.0 - 10pr	1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7, 3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2, 10pF
DKD1111C02 DKD1111C06	10 - 100pF	10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 82, 100pF
DKD1111P02 DKD1111P06	10 - 100pr	10, 12, 13, 16, 20, 22, 24, 27, 30, 33, 39, 47, 30, 06, 62, 100pr
DKD1111C03 DKD1111C07	100 - 1000pF	100, 120, 150, 180, 200, 220, 240, 270, 300, 330, 390, 470, 560, 680, 820,
DKD1111P03 DKD1111P07	100 - 1000pr	100, 120, 150, 180, 200, 220, 240, 270, 300, 330, 390, 470, 360, 680, 820, 1000pF
DKD1111C04 DKD1111C08	1000 - 10000pF	1000, 1100, 1200, 1500, 1800, 2000, 2200, 2700, 3000, 3300, 3900, 4700,
DKD1111P04 DKD1111P08	1000 - 10000pr	5100, 5600, 10000pF
Passive Plus Inc.  DKD1111C01	Passive Plus Inc.	DKD1111C03  Passive Plus Inc.  DKD1111C04
1111C Series 1.0 — 10pF	1111C Series 10 — 1	1111C Series 100 — 1000pF Size: 0.110" x 0.110" Size: 0.110" x 0.110"
TC = NP0 WVDC = 500V	TC = NPO WVDC = 500	
Hi-Q Low ESR Capacitor Design Kit	Hi-Q Low ESR Capacitor Des	
Passiva Plus Inc.  DKD1111P01  Passiva Plus Inc.	DKD1111P02	Passive Plus Inc.  DKD1111P03  DKD1111P04  Passive Plus Inc.
	Series 10 — 100pF	1111P Series 100 — 1000pF Size: 0.110" x 0.110" Size: 0.110" x 0.110" Size: 0.110" x 0.110"
	= P90 WVDC = 500V	Size: 0.110 × 0.110 Size: 0.110 × 0.110 TC = P90 WVDC = 500V TC = P90 WVDC = 100V
	w ESR Capacitor Design Kit	Hi-Q Low ESR Capacitor Design Kit Hi-Q Low ESR Capacitor Design Kit
www.passiveplus.com	eplus.com	www.passiveplus.com

2225C/P (0.220" x 0.250")

#### **Product Features**

- High Q
- High RF Current/Voltage
- Ultra Stable Performance
- Capacitance Range: 0.5pF to 2700pF
- Working Voltage: 2500V
- Extended Voltage: 3600V

# **†** Product Applications

#### **Typical Functional Applications:**

- Tuning Bypass Coupling
- Feedback D.C. Blocking
- Impedance Matching

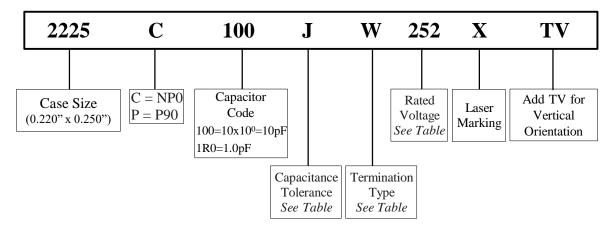
#### **Typical Circuit Applications:**

- UHF/Microwave RF Power Amplifiers
- Antenna Tuning Plasma Chambers
- Medical Equipment



Marking shown for illustration purposes only. Actual marking may differ.

# Part Numbering



# **Capacitance Tolerance Codes**

Code	A	В	C	D	F	G	J	K
Tol.	±0.05pF	±0.1pF	±0.25pF	±0.5pF	±1%	±2%	±5%	±10%

# **Voltage Codes**

Voltage	Code	Voltage	Code		
500V	501	2500V	252		
1000V	102	3000V	302		
1500V	152	3600V	362		
2000V	202				





# **≠** 2225C/P Capacitance Values

• NP0=C; P90=P

Special capacitances, tolerances and WVDC are available. Please contact PPI.

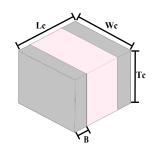


Cap.	Сар	Tol.		WVDC	Cap.	Сар	Tol.	Rated WVDC	Cap.	Сар	Tol.		WVDC	Cap.	Сар	Tol.		WVDC
pF	Code	101.	Std.	Ext.	рF	Code	101.	Std. Ext.	pF	Code	101.	Std.	Ext.	рF	Code	101.	Std.	Ext.
0.5	OR5				4.3	4R3			43	430				430	431	F,G,	1500V	1500V 2000V
0.6	OR6				4.7	4R7			47	470		2500V 3600V		470	471	J,K		
0.7	OR7				5.1	5R1			51	510			510	511				
0.8	OR8				5.6	5R6	B,C,		56	560			560	561				
0.9	OR9				6.2	6R2	В,С, D	2500V 3600V	62	620	F,G,		3600V	620	621			
1.0	1R0				6.8	6R8			68	680	J,K	23001	30001	680	681			
1.1	1R1				7.5	7R5			75	750				750	751	F,G,	1000\/	1500V
1.2	1R2				8.2	8R2			82	820				820	821	J,K	10007 13	1300 V
1.3	1R3			,	9.1	9R1			91	910				910	911			
1.4	1R4				10	100			100	101				1000	102			
1.5	1R5				11	110			110	111				1100	112			
1.6	1R6	B,C,	2500\/	3600V	12	120			120	121			1200	122				
1.7	1R7	D	23000	30000	13	130			130	131				1500	152			
1.8	1R8				15	150			150	151				1800	182	F,G,	500V	N/A
1.9	1R9				16	160			160	161	F,G,	2500V 3000V	2200	222	J,K	3000	N/A	
2.0	2R0				18	180			180	181	J,K	23000	30007	2700	272			
2.1	2R1				20	200	F,G, J,K	2500V 3600V	200	201								
2.2	2R2				22	220	3,10		220	221								
2.4	2R4				24	240			240	241								
2.7	2R7				27	270			270	271								
3.0	3R0				30	300			300	301								
3.3	3R3				33	330			330	331	F,G,	45001	20001					
3.6	3R6				36	360			360	361	J,K	15000	2000V					
3.9	3R9				39	390			390	391								

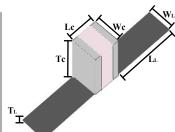




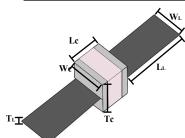
# **Termination Types and Codes**



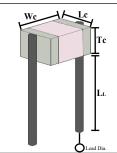
Chip Termination: Codes: W, L, P



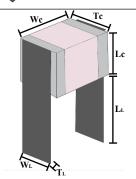
Microstrip Termination: Codes: MS, MN



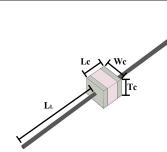
Axial Ribbon Termination: Code: AR, AN



Radial Wire Termination: Codes: RW, RN



Radial Ribbon Termination: Code: RR, FN



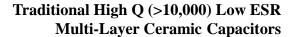
**Axial Wire Termination:** Codes: AW, BN

Termination Code	Magnetic Termination
W ROHS	100% Tin Solder over Nickel Barrier
L	90%Tin/10%Lead Solder over Nickel Barrier
MS (ROHS)	
AR ROHS	
RR (ROHS)	Silver-Plated Copper
RW ROHS	
AW ROHS	

Termination Code	Non-Magnetic 🔗 Termination
P ROHS	100% Tin Solder over Copper Barrier
MN (ROHS)	
AN ROHS	
FN ROHS	Silver-Plated Copper
RN ROHS	
BN ROHS	
Note: "Non-Magnet	tic" means no magnetic materials.

sales@passiveplus.com

PPI2225CPDATA010324RevA





#### **Dimensions** - For Termination Types images, see previous page Unit: inch (millimeter)

	Magnetic Termination										
				Lead Dimensions							
	Code	Le	Length Width Thickness Ove			Width Thickness Overlap			Thickness		
		]	Lc	Wc	Tc	В	LL	WL	TL		
W/L	Chin	0.225	+0.025 -0.010	$0.250 \pm 0.015$	0.165 max	$0.020 \sim 0.047$			-		
W/L	Chip	(5.72	+0.64 -0.25 )	$(6.35 \pm 0.38)$	(4.19 max)	$(0.50 \sim 1.20)$	-	-			
MS	Microstrip						0.500 min	$0.240 \pm 0.005$	$0.008 \pm 0.001$		
AR	Axial Ribbon			$0.250 \pm 0.015$ $(6.35 \pm 0.38)$	0.150 max (3.81 max)		(12.70 min)	$(6.1 \pm 0.13)$	$(0.2 \pm 0.025)$		
RR	Radial Ribbon		$\pm 0.025  \pm 0.64)$			-	0.354 min (9.00 min)	$0.118 \pm 0.005$ $(3.00 \pm 0.13)$	$0.012 \pm 0.001 \\ (0.3 \pm 0.025)$		
RW	Radio Wire						0.709 min (18.00 min)	Dia. $= 0.0$	$31 \pm 0.004$		
AW	Axial Wire						0.906 min (23.00 min)	Dia. = $(0.$	$80 \pm 0.10$ )		

<b>⊘</b>				Non	rmination			<b>⊘</b>			
		Capacitor Dimensions						Lead Dimensions			
	Code	Le	ngth	Width Thickness		Overlap	Length	Width	Thickness		
		]	Lc	Wc	Tc	В	LL WL		TL		
P	Claire	0.225	+0.025 -0.010	$0.250 \pm 0.015$	0.165 max	$0.020 \sim 0.047$					
	Chip	(5.72	<sup>+0.64</sup> <sub>-0.25</sub> )	$(6.35 \pm 0.38)$	(4.19 max)	$(0.50 \sim 1.20)$	-	-	-		
MN	Microstrip						0.500 min	$0.240 \pm 0.005$	$0.008 \pm 0.001$		
AN	Axial Ribbon	$\frac{n}{1}$ 0.245 ± 0.025					(12.70 min)	$(6.1 \pm 0.13)$	$(0.2 \pm 0.025)$		
FN	Radial Ribbon			***************************************	0.150 max (3.81 max)	-	0.354 min (9.00 min)	$0.118 \pm 0.005$ $(3.00 \pm 0.13)$	$0.012 \pm 0.001 \\ (0.3 \pm 0.025)$		
RN	Radio Wire		ŕ	,			0.709 min (18.00 min)	Dia. = 0.0	$31 \pm 0.004$		
BN	Axial Wire	•					0.906 min (23.00 min)	Dia. = $(0.$	$80 \pm 0.10$ )		

Note: Non-Magnetic means no magnetic materials. All leads are attached with high temperature solder and parts are RoHS Compliant.





# **#** Electrical Specifications

Quality Factor (Q)	Greater than 10,000 at 1 MHz
Insulation Resistance (IR)	Test Voltage: 500V 10 <sup>5</sup> Megaohms min. @ +25°C 10 <sup>4</sup> Megaohms min. @ +125°C
Rated Voltage	See Rated Voltage in Capacitance Table
Dielectric Withstanding Voltage (DWV)	250% of Rated Voltage of 5 seconds, Rated Voltage ≤ 500VDC 150% of Voltage for 5 seconds, 500VDC <rated 120%="" 1250="" 5="" for="" of="" rated="" seconds,="" vdc="" voltage="" ≤=""> 1250 VDC</rated>
Operating Temperature Range	-55°C to 200°C
Temperature Coefficient (TC)	C: -55°C to 125°C
Capacitance Drift	$\pm 0.02\%$ or $\pm 0.02$ pF, whichever is greater
Piezoelectric Effects	None
Termination Type	See Termination Type Table

Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.

# **#** Environmental Specifications

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#### **Test Parameters**

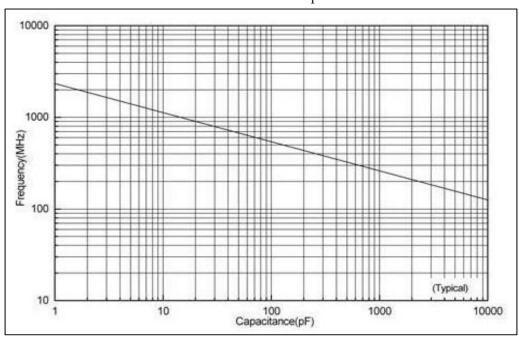
	•	
Thermal Shock	DWV: The initial Value IR: Shall not be less than 30% of the initial value.  Capacitance Change:	MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 200°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles.
Moisture Resistance	No more than 0.5% or 0.5pF, whichever is greater.	MIL-STD-202, Method 106
Humidity (Steady State)	DWV: The initial Value IR: The initial value. Capacitance Change: No more than 0.3% or 0.3pF, whichever is greater.	MIL-STD-202, Method 103, Condition A With 1.5Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours minimum.
Life	IR: Shall not be less than 30% of the initial value.  Capacitance Change:  No more than 2.0% or 0.5pF, whichever is greater.	MIL-STD-202, Method 108. For 2000 hours, at 200°C. 200% of Voltage for Capacitors, Rated Voltage ≤ 500VDC; 120% of Voltage for Capacitors, 500VDC< Rated Voltage ≤1250VDC; 100% for Voltage for Capacitors, Rated Voltage >1250VDC
Terminal Strength	Force: 20lbs typical, 10lbs. Minimum.  Duration Time: 5 to 10 seconds	MIL-STD-202, Method 211A, Test Condition A. Applied a force and maintained for a period of 5 to 10 seconds. The force shall be in the direction of the axes of the terminations.





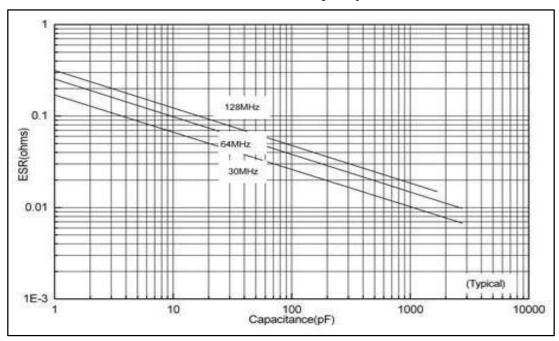
# Series Resonance vs. Capacitance

Series Resonance vs. Capacitance



# ESR vs. Frequency

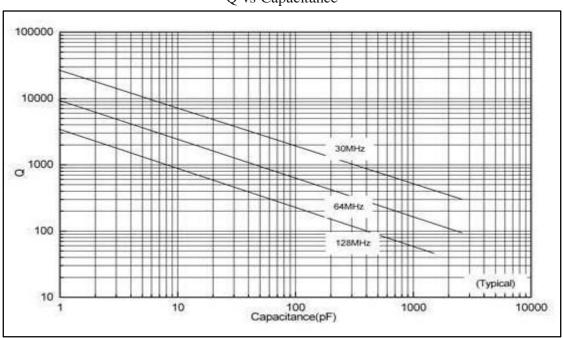
2225C/P ESR vs Frequency





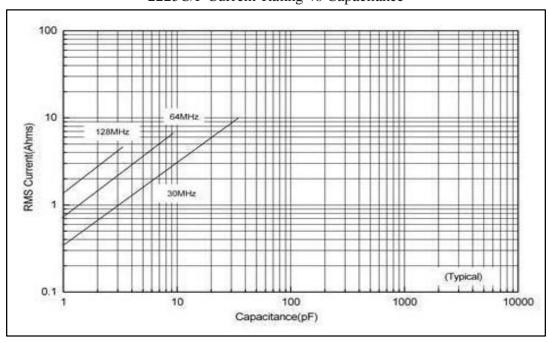
## Q vs. Capacitance

Q vs Capacitance



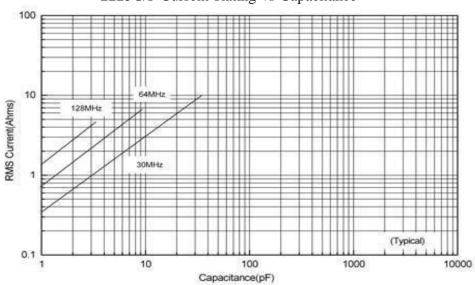
# **Current Rating vs. Capacitance**

2225C/P Current Rating vs Capacitance



## **#** Current Rating vs. Capacitance

2225C/P Current Rating vs Capacitance



Current limits can depend on two different criteria. The first Voltage Limited Current ( $I_{volt \, lim}$ , represented by the solid line), the second is Power Dissipation Limited Current ( $I_{pow \, diss}$ ).

$$I_{\text{volt lim}} = \frac{\sqrt{2}}{2} I_{peak} = \frac{\sqrt{2}}{2} \times \frac{V_{rated}}{X_C} = \sqrt{2} \pi FCV_{rated}$$

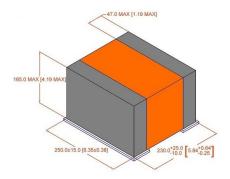
 $I_{\text{pow diss}} = \sqrt{\frac{P_{dissipation}}{ESR}}$  (If the thermal resistance of the mounting surface is 15°C/W, then you will reach the power dissipated limit of 4W)





#### **†** Capacitor Application Program

PPI's brand new online Capacitor Application Program (C.A.P.) helps Engineers and Designers select capacitors according to parameters such as cap value and frequency. C.A.P. allows engineers to insert capacitors requirements (Cap value, Frequency), producing Scattering Matrices (S2P) Charts while providing options (Case Size, Terminations, Mounting), and parameters (ESR, Q, Impedance) along with Datasheets. Once engineers have determined their capacitor requirements, C.A.P. also includes online Requests For Quotes (RFQs) and/or sample requests.



#### **#** Recommended Land Pattern Dimensions

Regarding Landing Patterns, please refer to IPC-7351B (table 3-5, 3-6).

#### **#** Custom Assemblies

Passive Plus offers Capacitor Assemblies for high power requirements. Typical assemblies are configured in series and/or parallel combinations, producing higher voltage/current handling capabilities, extended capacitance range and tighter tolerances.

To get started, simply send us either a mechanical drawing or circuit conditions and we can recommend a solution. All components are 100% upscreened for Partial Discharge and Sonoscanned. All assemblies include a 100hr Military burn in.

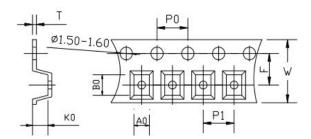






# **Tape & Reel Specifications (mm)**

	Orientation	Measurement Unit	W	P0	P1	Т	F	Minimum Qty per Reel	Std Qty per Reel	Tape Material
	Н	in.	0.630 0.	.157 0.4	472 0	.012 (	0.295	500	500	Plastic
		mm	16.00 4	1.00 12	2.00	0.30	7.50	300	500	lastic
	V	in.	0.630 0.	.157 0	315 0	.020 (	0.295	500	500	Plastic
V	mm	16.00 4	1.00 8.	.00	0.50	7.50	300	300 1	riastic	



#### $A_0B_0K_0$

- Determined by component size. Typical clearance between the cavity and the component is: .50 (.002) min to .65 (.026) max for 12mm tape.
- $\bullet$  The component cannot rotate more than  $20^\circ$  within the determined cavity.

3838C/P (0.380" x 0.380")

#### **#** Product Features

- High Q
- High RF Current/Voltage
- Ultra Stable Performance
- Capacitance Range: 0.5pF to 5100pF
- Working Voltage: 3600V
- Extended Voltage: 7200V

# **÷** Product Applications

#### **Typical Functional Applications:**

- Tuning Bypass Coupling
- D.C. Blocking Impedance Matching

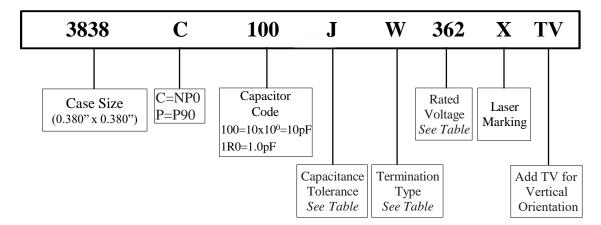
#### **Typical Circuit Applications:**

- HF/RF Power Amplifiers
- Antenna Tuning Plasma Chambers
- Medical Equipment Transmitters



Marking shown for illustration purposes only. Actual marking may differ.

## Part Numbering



# **‡** Capacitance Tolerance Codes

Code	A	В	C	D	F	G	J	K
Tol.	±0.05pF	±0.1pF	±0.25pF	±0.5pF	$\pm 1\%$	±2%	±5%	±10%

# **≠** Voltage Codes

Voltage	Code
500V	501
1000V	102
2500V	252
3600V	362
7200V	722

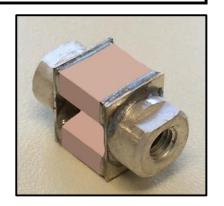




3838C/P (0.380" x 0.380")

# **≠** 3838C/P Capacitance Values

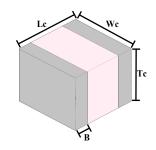
Special capacitances, tolerances and WVDC are available. Please contact PPI.



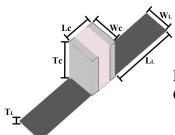
Cap.	Сар	Tol.		WVDC	Cap.	Сар	Tol.		WVDC	Cap.	Сар	Tol.		WVDC	Cap.	Сар	Tol.	Rated
pF	Code		Std.	Ext.	pF	Code		Std.	Ext.	pF	Code		Std.	Ext.	pF	Code		WVDC
0.5	OR5				4.7	4R7		3600V 7200V		51	510				560	561	F,G, J,K	2500V
0.6	OR6				5.1	5R1				56	560				620	621		
0.7	OR7				5.6	5R6				62	620				680	681		
0.8	OR8				6.2	6R2	B,C,		68	680				750	751			
0.9	OR9				6.8	6R8	D		75	750	F,G,			820	821			
1.0	1R0				7.5	7R5			82	820				910	911			
1.1	1R1				8.2	8R2			91	910		3600V	7200V	1000	102			
1.2	1R2				9.1	9R1				100	101	J,K	3000	72001	1100	112	E C	
1.3	1R3		3600V 7200V	10	100			110	111				1200	122	F,G, J,K	1000V		
1.4	1R4				11	110				120	121				1500	152	ŕ	
1.5	1R5				<b>12</b> 120	120				130	131				1800	182		
1.6	1R6	D.C			13	130				150	151				2200	222		
1.7	1R7	B,C, D		7200V	15	150				160	161				2400	242		
1.8	1R8				16	160				180	181			2700	272			
1.9	1R9				18	180				200	201				3000	302		
2.0	2R0			20	200				220	221				3300	332			
2.1	2R1				22	220	0 F,G, J,K	136007 //007	7200V	240	241	F,G,	3600V	N/A	3600	362	F,G, J,K	500V
2.2	2R2				24 240 27 270 30 300	240	,			270	271				3900	392		
2.4	2R4								300	301	J,K	30000	N/A	4300	432			
2.7	2R7					300				330	331				4700	472		
3.0	3R0			33	330			360	361				5100	512				
3.3	3R3				36	360			390	391								
3.6	3R6				39	390				430	431		1 /500/	N/A				
3.9	3R9				43	430				470	471	F,G, J,K						
4.3	4R3				47	470				510	511	3,11						

# 3838C/P (0.380" x 0.380")

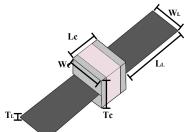
# **#** Termination Types and Codes



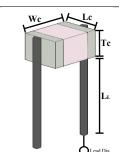
Chip Termination: Codes: W, L, P



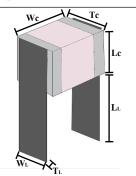
Microstrip Termination: Codes: MS, MN



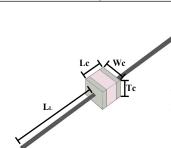
Axial Ribbon Termination: Code: AR, AN



Radial Wire Termination: Codes: RW, RN



Radial Ribbon Termination: Code: RR, FN



Axial Wire Termination: Codes: AW, BN

Termination Code	Magnetic Termination					
W ROHS	100% Tin Solder over Nickel Barrier					
L	90%Tin/10%Lead Solder over Nickel Barrier					
MS ROHS						
AR ROHS						
RR (ROHS)	Silver-Plated Copper					
RW ROHS						
AW ROHS						

Termination Code	Non-Magnetic 🔗 Termination					
P (1)	100% Tin					
RóHS	Solder over Copper Barrier					
MN (ROHS)						
AN ROHS						
FN ROHS	Silver-Plated Copper					
RN ROHS						
BN ROHS	•					
Note: "Non-Magnetic" means no magnetic materials.						





#### Traditional High Q (>10,000) Low ESR **Multi-Layer Ceramic Capacitors**

3838C/P (0.380" x 0.380")

#### **Dimensions** - For Termination Types images, see previous page Unit: inch (millimeter)

	Magnetic Termination												
				Capacitor D	imensions			<b>Lead Dimension</b>	ons				
	Code	Le	ngth	Width	Thickness	Overlap	Length	Width	Thickness				
		-	Lc	Wc	Tc	В	LL	WL	TL				
W/L	Chin	0.380	+0.015 -0.010	$0.380\pm0.010$	0.170 max	$0.024 \sim 0.059$							
	Chip	(9.65	+0.38 -0.25 )	$(9.65 \pm 0.25)$	(4.32 max)	$(0.60 \sim 1.50)$	-	-	-				
MS	Microstrip						0.728 min	$0.350 \pm 0.020$	$0.008 \pm 0.001$				
IVIS	Microsurp	-					(18.50  min)	$(8.89 \pm 0.50)$	$(0.20 \pm 0.025)$				
AR	Axial						0.728 min	$0.315 \pm 0.010$	$0.008 \pm 0.001$				
AK	Ribbon	-					(18.50  min)	$(8.00 \pm 0.25)$	$(0.20 \pm 0.025)$				
RR	Radial	0.380	+0.015	$0.380 \pm 0.010$	0.177 max	-	0.354 min	$0.118 \pm 0.005$	$0.012 \pm 0.001$				
	Ribbon	(9.65	+0.38 -0.25	$(9.65 \pm 0.25)$	(4.50 max)		(9.00 min)	$(3.00 \pm 0.13)$	$(0.3 \pm 0.025)$				
RW	Radio						0.709 min						
	Wire	_					(18.00  min)	Dia. $= 0.0$	$31 \pm 0.004$				
A W/	Axial						0.906 min	Dia. = $(0.$	$80 \pm 0.10$ )				
AW	Wire						(23.00 min)						

<b>②</b>				Non	rmination			<b>⊘</b>	
				Capacitor D	imensions		Lead Dimensions		
	Code	Length		Width	Thickness	Overlap	Length	Width	Thickness
		Lc		Wc	Tc	В	LL	WL	TL
P	Chip	0.380	+0.015 -0.010	$0.380 \pm 0.010$	0.170 max	$0.024 \sim 0.059$			
		(9.65	+0.38 -0.25 )	$(9.65 \pm 0.25)$	(4.32 max)	$(0.60 \sim 1.50)$	-	-	-
MN	Microstrip						0.728 min	$0.350 \pm 0.020$	$0.008 \pm 0.001$
IVIIN	Microsurp						(18.50 min)	$(8.89 \pm 0.50)$	$(0.20 \pm 0.025)$
AN	Axial						0.728 min	$0.315\pm0.010$	$0.008 \pm 0.001$
AIN	Ribbon	_					(18.50  min)	$(8.00 \pm 0.25)$	$(0.20 \pm 0.025)$
FN	Radial	0.380	+0.015 -0.010	$0.380 \pm 0.010$	0.177 max	_	0.354 min	$0.118 \pm 0.005$	$0.012 \pm 0.001$
111	Ribbon	(9.65	+0.38 -0.25	$(9.65 \pm 0.25)$	(4.50 max)		(9.00 min)	$(3.00 \pm 0.13)$	$(0.3 \pm 0.025)$
RN	Radio	•					0.709 min		
IXIN	Wire						(18.00 min)	Dia. = 0.0	$31 \pm 0.004$
BN	Axial	•					0.906 min	Dia. $= (0.$	$80 \pm 0.10$ )
DN	Wire						(23.00 min)		

Note: Non-Magnetic means no magnetic materials. All leads are attached with high temperature solder and parts are RoHS Compliant.





## **‡** Electrical Specifications

Quality Factor (Q)	Greater than 10,000 at 1 MHz
Insulation Resistance (IR)	Test Voltage: 500V 10 <sup>5</sup> Megaohms min. @ +25°C 10 <sup>4</sup> Megaohms min. @ +125°C
Rated Voltage	See Rated Voltage in Capacitance Table
Dielectric Withstanding Voltage (DWV)	250% of Rated Voltage of 5 seconds, Rated Voltage ≤ 500VDC 150% of Voltage for 5 seconds, 500VDC <rated 120%="" 1250="" 5="" for="" of="" rated="" seconds,="" vdc="" voltage="" ≤=""> 1250 VDC</rated>
Operating Temperature Range	-55°C to 200°C
Temperature Coefficient (TC)	C: -55°C to 125°C 0±30ppm/°C; >125°C to 200°C 0±60ppm/°C P: -55°C to 200°C +90±20ppm/°C
Capacitance Drift	$\pm 0.02\%$ or $\pm 0.02$ pF, whichever is greater
Piezoelectric Effects	None
Termination Type	See Termination Type Table

## **‡** Environmental Specifications

#### Specification

#### **Test Parameters**

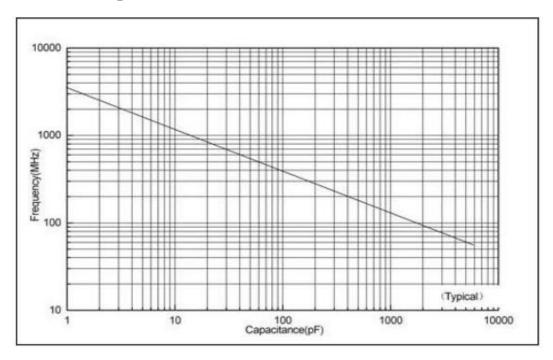
	-	
Thermal Shock	<b>DWV:</b> The initial value <b>IR:</b> Shall not be less than 30% of the initial value. <b>Capacitance Change:</b>	MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 200°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles.
Moisture Resistance	No more than 0.5% or 0.5pF, whichever is greater.	MIL-STD-202, Method 106
Humidity (Steady State)	DWV: The initial value IR: The initial value Capacitance Change: No more than 0.3% or 0.3pF, whichever is greater.	MIL-STD-202, Method 103, Condition A With 1.5Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours minimum.
Life	IR: Shall not be less than 30% of the initial value.  Capacitance Change: No more than 2.0% or 0.5pF, whichever is greater.	MIL-STD-202, Method 108. For 2000 hours, at 200°C. 200% of Voltage for Capacitors, Rated Voltage ≤ 500VDC; 120% of Voltage for Capacitors, 500VDC< Rated Voltage ≤1250VDC; 100% for Voltage for Capacitors, Rated Voltage >1250VDC
Terminal Strength	Force: 20lbs typical, 10lbs. min. Duration Time: 5 to 10 seconds	Applied a force and maintained for a period of 5 to 111 seconds

Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.

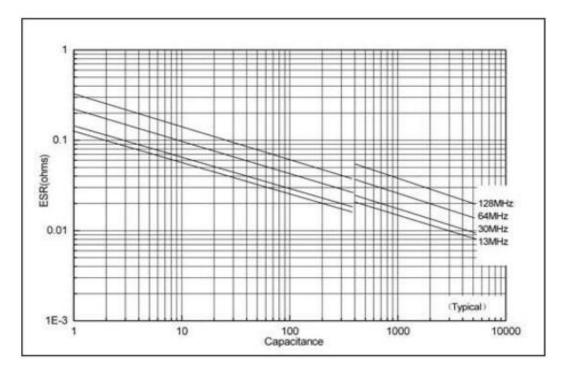




#### **Fig. 3** Series Resonance vs. Capacitance



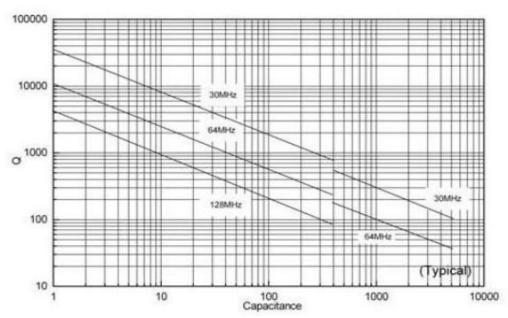
## **ESR** vs. Frequency



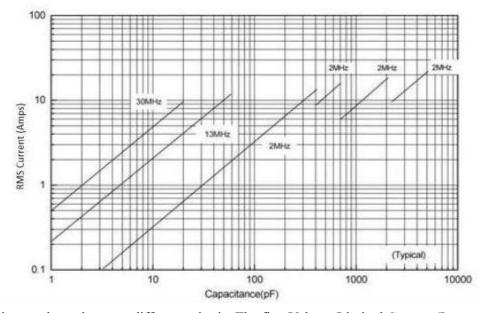




#### 



## **‡** Current Rating vs. Capacitance



Current limits can depend on two different criteria. The first Voltage Limited Current ( $I_{volt \, lim}$ , represented by the solid line), the second is Power Dissipation Limited Current ( $I_{pow \, diss}$ ).

$${\rm I_{volt\,lim}} = \frac{\sqrt{2}}{2}I_{peak} = \frac{\sqrt{2}}{2} \times \frac{V_{rated}}{X_C} = \sqrt{2}\pi FCV_{rated}$$

 $I_{pow \ diss} = \sqrt{\frac{P_{\textit{dissipation}}}{\textit{ESR}}} \ (\text{If the thermal resistance of the mounting surface is } 12^{\circ}\text{C/W}, \text{ then you will reach the power dissipated limit of 5W})$ 



www.passiveplus.com



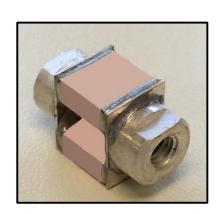
#### **#** Recommended Land Pattern Dimensions

Regarding Landing Patterns, please refer to IPC-7351B (table 3-5, 3-6).

#### **#** Custom Assemblies

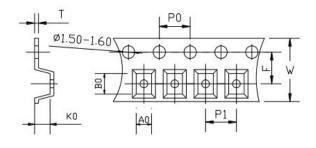
Passive Plus offers Capacitor Assemblies for high power requirements. Typical assemblies are configured in series and/or parallel combinations, producing higher voltage/current handling capabilities, extended capacitance range and tighter tolerances.

To get started, simply send us either a mechanical drawing or circuit conditions and we can recommend a solution. All components are 100% upscreened for Partial Discharge and Sonoscanned. All assemblies include a 100hr Military burn in.



#### **†** Tape & Reel Specifications (mm)

Orientation	Measurement Unit		W	P0	P1	Т	F	Minimum Qty per Reel	Std Qty per Reel	Tape Material
Н	in. mm	0.630			630 ( 500		0.295 7.50	50	200	Plastic



#### $A_0B_0K_0$

- Determined by component size. Typical clearance between the cavity and the component is: .50 (.002) min to .65 (.026) max for 12mm tape.
- The component cannot rotate more than 20° within the determined cavity.





# UHF/RF High-Q Power Transmitter Multi-Layer Ceramic Capacitors

6040C (0.600" x 0.400")

#### Product Features

- High Q
- High RF Current/Voltage
- Ultra Stable Performance
- Capacitance Range: 1.0pF to 6800pF
- Working Voltage: 5000VExtended Voltage: 8000V

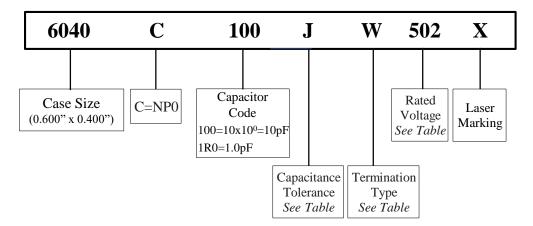
### **‡** Typical Circuit Applications

- Semiconductor Manufacturing
- High Energy Power Transfers
- Plasma Chambers
- Medical Equipment



Marking shown for illustration purposes only. Actual marking may differ.

#### Part Numbering



#### **‡** Capacitance Tolerance Codes

Code	В	C	D	F	G	J	K
Tol.	±0.1pF	±0.25pF	±0.5pF	±1%	±2%	±5%	±10%

### **≠** Voltage Codes

Voltage	Code
1000V	102
2000V	202
3000V	302
5000V	502
8000V	802





#### UHF/RF High-Q Power Transmitter Multi-Layer Ceramic Capacitors

6040C (0.600" x 0.400")

## **≠** 6040C Capacitance Values

For special capacitances, tolerances and WVDC, please contact PPI.



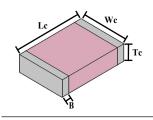
Marking shown for illustration purposes only. Actual marking may differ.

Cap.	Сар	Tol.	Rated WVDC	Cap.	Сар	Tol.	Rated	WVDC	Cap.	Сар	Tol.	Rated	WVDC
рF	Code	101.	Std. Ext.	pF	Code	101.	Std.	Ext.	pF	Code	101.	Std.	Ext.
1.0	1R0			39	390				1500	152	F.C		
1.2	1R2			47	470				1800	182	F,G, J,K	2000V	3000V
1.5	1R5			56	560	F,G,	5000V 8000V	8000\/	2200	222	,		
1.8	1R8			68	680	J,K	30001	0000	2700	272			
2.2	2R2			82	820				3300	332			
2.7	2R7	B,C,	5000V 8000V	100	101				4700	472	F,G,	1000V	2000V
3.3	3R3	D	30001 0000	120	121				5100	512	J,K	10001	20001
3.9	3R9			150	151			5600	562				
4.7	4R7			180	181				6800	682			
5.6	5R6			220	221								
6.8	6R8			270	271	F,G,	3000V 5000	5000V					
8.2	8R2			330	331	J,K	30001	3000					
10	100			390	391								
12	120			470	471								
15	150	E G		560	561								
18	180	F,G, J,K	5000V 8000V	680	681								
22	220			820	821	F.G.							
27	270			1000	102	F,G, J,K	2000V	3000V					
33	330			1200	122								

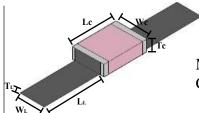




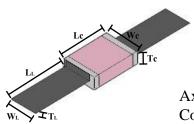
### **Termination Types and Codes**



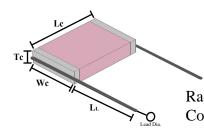
Chip Termination: Codes: W, L, P



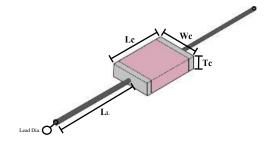
Microstrip Termination: Codes: MS, MN



Axial Ribbon Termination: Code: AR, AN



Radial Wire Termination: Codes: RW, RN



**Axial Wire Termination:** Codes: AW, BN

Termination Code	Magnetic Termination						
W ROHS	100% Tin Solder over Nickel Barrier						
L	90%Tin/10%Lead Solder over Nickel Barrier						
MS (ROHS)							
AR ROHS							
RW ROHS	Silver-Plated Copper						
AW ROHS							

Termination Code	Non-Magnetic 🔗 Termination					
P Rohs	100% Tin Solder over Copper Barrier					
MN ROHS						
AN ROHS						
RN ROHS	Silver-Plated Copper					
BN ROHS						

Note: "Non-Magnetic" means no magnetic materials.





#### UHF/RF High-Q Power Transmitter Multi-Layer Ceramic Capacitors

6040C (0.600" x 0.400")

## **Dimensions** - For Termination Types images, see previous page Unit: inch (millimeter)

	Magnetic Termination												
				Capacitor 1	Dimensions			<b>Lead Dimension</b>	ons				
	Code	Length		Width	Thickness	Overlap	Length	Width	Thickness				
		]	Lc	Wc	Tc	В	LL	WL	TL				
W/L	Chip	0.614	+0.015 -0.010	$0.433\pm0.010$	$0.154\pm0.008$	0.063 max							
W/L		(15.6	+0.38 -0.25 )	$(11.0 \pm 0.25)$	$(3.90 \pm 0.20)$	(1.60 max)	_	-	-				
MS	Microstrip						0.787 min	$0.350 \pm 0.010$	$0.008 \pm 0.001$				
1015	Microstrip						(20.0 min)	$(8.89 \pm 0.50)$	$(0.20 \pm 0.025)$				
	Axial						0.787 min	$0.350 \pm 0.010$	$0.008 \pm 0.001$				
AR	Ribbon	0.614	+0.015 -0.010	$0.433 \pm 0.010$	$0.154\pm0.008$		(20.0 min)	$(8.89 \pm 0.50)$	$(0.20 \pm 0.025)$				
RW	Radio Wire	(15.6	+0.38 -0.25 )	$(11.0 \pm 0.25)$	$(3.90 \pm 0.20)$	-	0.787 min (20.0 min)	Dia. = 0.0	$30 \pm 0.004$				
	Axial						0.984 min		$80 \pm 0.10$ )				
AW	Wire						(25.00 min)	= 140.					

<b>⊘</b>				No	mination						
				Capacitor 1	Dimensions			Lead Dimensions			
	Code	Length		Width	Thickness	Overlap	Length	Width	Thickness		
		Lc		Wc	Tc	В	LL	WL	TL		
P	Chin	0.614	+0.015 -0.010	$0.433\pm0.010$	$0.154\pm0.008$	0.063 max					
Р	Chip	(15.6	+0.38 -0.25 )	$(11.0 \pm 0.25)$	$(3.90\pm0.20)$	(1.60 max)	_	-	-		
MN	Mionostnin						0.787 min	$0.350 \pm 0.010$	$0.008 \pm 0.001$		
IVIIN	Microstrip	_					(20.0 min)	$(8.89 \pm 0.50)$	$(0.20 \pm 0.025)$		
	Axial	-					0.787 min	$0.350 \pm 0.010$	$0.008 \pm 0.001$		
AN	Ribbon	0.614	+0.015 -0.010	$0.433 \pm 0.010$	$0.154 \pm 0.008$		(20.0 min)	$(8.89 \pm 0.50)$	$(0.20 \pm 0.025)$		
			+0.38			-					
RN	Radio	(15.6	-0.25	$(11.0 \pm 0.25)$	$(3.90 \pm 0.20)$		0.787 min				
	Wire						(20.0 min)	Dia. = 0.0	$30 \pm 0.004$		
DN	Axial	•					0.984 min	Dia. $= (0.$	$80 \pm 0.10$ )		
BN	Wire						(25.00 min)		,		

Note: Non-Magnetic means no magnetic materials. All leads are attached with high temperature solder and parts are RoHS Compliant.





## **#** Electrical Specifications

Quality Factor (Q)	No less than 1000pF, Q value more than 2000, Test Frequency 1MHz; More than 1000pF, Q value more than 2000, Test Frequency 1MHz			
Insulation Resistance (IR)	Test Voltage: 500V 10 <sup>5</sup> Megaohms min. @ +25°C 10 <sup>4</sup> Megaohms min. @ +125°C			
Rated Voltage	See Rated Voltage in Capacitance Table			
Dielectric Withstanding Voltage (DWV)	250% of Voltage of 5 seconds, Rated Voltage ≤ 500VDC 150% of Voltage for 5 seconds, 500VDC <rated 120%="" 1250="" 5="" for="" of="" rated="" seconds,="" vdc="" voltage="" ≤=""> 1250 VDC</rated>			
Operating Temperature Range	-55°C to 175°C			
Temperature Coefficient (TC)	-55°C to 125°C			
Capacitance Drift	$\pm 0.02\%$ or $\pm 0.02$ pF, whichever is greater			
Piezoelectric Effects	None			
Termination Type	See Termination Type Table			

#### **‡** Environmental Specifications

#### **Specification**

#### **Test Parameters**

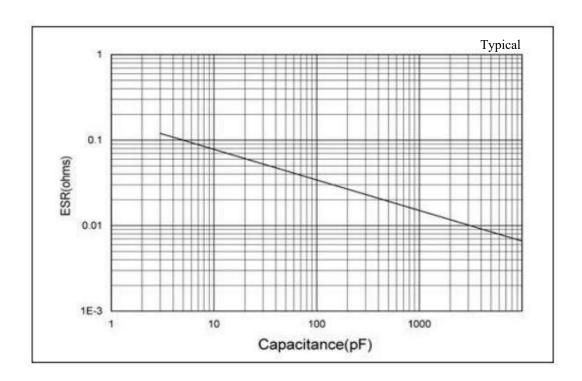
	-	
Thermal Shock	<b>DWV:</b> The initial value <b>IR:</b> Shall not be less than 30% of the initial value. <b>Capacitance Change:</b>	MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 175°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles.
Moisture Resistance	No more than 0.5% or 0.5pF, whichever is greater.	MIL-STD-202, Method 106
Humidity (Steady State)	DWV: The initial value IR: The initial value Capacitance Change: No more than 0.3% or 0.3pF, whichever is greater.	MIL-STD-202, Method 103, Condition A With 1.5Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours minimum.
Life	IR: Shall not be less than 30% of the initial value.  Capacitance Change: No more than 2.0% or 0.5pF, whichever is greater.	MIL-STD-202, Method 108. For 2000 hours, at 125°C. 200% of Voltage for Capacitors, Rated Voltage ≤ 500VDC; 120% of Voltage for Capacitors, 500VDC< Rated Voltage ≤1250VDC; 100% for Voltage for Capacitors, Rated Voltage >1250VDC
Terminal Strength	Force: 25lbs typical, 20lbs. min. Duration Time: 5 to 10 seconds	Applied a force and maintained for a period of 5 to 111 seconds

Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.

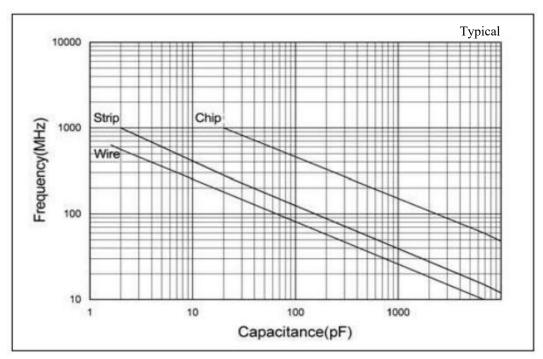




### ESR vs. Capacitance Measured @ 30MHz



## **Self Resonant Frequency vs. Capacitance**



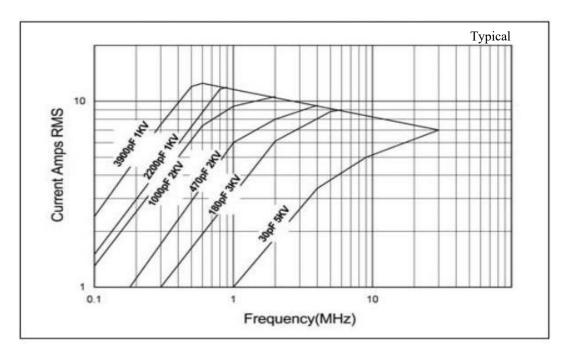
sales@passiveplus.com

PPI6040CDATA010324RevA

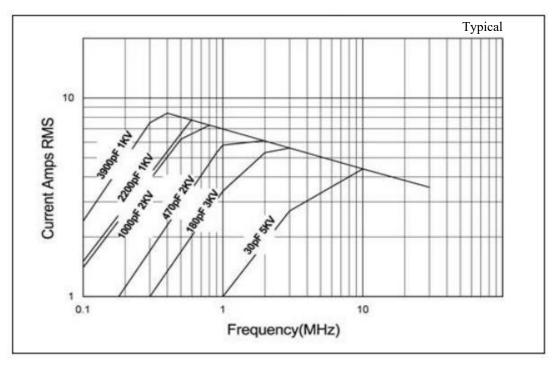




### **#** Strip Terminals Rated Current vs. Frequency



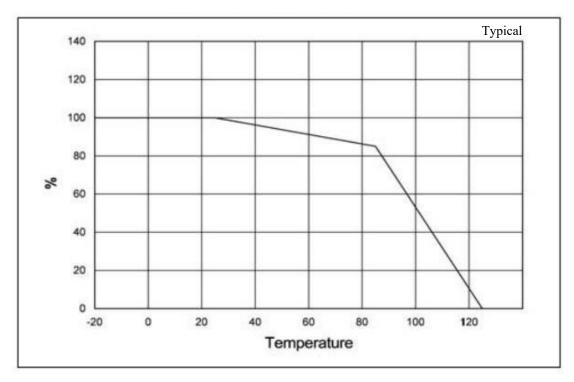
## **#** Wire Terminals Rated Current vs. Frequency







#### % Maximum Current vs. Ambient Temperature



#### **‡** Recommended Land Pattern Dimensions

Regarding Landing Patterns, please refer to IPC-7351B (table 3-5, 3-6).

#### Custom Assemblies

Passive Plus offers Capacitor Assemblies for high power requirements. Typical assemblies are configured in series and/or parallel combinations, producing higher voltage/current handling capabilities, extended capacitance range and tighter tolerances.

To get started, simply send us either a mechanical drawing or circuit conditions and we can recommend a solution. All components are 100% upscreened for Partial Discharge and Sonoscanned. All assemblies include a 100hr Military burn in.







## UHF/RF High-Q Power Transmitter Multi-Layer Ceramic Capacitors

7676C (0.760" x 0.760")

#### **†** Product Features

- High Q
- High RF Current/Voltage
- Ultra Stable Performance
- Capacitance Range: 1.0pF to 20000pF
- Working Voltage: 5000VExtended Voltage: 8000V

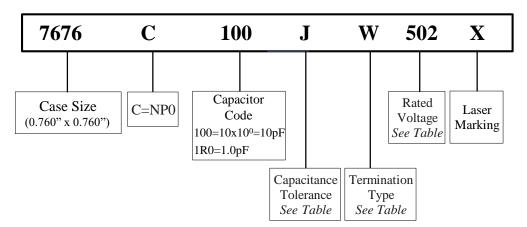
#### **†** Typical Circuit Applications

- Semiconductor Manufacturing
- High Energy Power Transfers
- Plasma Chambers
- Medical Equipment



Marking shown for illustration purposes only. Actual marking may differ.

#### Part Numbering



#### **÷** Capacitance Tolerance Codes

Code	В	C	D	F	G	J	K
Tol.	±0.1pF	±0.25pF	±0.5pF	±1%	±2%	±5%	±10%

## **≠** Voltage Codes

Voltage	Code
1000V	102
2000V	202
3000V	302
5000V	502
8000V	802





 $7676C (0.760" \times 0.760")$ 

## **≠** 7676C Capacitance Values

Special capacitances, tolerances and WVDC are available. Please contact PPI.

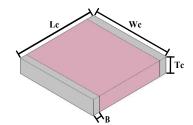


Marking shown for illustration purposes only. Actual marking may differ.

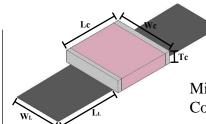
Cap.	Сар	Tol.	Rated	WVDC	Cap.	Сар	Tol.	Rated	WVDC	Cap.	Сар	Tol.	Rated	WVDC
pF	Code	101.	Std.	Ext.	pF	Code	101.	Std.	Ext.	рF	Code	101.	Std.	Ext.
1.0	1R0				33	330				1000	102			
1.2	1R2				39	390				1200	122			
1.5	1R5				47	470				1500	152			
1.8	1R8				56	560				1800	182	GI		
2.2	2R2				68	680	F,G,			2200	222	G,J, K	3000V 5	5000V
2.7	2R7	B,C,	5000V	5000V 8000V	82	820	J,K	5000V 8000V	2700	272				
3.3	3R3	D			100	101				3300	332			
3.9	3R9				120	121				4700	472			
4.7	4R7				150	151				5100	512			
5.6	5R6				180	181				5600	562			
6.8	6R8				220	221				6800	682	G I		
8.2	8R2				270	271				7500	752	G,J, K	1000V	3000V
10	100				300	301				8200	822			
12	120				390	391	F.C			10000	103			
15	150	F,G,	5000\/	8000V	470	471	F,G, J,K	3000V	5000V	12000	123			
18	180	J,K	3000 0	560	560	561	-,			15000	153	G,J,	1000	2000\/
22	220				680	681				18000	183	K	1000V 2000	2000
27	270				820	821				20000	203			



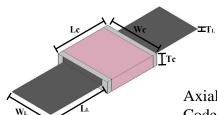
#### **Termination Types and Codes**



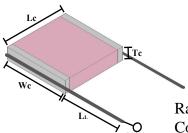
Chip Termination: Codes: W, L, P



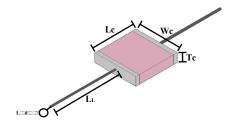
Microstrip Termination: Codes: MS, MN



**Axial Ribbon Termination:** Code: AR, AN



Radial Wire Termination: Codes: RW, RN



**Axial Wire Termination:** Codes: AW, BN

Termination Code	Magnetic Termination
W ROHS	100% Tin Solder over Nickel Barrier
L	90%Tin/10%Lead Solder over Nickel Barrier
MS (ROHS)	
AR ROHS	
RW ROHS	Silver-Plated Copper
AW ROHS	

Termination Code	Non-Magnetic 🔗 Termination			
Р 🐼	100% Tin			
ROHS	Solder over Copper Barrier			
MN (ROHS)				
AN ROHS				
RN ROHS	Silver-Plated Copper			
BN ROHS				
A N-4 "N M				

Note: "Non-Magnetic" means no magnetic materials.





#### **UHF/RF High-Q Power Transmitter Multi-Layer Ceramic Capacitors**

7676C (0.760" x 0.760")

#### **Dimensions** - For Termination Types images, see previous page Unit: inch (millimeter)

	Magnetic Termination									
				Capacitor I	Dimensions			Lead Dimensions		
	Code	Le	ngth	Width	Thickness	Overlap	Length	Width	Thickness	
			Lc	Wc	Tc	В	LL	WL	TL	
W/L	Chin	0.760	+0.015 -0.010	$0.760\pm0.010$	0.197 max	$0.024 \sim 0.059$				
W/L	Chip	(19.3	+0.38 -0.25 )	$(19.3 \pm 0.25)$	(5.00 max)	$(0.60 \sim 1.50)$	-	-	-	
MS	Microstrip							$0.591 \pm 0.010$ $(15.00 \pm 0.25)$		
AR	Axial Ribbon	0.760	+0.015 -0.010	$0.760 \pm 0.010$	0.197 max			$0.591 \pm 0.010$ $(15.00 \pm 0.25)$		
RW	Radio Wire	(19.3	+0.38 -0.25 )	$(19.3 \pm 0.25)$	(5.00 max)	-	0.748 min (19.0 min)	Dia. = 0.0	31 ± 0.006	
AW	Axial Wire	<del>-</del>					0.906 min (23.00 min)	`	$80 \pm 0.15$ )	

<b>②</b>	Non-Magnetic Termination							Lead Dimension	<b>②</b>
	Code	Le	ength	Capacitor Dimensions Width Thickness		Overlap	Length Widt		Thickness
			Lc	Wc	Tc	В	LL	WL	TL
P	Chin	0.760	+0.015 -0.010	$0.760 \pm 0.010$	0.197 max	0.024 ~ 0.059			
r	Chip	(19.3	+0.38 -0.25 )	$(19.3 \pm 0.25)$	(5.00 max)	$(0.60 \sim 1.50)$	-	-	
MN	Microstrip						0.748 min (19.0 min)	$0.591 \pm 0.010$ $(15.00 \pm 0.25)$	
AN	Axial Ribbon	0.760	+0.015 -0.010	$0.760 \pm 0.010$	0.197 max		0.748 min (19.0 min)	$0.591 \pm 0.010$ $(15.00 \pm 0.25)$	
RN	Radio Wire	(19.3	+0.38 -0.25 )	$(19.3 \pm 0.25)$	(5.00 max)	-	0.748 min (19.0 min)	Dia. = 0.0	31 ± 0.006
BN	Axial Wire						0.906 min (23.00 min)	`	$80 \pm 0.15$ )

Note: Non-Magnetic means no magnetic materials. All leads are attached with high temperature solder and parts are RoHS Compliant.

PPI7676CDATA120823RevB





## **÷** Electrical Specifications

Quality Factor (Q)	No less than 1000pF, Q value more than 2000, Test Frequency 1MHz; More than 1000pF, Q value more than 2000, Test Frequency 1kHz			
Insulation Resistance (IR)	Test Voltage: 500V 10 <sup>5</sup> Megaohms min. @ +25°C 10 <sup>4</sup> Megaohms min. @ +125°C			
Rated Voltage	See Rated Voltage in Capacitance Table			
Dielectric Withstanding Voltage (DWV)	250% of Voltage of 5 seconds, Rated Voltage ≤ 500VDC 150% of Voltage for 5 seconds, 500VDC <rated 1250="" vdc<br="" voltage="" ≤="">120% of Voltage for 5 seconds, Rated Voltage &gt; 1250 VDC</rated>			
Operating Temperature Range	-55°C to 175°C			
Temperature Coefficient (TC)	-55°C to 125°C			
Capacitance Drift	$\pm 0.2\%$ or $\pm 0.05$ pF, whichever is greater			
Piezoelectric Effects	None			
Termination Type	See Termination Type Table			

## **#** Environmental Specifications

#### **Specification**

#### **Test Parameters**

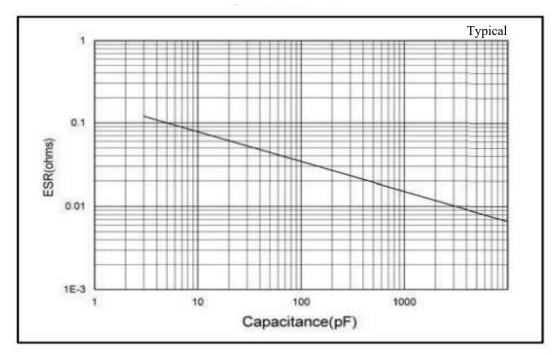
	- I	
Thermal Shock	<b>DWV:</b> The initial value <b>IR:</b> Shall not be less than 30% of the initial value. <b>Capacitance Change:</b>	MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 175°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles.
Moisture Resistance	No more than 0.5% or 0.5pF, whichever is greater.	MIL-STD-202, Method 106
Humidity (Steady State)	DWV: The initial value IR: The initial value Capacitance Change: No more than 0.3% or 0.3pF, whichever is greater.	MIL-STD-202, Method 103, Condition A With 1.5Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours minimum.
Life	30% of the initial value	MIL-STD-202, Method 108. For 2000 hours, at 125°C. 200% of Voltage for Capacitors, Rated Voltage ≤ 500VDC; 120% of Voltage for Capacitors, 500VDC< Rated Voltage ≤1250VDC; 100% for Voltage for Capacitors, Rated Voltage >1250VDC
Terminal Strength	Force: 30lbs. min.  Duration Time: 5 to 10 seconds	MIL-STD-202, Method 211A, Test Condition A. Applied a force and maintained for a period of 5 to 10 seconds. The force shall be in the direction of the axes of the terminations.

Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.

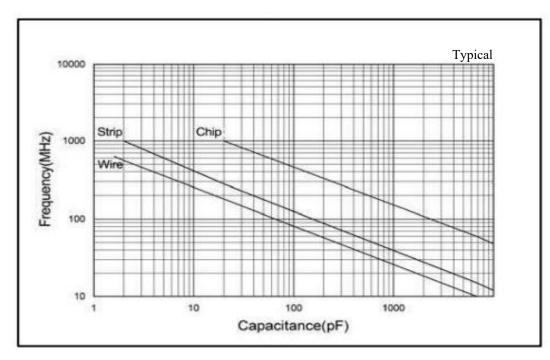




## **ESR vs. Capacitance Measured @ 30MHz**



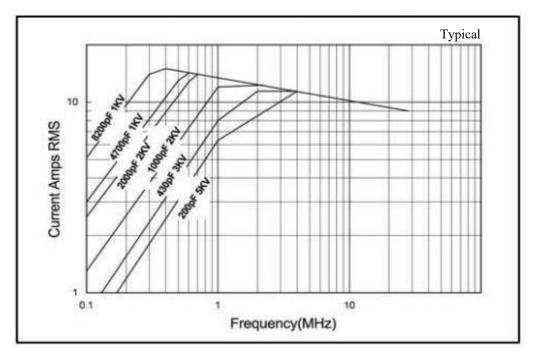
## **≠** Self Resonant Frequency vs. Capacitance



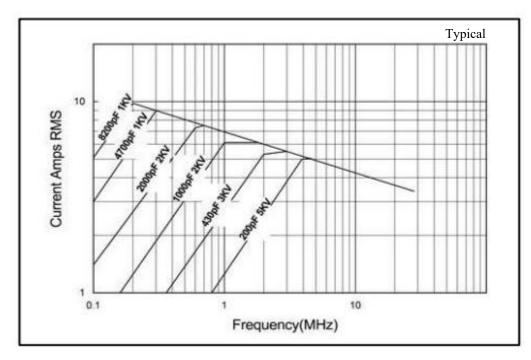




### **Strip Terminals Rated Current vs. Frequency**



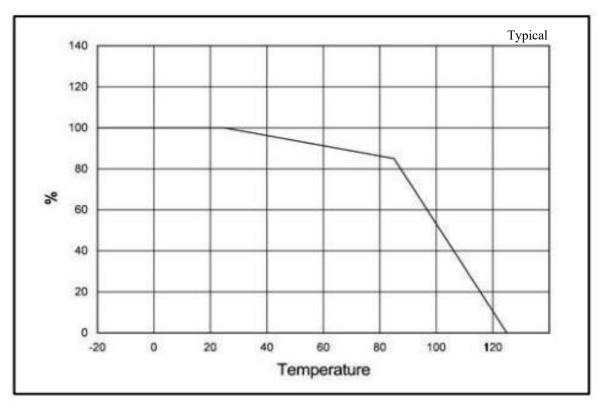
## **≠** Wire Terminals Rated Current vs. Frequency







#### # % Maximum Current vs. Ambient Temperature



#### **‡** Recommended Land Pattern Dimensions

Regarding Landing Patterns, please refer to IPC-7351B (Table 3-5, 3-6).

#### Custom Assemblies

Passive Plus offers Capacitor Assemblies for high power requirements. Typical assemblies are configured in series and/or parallel combinations, producing higher voltage/current handling capabilities, extended capacitance range and tighter tolerances.

To get started, simply send us either a mechanical drawing or circuit conditions and we can recommend a solution. All components are 100% upscreened for Partial Discharge and Sonoscanned. All assemblies include a 100hr Military burn in.







## **UHF/RF High-Q Power Transmitter Multi-Layer Ceramic Capacitors**

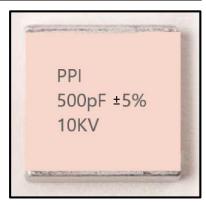
1313C (1.30" x 1.30")

#### **Product Features**

- High Q
- High RF Current/Voltage
- Ultra Stable Performance
- Capacitance Range: 200pF to 120000pF
- Working Voltage: 10000V

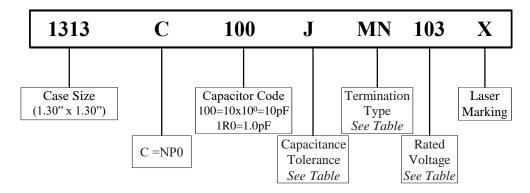
### **#** Typical Circuit Applications

- Semiconductor Manufacturing
- High Energy Power Transfers
- Plasma Chambers
- Medical Equipment



Marking shown for illustration purposes only. Actual marking may differ.

#### **‡** Part Numbering



#### **÷** Capacitance Tolerance Codes

Code	G	J	K
Tol.	±2%	±5%	±10%

### **≠** Voltage Codes

Voltage	Code
1000V	102
3000V	302
5000V	502
10000V	103





#### **≠** 1313C Capacitance Values

For special capacitances, tolerances and WVDC, please contact PPI.

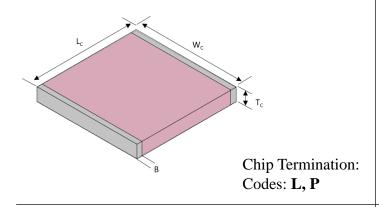


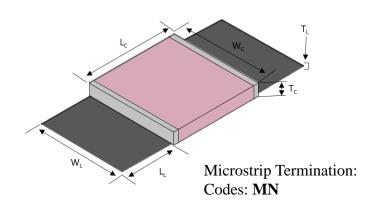
Marking shown for illustration purposes only. Actual marking may differ.

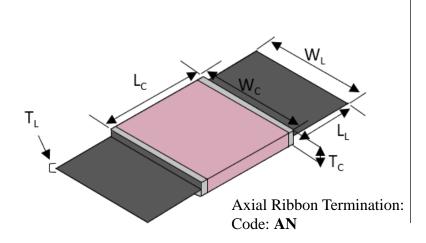
Cap. pF	Cap Code	Tol.	Rated WVDC	Cap. pF	Cap Code	Tol.	Rated WVDC	Cap. pF	Cap Code	Tol.	Rated WVDC
200	201			1800	182			12000	123		
220	221			2200	222	G,J, K	10kV	15000	153		
270	271			2700	272			22000	223	J,K	3000V
300	301			3300	332			33000	333	J,IX	3000 V
330	331			4700	472			47000	473		
390	391			5100	512	0.1		56000 68000 82000	563		
470	471	G,J, K	10kV	5600	562	G,J, K	5000V		683	J,K	1000V
560	561			6800	682				823		
680	681			7500	752			100000	104		
820	821			10000	103			120000	124		
1000	102										
1200	122										
1500	152										

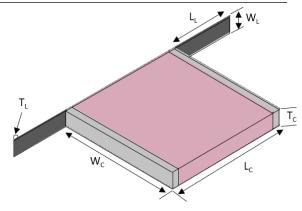


#### **#** Termination Types and Codes









Radial Wire Termination: Codes: **FN** 

Termination Code	Magnetic Termination
L	90% Sn10%Pb Tin/Lead Solder over Nickel Plating

Terminat Code	ion	Non-Magnetic Terminations
Р (	ROHS	100%Sn Solder over Copper Plating
MN (	RoHS	· · · · · ·
AN (	RoHS	Silver-Plated Copper
FN (	ROHS	

Note: "Non-Magnetic" means no magnetic materials.





#### UHF/RF High-Q Power Transmitter Multi-Layer Ceramic Capacitors

1313C (1.30" x 1.30")

**Dimensions** - For Termination Types images, see previous page Unit: inch (millimeter)

	Magnetic Termination									
			Capacitor D	Dimensions		]	Lead Dimensi	ons		
Code		Length	Width Thickness		Overlap	Length	Width	Thickness		
		Lc	Wc	Тс	В	LL	WL	TL		
T	Chin	$1.350 \pm 0.050$	$1.350 \pm 0.050$	0.197 max	$0.039 \sim 0.071$					
L	Chip	$(34.29 \pm 1.27)$	$(34.29 \pm 1.27)$	(5.00 max)	$(1.00 \sim 1.80)$	-	-			

<b>(</b>	Non-Magnetic Termination								
	Capacitor Dimensions					<b>Lead Dimension</b>	ons		
	Code	Length	Width	Thickness	Overlap	Length	Width	Thickness	
		Lc	Wc	Тс	В	LL	WL	TL	
D	CI.	$1.350\pm0.050$	$1.350 \pm 0.050$	0.197 max	$0.039 \sim 0.071$	0.039 ~ 0.071			
Р	Chip	$(34.29 \pm 1.27)$	$(34.29 \pm 1.27)$	(5.00 max)	$(1.00 \sim 1.80)$	-	-	-	
MNI	Mionostuin	$1.350 \pm 0.050$	$1.350 \pm 0.050$	0.197 max		0.748 min	$1.299 \pm 0.020$	$0.012 \pm 0.001$	
MN	Microstrip	$(34.29 \pm 1.27)$	$(34.29 \pm 1.27)$	(5.00 max)	-	(19.0 min)	$(33.00 \pm 0.50)$	$(0.30 \pm 0.025)$	
AN	Axial	$1.350 \pm 0.050$	$1.350 \pm 0.050$	0.197 max		0.748 min	$1.299 \pm 0.020$	$0.012 \pm 0.001$	
AN	Ribbon	$(34.29 \pm 1.27)$	$(34.29 \pm 1.27)$	(5.00 max)	-	(19.0 min)	$(33.00 \pm 0.50)$	$(0.30 \pm 0.025)$	
FN	Radial	$1.350 \pm 0.050$	$1.350 \pm 0.050$	0.197 max		0.699 min	$0.157 \pm 0.010$	$0.008 \pm 0.001$	
I'IN	Ribbon	$(34.29 \pm 1.27)$	$(34.29 \pm 1.27)$	(5.00 max)	-	(17.0 min)	$(4.00 \pm 0.25)$	$(0.20 \pm 0.025)$	

Note: Non-Magnetic means no magnetic materials. All leads are attached with high temperature solder and parts are RoHS Compliant.





#### **#** Electrical Specifications

Quality Factor (Q)	No less than 1000pF, Q value more than 2000, Test Frequency 1MHz; More than 1000pF, Q value more than 2000, Test Frequency 1kHz
Insulation Resistance (IR)	Test Voltage: 500V 10 <sup>5</sup> Megaohms min. @ +25°C rated WVDC 10 <sup>4</sup> Megaohms min. @ +125°C rated WVDC
Rated Voltage	See Rated Voltage Table
Dielectric Withstanding Voltage (WVDC)	250% of Voltage of 5 seconds, Rated Voltage ≤ 500VDC 150% of Voltage for 5 seconds, 500VDC <rated 1250="" vdc<br="" voltage="" ≤="">120% of Voltage for 5 seconds, Rated Voltage &gt; 1250 VDC</rated>
Operating Temperature Range	-55°C to 175°C
Temperature Coefficient (TC)	-55°C to 125°C
Capacitance Drift	$\pm 0.02\%$ or $\pm 0.02$ pF, whichever is greater
Piezoelectric Effects	None
Termination Type	See Termination Type Table
	1

Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.

## **=** Environmental Specifications

#### **Specification**

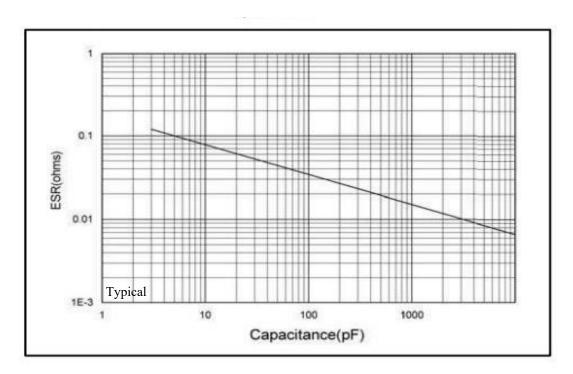
#### **Test Parameters**

Thermal Shock	<b>DWV:</b> The initial value <b>IR:</b> Shall not be less than 30% of the initial value. <b>Capacitance Change:</b>	MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 175°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles.
Moisture Resistance	No more than 0.5% or 0.5pF, whichever is greater.	MIL-STD-202, Method 106
Humidity (Steady State)	<b>DWV:</b> The initial value <b>IR:</b> The initial value <b>Capacitance Change:</b> No more than 0.3% or 0.3pF, whichever is greater.	MIL-STD-202, Method 103, Condition A With 1.5Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours minimum.
Life	IR: Shall not be less than 30% of the initial value.  Capacitance Change: No more than 2.0% or 0.5pF, whichever is greater.	MIL-STD-202, Method 108. For 2000 hours, at 125°C. 200% of Voltage for Capacitors, Rated Voltage ≤ 500VDC; 120% of Voltage for Capacitors, 500VDC< Rated Voltage ≤1250VDC; 100% for Voltage for Capacitors, Rated Voltage >1250VDC
Terminal Strength	Force: 30lbs. min.  Duration Time: 5 to 10 seconds	MIL-STD-202, Method 211A, Test Condition A. Applied a force and maintained for a period of 5 to 10 seconds. The force shall be in the direction of the axes of the terminations.

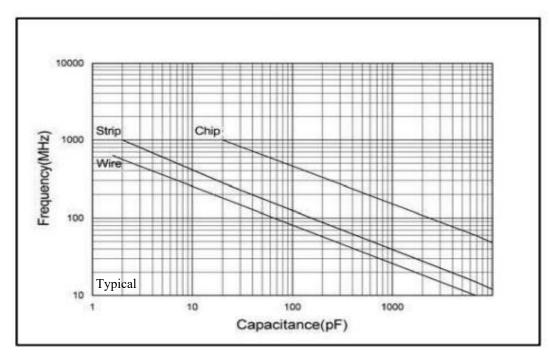




## **ESR vs. Capacitance Measured @ 30MHz**



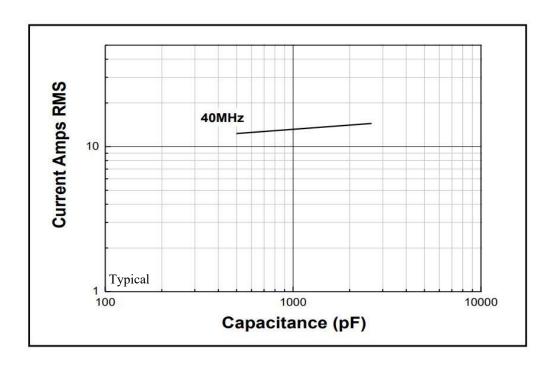
## **Self Resonant Frequency vs. Capacitance**







#### **#** Rated Current vs. Frequency



#### **‡** Recommended Land Pattern Dimensions

Regarding Landing Patterns, please refer to IPC-7351B (table 3-5, 3-6).

#### **#** Custom Assemblies

Passive Plus offers Capacitor Assemblies for high power requirements. Typical assemblies are configured in series and/or parallel combinations, producing higher voltage/current handling capabilities, extended capacitance range and tighter tolerances.

To get started, simply send us either a mechanical drawing or circuit conditions and we can recommend a solution. All components are 100% upscreened for Partial Discharge and Sonoscanned. All assemblies include a 100hr Military burn in.







## **Custom Capacitor Assemblies**





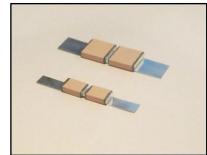




















Marking shown for illustration purposes only. Actual marking may differ.

Please contact PPI (sales@passiveplus.com) to discuss custom assembly options.



## **Custom Capacitor Assemblies**

#### **Product Features**

High Operating Voltage, High Operating Current, Extended Capacitance, Tighter Tolerances, High Reliability, High Q, Ultra-low ESR, Non-Magnetic

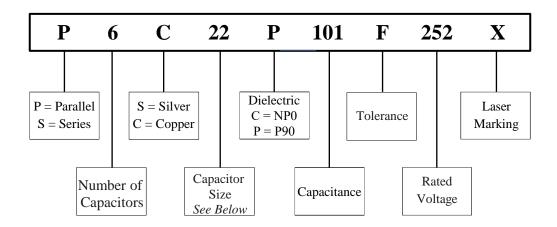
#### **#** Typical Applications Field

High Power RF, Medical Electronics, Broadcast, Semiconductor Manufacturing, High Magnetic Environments, Inductive Heating



Marking shown for illustration purposes only. Actual marking may differ.

#### 茾 Part Numbering



#### Capacitor Size:

$$11 = 1111$$
;  $22 = 2225$ ;  $38 = 3838$ ;  $60 = 6040$ ;  $76 = 7676$ 

Capacitance: For capacitor values requiring 3 significant digits,

e.g. 
$$1222.5pF = 1222R5$$

Silver bracket assembly with six 2225C pieces in parallel, Capacitance is 100pF,

Capacitance tolerance is ±1%, WVDC is 2500 V and Laser marking.

Silver bracket assembly with two 2225C pieces in series, Capacitance is 1222.5pF,

Capacitance tolerance is ±2%, WVDC is 20,000V and Laser marking.

#### Capacitance and Voltage

By Buyer's requirements using existing drawings, mechanical sketches, or we can help with capable modeling of assemblies thermal rise predictions.





## **Custom Capacitor Assemblies**

#### **Typical Assembly Configurations**

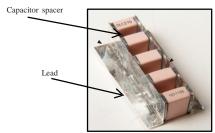
#### Parallel Assemblies

unit:inch (millimeter)

	1111C/P	22225C/P	3838C/P	6040C	7676C		
Lead Material	Silver plated Copper or Silver						
Lead Thickness	.004	or .010 (0.1 or 0	.010 or .020 (0.25 or 0.51)				
Lead Length (max.)	.50 (12.7) .75 (19.8) 2.0 (50.8)			50.8)			
Capacitor Spacer (typ.)	.05	50 or .078 (1.3 or	.090 (2.3)	.050 or .157 (1.3 or 4)			

#### **Mounting Configuration**

## Horizontal / Vertical



Marking illustration purposes only. Actual marking may differ.



#### Series Assemblies

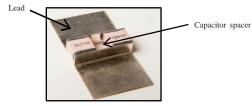
unit:inch (millimeter)

	22225C/P	3838C/P	6040C	7676C			
Lead Type		L Br	acket				
Lead Material		Silver plated C	opper or Silver				
Lead Thickness	.010	( 0.25)	.010 or .020 (0.25 or 0.51)				
Lead Length (max.)	.75 (19.8)	1.0 (25.4)					
Capacitor Spacer (typ.)	.050 or .157 (1.3 or 4)						
Mounting Configuration	Horizontal						

• Epoxy Molding Available



Other Assemblies: By Buyer's requirement. Contact PPI.



Marking shown for illustration purposes only. Actual marking may differ.





## **EIA Low ESR Microwave Capacitors**

#### Product Features

- Lowest ESR
- Low Noise
- High Self-Resonance

#### **÷** Product Applications

#### **Typical Functional Applications**

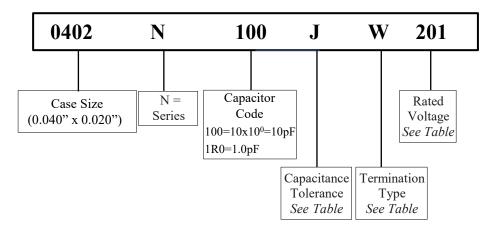
- Tuning Bypass Coupling
- Feedback D.C. Blocking
- Impedance Matching

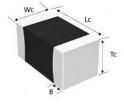


#### **Typical Circuit Applications**

- UHF/Microwave RF Power Amplifiers
- Mixers Oscillators Filter Networks
- Low Noise Amplifiers Timing Circuits and Delay Lines

#### Part Numbering





### **≠** Case Size (Chip) Dimensions

	0201	0402	0603	0708	0805	1111
Length Lc	$0.024 \pm 0.001$ $(0.60 \pm 0.03)$	$0.040 \pm 0.004 \\ (1.02 \pm 0.10)$	$0.062 \pm 0.006$ $(1.57 \pm 0.15)$	$0.065 \pm 0.006$ $(1.65 \pm 0.15)$	$0.080 \pm 0.008$ $(2.03 \pm 0.20)$	$0.110 \begin{array}{c} +0.020 \\ -0.010 \end{array}$ $(2.79 \begin{array}{c} +0.51 \\ -0.25 \end{array})$
Width Wc	$0.012 \pm 0.001$ $(0.30 \pm 0.03)$	$0.020 \pm 0.004$ $(0.51 \pm 0.10)$	$0.032 \pm 0.006$ $(0.81 \pm 0.15)$	$0.080 \pm 0.006$ $(2.02 \pm 0.15)$	$0.050 \pm 0.008$ $(1.27 \pm 0.20)$	$0.110 \pm 0.015$ $(2.79 \pm 0.38)$
Thickness Tc	$0.012 \pm 0.001 \\ (0.30 \pm 0.03)$	$0.020 \pm 0.004 \\ (0.51 \pm 0.10)$	$0.030 \begin{array}{l} +0.005 \\ -0.003 \end{array}$ $(0.76 \begin{array}{l} +0.20 \\ -0.08 \end{array})$	$0.100 \pm 0.008$ $(2.54 \pm 0.20)$	$0.040 \pm 0.006 \\ (1.02 \pm 0.15)$	0.10 max (2.60 max)
Overlap B	0.008 (0.20)	$0.010 \pm 0.006 \\ (0.25 \pm 0.15)$	$0.014 \pm 0.006 \\ (0.35 \pm 0.15)$	$0.020 \pm 0.004 \\ (0.50 \pm 0.10)$	$0.020 \pm 0.010 \\ (0.50 \pm 0.25)$	0.015 max (0.025 max)





## **EIA Low ESR Microwave Capacitors**

#### **#** Temperature Coefficient

 $N: 0\pm30 ppm/^{\circ}C$ 

## **#** Rated Capacitance

Capacitance is less than 10pF; for example: 1R0=1.0pF, R denotes decimal point Capacitance greater than 10pF; for example: 101=100pF, the third number is the power of 10

#### **†** Tolerance

	Capacitance Tolerance									
Code	A	В	C	D	F	G	J	K		
Tolerance	±0.05pF	±0.1pF	±0.25pF	±0.5pF	±1%	±2%	±5%	±10%		

## **†** Termination Types and Codes

Termination Code	Туре	Magnetic Termination
W ROHS	Chip	100% Sn Solder over Nickel Plating
L	Chip	90% Sn10%Pb Tin/Lead Solder over Nickel Plating

### **≠** Voltages

Code	Rated Voltage					
250	25V					
500	50V					
251	250V					
501	500V					
102	1000V					





## **EIA Low ESR Microwave Capacitors**

#### **±** Laser Marking

An "X" at the end of the part number indicates the part is marked.

Laser Marking is available on the 0805N & 1111N case sizes.

#### **Packing Orientation Option**

TV: Tape carrier packaging Vertical Orientation.

Vertical orientation means that if the part is lifted from the tape without any rotation and placed on a substrate, its electrodes will be perpendicular to the substrate plane. This extends the frequency of the First Parallel Resonance (FPR), typically twice the FPR of an equivalent part mounted horizontally.

#### **Performance Requirements**

Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.

All products are in compliance with RoHS instruction.







0201N (0.020" x 0.010")

#### **Product Features**

- High Q
- High Power
- Low ESR/ESL
- Low Noise
- High Self-Resonance
- Ultra Stable Performance
- Capacitance Range: 0.1pF to 47pF
- Working Voltage: 50V

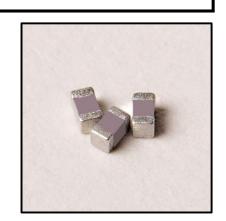
#### **†** Product Applications

#### **Typical Functional Applications:**

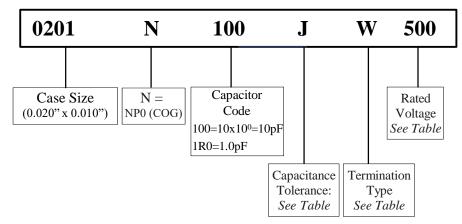
- Tuning Bypass Coupling
- Feedback D.C. Blocking
- Impedance Matching

#### **Typical Circuit Applications:**

- UHF/Microwave RF Power Amplifiers
- Mixers Oscillators Filter Networks
- Low Noise Amplifiers Timing Circuits and Delay Lines

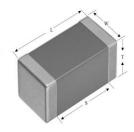


### Part Numbering



### **†** Capacitor Dimensions Unit: inch (millimeter)

Code	Term.	Length	Width	Thickness	Overlap	
		Lc	Wc	Tc	В	
W	Chip	$0.024 \pm 0.001$ $(0.60 \pm 0.03)$	$0.012 \pm 0.001 \\ (0.30 \pm 0.03)$	$0.012 \pm 0.001 \\ (0.30 \pm 0.03)$	0.008 (0.20)	



### Capacitance Tolerance Codes

Code	A	В	C	D	F	G	J	K
Tol.	±0.05pF	±0.1pF	±0.25pF	±0.5pF	±1%	±2%	±5%	±10%





## $0201N (0.020" \times 0.010")$

#### **=** Terminations Type and Code

# **≠** Voltage Codes

Termination Code		Termination				
W	RoHS	100% Tin Solder over Nickel Barrier				

Voltage	Code
25V	250
50V	500



#### **≠** 0201N Capacitance Values

For special capacitances, tolerances and WVDC, please contact PPI.

Cap.	Cap. Cap		Rated	Rated WVDC		Сар	- 1	Rated	Rated WVDC		Cap	<b>-</b> 1	Rated WVD	
pF	Code	Tol.	Std.	Ext.	pF	Code	de Tol.	Std.	Ext.	pF	Code	Tol.	Std.	Ext.
0.1	OR1				2.2	2R2			25V 50V	16	160			
0.2	OR2				2.4	2R4	A*,B, C,			18	180			
0.3	OR3				2.7	2R7		25V		20	200			
0.4	OR4				3.0	3R0				22	220			
0.5	OR5				3.3	3R3				24	240	F,G, J,K		
0.6	OR6				3.6	3R6				27	270		25V	50V
0.7	OR7				3.9	3R9				30	300			
0.8	OR8				4.3	4R3				33	330			
0.9	OR9			5V 50V	4.7	4R7				36	360			
1.0	1R0				5.1	5R1	B,C,	25V	50V	39	390			
1.1	1R1	A*,B, C,	25V		5.6	5R6				43	430			
1.2	1R2	C,			6.2	6R2				47	470			
1.3	1R3				6.8	6R8								
1.4	1R4				7.5	7R5								
1.5	1R5				8.2	8R2								
1.6	1R6				9.1	9R1								
1.7	1R7				10	100	F,G, J,K							
1.8	1R8				11	110			50V					
1.9	1R9				12	120		25V						
2.0	2R0				13	130		20150305						
2.1	2R1				15	150								

<sup>\*</sup>For A-tolerance parts, contact factory for availability





# **‡** Electrical Specifications

Quality Factor (Q)	2,000 at 1 MHz min.
Insulation Resistance (IR)	10 <sup>5</sup> Megaohms min. @ +25°C rated WVDC 10 <sup>4</sup> Megaohms min. @ +125°C rated WVDC
Rated Voltage	25V or 50V
Dielectric Withstanding Voltage (WVDC)	250% of Rated Voltage of 5 seconds
Operating Temperature Range	-55°C to 175°C
Temperature Coefficient (TC)	0±30ppm/°C
Capacitance Drift	±0.02% or ±0.02pF, whichever is greater
Piezoelectric Effects	None

# **=** Environmental Specifications

### **Specification** Test Parameters

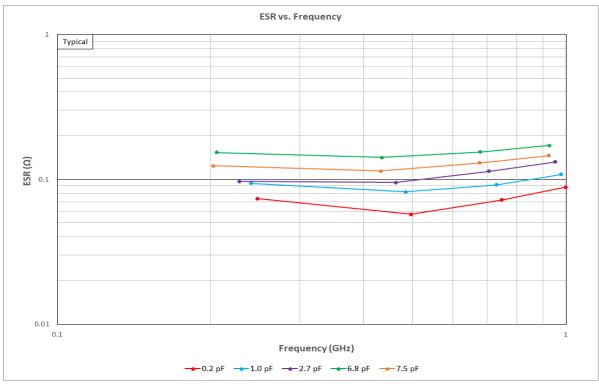
	£	
Thermal Shock	No mechanical damage  Capacitance Change: ±0.5% or 0.5pF max  IR: >10 G Ohms  Q>2000  Breakdown Voltage: 2.5x WVDC	MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 175°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles.
Humidity (Steady State)	No mechanical damage  Capacitance Change: ±0.5% or 0.5pF max  IR: >1 G Ohms  Q>300  Breakdown Voltage: 2.5x WVDC	MIL-STD-202, Method 106
Low Voltage Humidity	No mechanical damage	MIL-STD-202, Method 103, Condition A, with 1.5 Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours minimum.
Life	No mechanical damage  Capacitance Change: ±2.0% or 0.5pF max  IR: >1 G Ohms  Q>500  Breakdown Voltage: 2.5x WVDC	MIL-STD-202, Method 108. For 1000 hours, at 175°C. 200% of Voltage for Capacitors
Terminal Adhesion	Termination should not pull off. Ceramic should remain undamaged	Linear pull force exerted on axial leads soldered to each terminal 2.0lbs.
Resistance to Soldering Heat	No mechanical damage  Capacitance Change: -1.0%~+2.0%  IR: >10 G Ohms  Q>500  Breakdown Voltage: 2.5x WVDC	Preheat device to 150°C -180°C for 60 seconds.  Dip in 260°C ±5°C solder for 10 ±1 second.  Measure after 24± 2 hour cooling period.

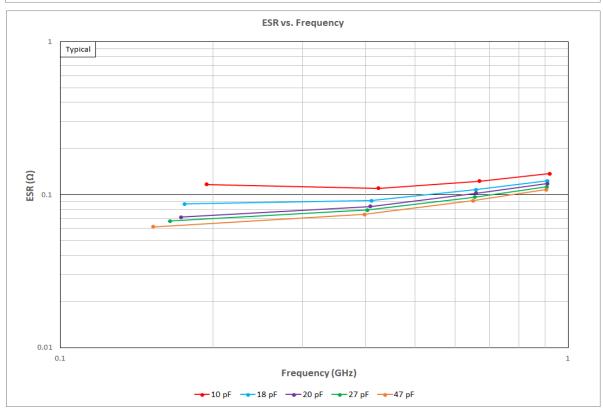
Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.





# **=** ESR vs. Frequency

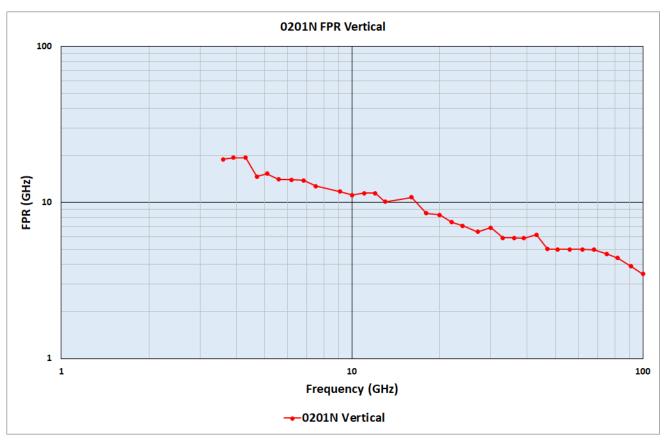








#### **First Parallel Resonance**



### **Definitions** and Measurement Conditions

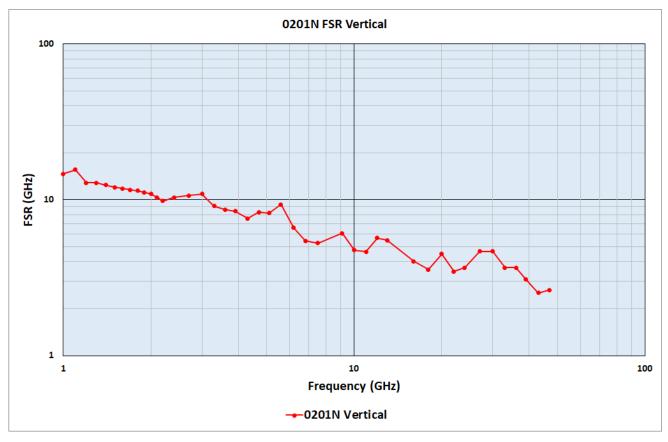
The **First Parallel Resonance**, **FPR**, is defined as the lowest frequency at which a suckout or notch appears in |S21|. It is generally independent of substrate thickness or dielectric constant, but does depend on capacitor orientation. A vertical orientation means the electrode planes are perpendicular to the substrate.

The definitions on the charts are for a capacitor in a series configuration, i.e., mounted across a gap in a microstrip trace with 50-Ohm termination. The measurement conditions are: substrate – Rogers RO3006; substrate dielectric constant = 6.15; substrate thickness (mils) = 10; gap in microstrip trace (mils) = 6.0; microstrip trace width (mils) = 14.1; Reference planes at sample edges.





#### **First Series Resonance**



#### **Definitions** and Measurement Conditions

The **First Series Resonance**, **FSR**, is defined as the lowest frequency at which the imaginary part of the input impedance, Im[Zin], equals zero. Should Im[Zin] or the real part of the input impedance, Re[Zin], not be monotonic with frequency at frequencies lower than those at which Im[Zin] =0, the FSR shall be considered as undefined (represented as a gap in the plot). FSR is dependent on internal capacitor structure; substrate thickness and dielectric constant; capacitor orientation, as defined alongside the FPR plot; and mounting pad dimensions.

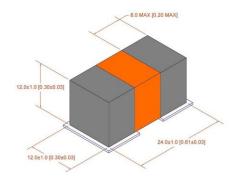
The definitions on the charts are for a capacitor in a series configuration, i.e., mounted across a gap in a microstrip trace with 50-Ohm termination. The measurement conditions are: substrate – Rogers RO3006; substrate dielectric constant = 6.15; substrate thickness (mils) = 10; gap in microstrip trace (mils) = 6.0; microstrip trace width (mils) = 14.1; Reference planes at sample edges.





### **†** Capacitor Application Program

PPI's brand new online Capacitor Application Program (C.A.P.) helps Engineers and Designers select capacitors according to parameters such as cap value and frequency. C.A.P. allows engineers to insert capacitors requirements (Cap value, Frequency), producing Scattering Matrices (S2P) Charts while providing options (Case Size, Terminations, Mounting), and parameters (ESR, Q, Impedance) along with Datasheets. Once engineers have determined their capacitor requirements, C.A.P. also includes online Requests For Quotes (RFQs) and/or sample requests.



## **#** Modelithics Vendor Program

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#### **Recommended Land Pattern Dimensions**

Regarding Landing Patterns, please refer to IPC-7351B (table 3-5, 3-6).

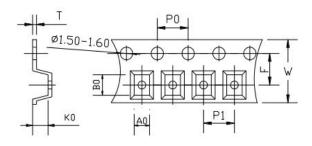




## **†** Tape & Reel Specifications Dimensions: mm

Orientation	Measurement Unit	W	P0	P1	Т	F	Minimum Qty per Reel	Std Qty per Reel	Tape Material
Н	in.	0.315	0.157	0.079	0.017	0.138	1000	15000	Paper
11	mm	8.00	4.00	2.00	0.42	3.50	1000	13000	1 apei





#### $A_0B_0K_0$

- Determined by component size. Typical clearance between the cavity and the component is: .50 (.002) min to .65 (.026) max for 12mm tape.
- The component cannot rotate more than 20° within the determined cavity.

### **=** Engineering Design Kits

PPI offers Design Kits for engineers who are building and testing prototypes. Each kit contains 10 pieces per value.

Kits are 100% RoHS compliant.

Kit Number	Value Range	Values	
DKD0201N01	0.1 - 2.0pF	0.1, 0.2, 0.3, 0.5, 0.7, 0.8, 0.9, 1.0, 1.3, 1.5, 1.7, 1.9, 2.0pF	RoHS
DKD0201N02	1.0 - 10pF	1.0, 1.3, 1.5, 1.7, 1.9, 2.0, 2.2, 2.7, 3.0, 3.9, 4.7, 5.6, 6.8, 7.5, 8.2, 10pF	RoHS
DKD0201N03	10 - 47pF	10, 13, 15, 18, 20, 22, 27, 30, 39, 47pF	1











0402N (0.040" x 0.020")

### **†** Product Features

- High Q
- High Power
- Low ESR/ESL
- Low Noise
- High Self-Resonance
- Ultra Stable Performance
- Capacitance Range: 0.1pF to 33pF
- Working Voltage: 200V

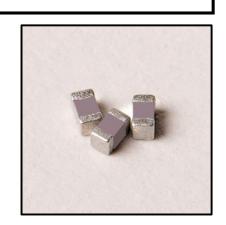
### **†** Product Applications

#### **Typical Functional Applications:**

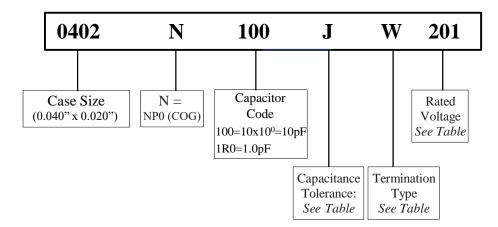
- Tuning Bypass Coupling
- Feedback D.C. Blocking
- Impedance Matching

### **Typical Circuit Applications:**

- UHF/Microwave RF Power Amplifiers
- Mixers Oscillators Filter Networks
- Low Noise Amplifiers Timing Circuits and Delay Lines



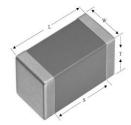
## Part Numbering



# **‡** Capacitor Dimensions Unit:

Unit: inch (millimeter)

Code	Term.	Length Width		Thickness	Overlap		
		Lc	Wc	Tc	В		
W	Chip	$0.040 \pm 0.004$ $(1.02 \pm 0.10)$	$0.020 \pm 0.004$ $(0.51 \pm 0.10)$	$0.020 \pm 0.004$ $(0.51 \pm 0.10)$	0.010±0.006 (0.25±0.15)		



# **÷** Capacitance Tolerance Codes

Code	A	В	C	D	F	G	J	K
Tol.	±0.05pF	±0.1pF	±0.25pF	±0.5pF	±1%	±2%	±5%	±10%





**Termination Code** 

W

0402N (0.040" x 0.020")

# **#** Terminations Type and Code

on	Termination
RoHS	100% Tin Solder over Nickel Barrier

# **≠** Voltage Codes

Voltage	Code
50V	500
200V	201
250V	251



# **≠** 0402N Capacitance Values

For special capacitances, tolerances and WVDC, please contact PPI.

Cap.	Сар	Tol.	Rated	WVDC	Cap.	Сар	Tol	Tol. Rated WVDC		Cap.	Сар	Tol.	Rated	WVDC						
pF	Code	101.	Std.	Ext.	pF	Code	101.	Std.	Ext.	pF	Code	101.	Std.	Ext.						
0.1	OR1				1.7	1R7	A,B,	50V		6.8	6R8		501							
0.2	OR2				1.8	1R8	C,D	or	250V	7.5	7R5	A,B,	50V or	N/A						
0.3	0R3				1.9	1R9		200V		8.2	8R2	С	200V	.,,						
0.4	0R4				2.0	2R0				9.1	9R1									
0.5	OR5				2.1	2R1				10	100									
0.6	OR6		501				2.2	2R2	ΛР	50V		11	110							
0.7	OR7				<b>21</b> 2D1	2.4	A,B, or 2 C,D 200V		12	120										
0.8	OR8	A,B,	50V or	250V	2.7	2R7			2R7 3R0					200V		13	130			
0.9	OR9	C,D	200V	2301	3.0	3R0								15	150	F,G,	50V			
1.0	1R0				3.3	3R3				16	160	J,K	or	N/A						
1.1	1R1				3.6	3R6				18	180		200V							
1.2	1R2				3.9	3R9				20	200									
1.3	1R3				4.3	4R3	A,B,	50V		22	220									
1.4	1R4				4.7	4R7	C,D	or	N/A	24	240									
1.5	1R5				5.1	5R1		200V		27	270									
1.6	1R6				5.6	5R6				30	300	F,G,	50V	N/A						
					6.2	6R2				33	330	J,K	300	14/74						





0402N (0.040" x 0.020")

# **#** Electrical Specifications

Quality Factor (Q)	2,000 at 1 MHz min.
Insulation Resistance (IR)	10 <sup>5</sup> Megaohms min. @ +25°C rated WVDC 10 <sup>4</sup> Megaohms min. @ +125°C rated WVDC
Rated Voltage	See Rated Voltage
Dielectric Withstanding Voltage (WVDC)	250% of Rated Voltage of 5 seconds
Operating Temperature Range	-55°C to 175°C
Temperature Coefficient (TC)	0±30ppm/°C
Capacitance Drift	±0.02% or ±0.02pF, whichever is greater
Piezoelectric Effects	None

# **÷** Environmental Specifications

### Specification Test Parameters

	±	
Thermal Shock	No mechanical damage  Capacitance Change: ±0.5% or 0.5pF max  IR: >10 G Ohms  Q>2000  Breakdown Voltage: 2.5x WVDC	MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 175°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles.
Humidity (Steady State)	No mechanical damage  Capacitance Change: ±0.5% or 0.5pF max  IR: >1 G Ohms  Q>300  Breakdown Voltage: 2.5x WVDC	MIL-STD-202, Method 106
Low Voltage Humidity	No mechanical damage  Capacitance Change: ±0.3% or 0.3pF max  IR: >1 G Ohms  Q>300  Breakdown Voltage: 2.5x WVDC	MIL-STD-202, Method 103, Condition A, with 1.5 Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours minimum.
Life	No mechanical damage  Capacitance Change: ±2.0% or 0.5pF max  IR: >1 G Ohms  Q>500  Breakdown Voltage: 2.5x WVDC	MIL-STD-202, Method 108. For 1000 hours, at 175°C. 200% of Voltage for Capacitors
Terminal Adhesion	Termination should not pull off. Ceramic should remain undamaged	Linear pull force exerted on axial leads soldered to each terminal 2.0lbs.
Resistance to Soldering Heat	No mechanical damage  Capacitance Change: -1.0%~+2.0%  IR: >10 G Ohms  Q>500  Breakdown Voltage: 2.5x WVDC	Preheat device to 150°C -180°C for 60 seconds.  Dip in 260°C ±5°C solder for 10 ±1 second.  Measure after 24± 2 hour cooling period.

Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.





 $0402N (0.040" \times 0.020")$ 

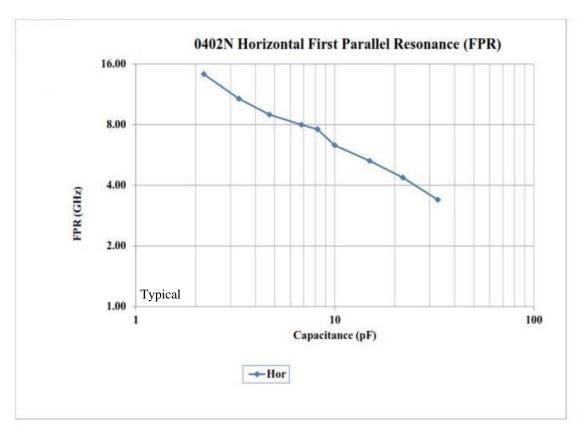
# **ESR** vs. Frequency





 $0402N (0.040^{\circ} \times 0.020^{\circ})$ 

#### **First Parallel Resonance**



#### **Definitions** and Measurement Conditions

The **First Parallel Resonance**, **FPR**, is defined as the lowest frequency at which a suckout or notch appears in |S21|. It is generally independent of substrate thickness or dielectric constant, but does depend on capacitor orientation. A vertical orientation means the electrode planes are perpendicular to the substrate.

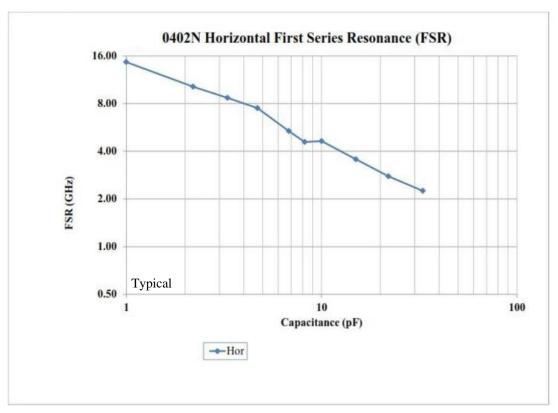
The definitions on the charts are for a capacitor in a series configuration, i.e., mounted across a gap in a microstrip trace with 50-Ohm termination. The measurement conditions are: substrate – Rogers RO4350; substrate dielectric constant = 3.48; substrate thickness (mils) = 10; gap in microstrip trace (mils) = 15; microstrip trace width (mils) = 22; Reference planes at sample edges.





 $0402N (0.040" \times 0.020")$ 

#### First Series Resonance



### **=** Definitions and Measurement Conditions

The **First Series Resonance**, **FSR**, is defined as the lowest frequency at which the imaginary part of the input impedance, Im[Zin], equals zero. Should Im[Zin] or the real part of the input impedance, Re[Zin], not be monotonic with frequency at frequencies lower than those at which Im[Zin] =0, the FSR shall be considered as undefined (represented as a gap in the plot). FSR is dependent on internal capacitor structure; substrate thickness and dielectric constant; capacitor orientation, as defined alongside the FPR plot; and mounting pad dimensions.

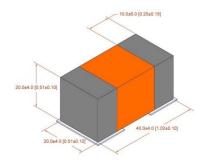
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0402N (0.040" x 0.020"

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#### Recommended Land Pattern Dimensions

Regarding Landing Patterns, please refer to IPC-7351B (table 3-5, 3-6).



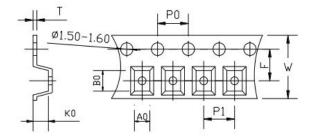


0402N (0.040" x 0.020"

### Tape & Reel Specifications Dimensions: mm

Orientation	Measurement Unit	W	Р0	P1	Т	F	Minimum Qty per Reel	Std Qty per Reel	Tape Material
Н	in. mm	0.315 8.00	0.157 4.00	0.079 2.00	0.003 0.07	0.138 3.50	1000	10000	Paper





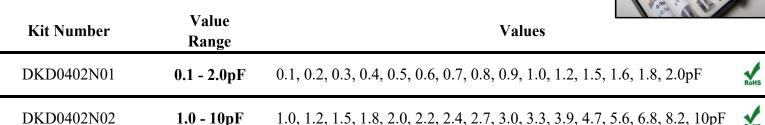
#### $A_0B_0K_0$

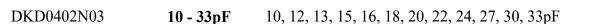
- Determined by component size. Typical clearance between the cavity and the component is: .50 (.002) min to .65 (.026) max for 12mm tape.
- The component cannot rotate more than 20° within the determined cavity.

### **Engineering Design Kits**

PPI offers Design Kits for engineers who are building and testing prototypes. Each kit contains 16 values;10 pieces per value.



















### **Product Features**

- High Q
- High Power
- Low ESR/ESL
- Low Noise
- High Self-Resonance
- Ultra Stable Performance
- Capacitance Range: 0.1pF to 100pF
- Working Voltage: 250V

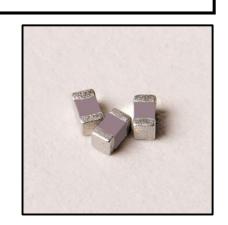
### **†** Product Applications

### **Typical Functional Applications:**

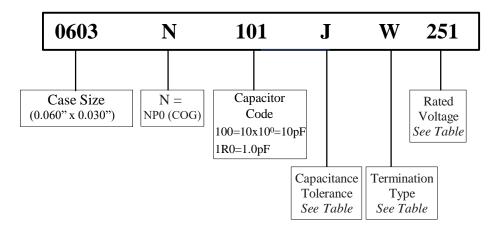
- Tuning Bypass Coupling
- Feedback D.C. Blocking
- Impedance Matching

#### **Typical Circuit Applications:**

- UHF/Microwave RF Power Amplifiers
- Mixers Oscillators Filter Networks
- Low Noise Amplifiers Timing Circuits and Delay Lines



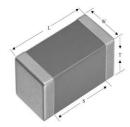
# Part Numbering



# Capacitor Dimensions Un

Unit: inch (millimeter)

Code	Term.	Length	Width	Thickness	Overlap	
		Lc	Wc	Tc	В	
W	Chip	$0.062 \pm 0.006$ $(1.57 \pm 0.15)$		$0.030 \pm 0.005 \text{-} 0.003$ $(0.76 \pm 0.20 \text{-} 0.08)$		



## Capacitance Tolerance Codes

Code	A	В	C	D	F	G	J	K
Tol.	±0.05pF	±0.1pF	±0.25pF	±0.5pF	±1%	±2%	±5%	±10%





# **#** Terminations Types and Codes

Termination Code		Termination		
W	RoHS	100% Tin Solder over Nickel Barrier		
L		90%Tin/10%Lead Solder over Nickel Barrier		

# **≠** Voltage Code

Voltage	Code
250V	251



# **≠** 0603N Capacitance Values

For special capacitances, tolerances and WVDC, please contact PPI.

Cap. pF	Cap Code	Tol.	Rated WVDC	Cap. pF	Cap Code	Tol.	Rated WVDC	Cap. pF	Cap Code	Tol.	Rated WVDC	Cap. pF	Cap Code	Tol.	Rated WVDC
0.1	OR1			1.7	1R7			6.2	6R2			30	300		
0.2	OR2			1.8	1R8			6.8	6R8	A D		33	330		
0.3	OR3			1.9	1R9			7.5	7R5	A,B, C	250V	36	360		
0.4	OR4			2.0	2R0			8.2	8R2			39	390		
0.5	OR5			2.1	2R1			9.1	9R1			43	430		
0.6	OR6			2.2	2R2			10	100			47	470		
0.7	OR7			2.4	2R4			11	110			51	510	F,G,	250V
0.8	OR8	A,B,	250V	2.7	2R7	A,B,	250V	12	120			56	560	J,K	230 V
0.9	OR9	C,D	2300	3.0	3R0	C,D	2300	13	130			62	620		
1.0	1R0			3.3	3R3			15	150	<b>5.</b> C		68	680		
1.1	1R1			3.6	3R6			16	160	F,G, J,K	250V	75	750		
1.2	1R2			3.9	3R9			18	180	•,		82	820		
1.3	1R3			4.3	4R3			20	200			91	910		
1.4	1R4			4.7	4R7			22	220			100	101		
1.5	1R5			5.1	5R1			24	240						
1.6	1R6			5.6	5R6			27	270						





# **‡** Electrical Specifications

Quality Factor (Q)	2,000 at 1 MHz min.
Insulation Resistance (IR)	10 <sup>5</sup> Megaohms min. @ +25°C rated WVDC 10 <sup>4</sup> Megaohms min. @ +125°C rated WVDC
Rated Voltage	250V
Dielectric Withstanding Voltage (WVDC)	250% of Rated Voltage of 5 seconds
Operating Temperature Range	-55°C to 175°C
Temperature Coefficient (TC)	0±30ppm/°C
Capacitance Drift	$\pm 0.02\%$ or $\pm 0.02$ pF, whichever is greater
Piezoelectric Effects	None

# **#** Environmental Specifications

Specification	<b>Test Parameters</b>

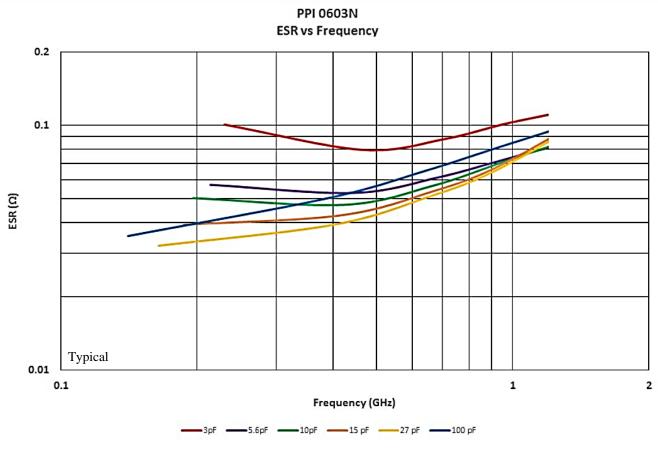
Thermal Shock	No mechanical damage  Capacitance Change: ±0.5% or 0.5pF max  IR: >10 G Ohms  Q>2000  Breakdown Voltage: 2.5x WVDC	MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 175°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles.
Humidity (Steady State)	No mechanical damage  Capacitance Change: ±0.5% or 0.5pF max  IR: >1 G Ohms  Q>300  Breakdown Voltage: 2.5x WVDC	MIL-STD-202, Method 106
Low Voltage Humidity	No mechanical damage	MIL-STD-202, Method 103, Condition A, with 1.5 Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours minimum.
Life	No mechanical damage  Capacitance Change: ±2.0% or 0.5pF max  IR: >1 G Ohms  Q>500  Breakdown Voltage: 2.5x WVDC	MIL-STD-202, Method 108. For 1000 hours, at 175°C. 200% of Voltage for Capacitors
Terminal Adhesion	Termination should not pull off. Ceramic should remain undamaged	Linear pull force exerted on axial leads soldered to each terminal 2.0lbs.
Resistance to Soldering Heat	No mechanical damage  Capacitance Change: -1.0%~+2.0%  IR: >10 G Ohms  Q>500  Breakdown Voltage: 2.5x WVDC	Preheat device to 150°C -180°C for 60 seconds.  Dip in 260°C ±5°C solder for 10 ±1 second.  Measure after 24± 2 hour cooling period.

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### **ESR** vs. Frequency

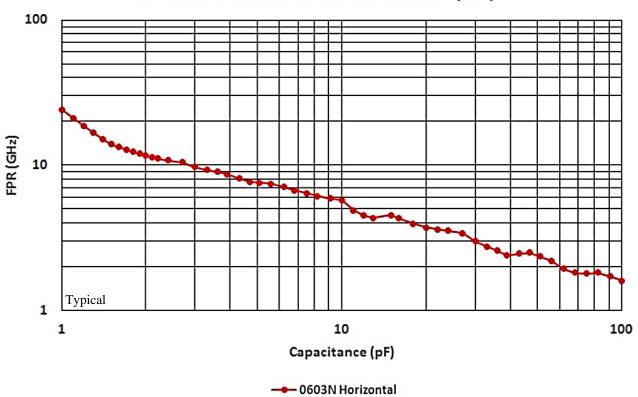






#### First Parallel Resonance

### 0603N Horizontal First Parallel Resonances (FPR)



#### **Definitions** and Measurement Conditions

The **First Parallel Resonance**, **FPR**, is defined as the lowest frequency at which a suckout or notch appears in |S21|. It is generally independent of substrate thickness or dielectric constant, but does depend on capacitor orientation. A vertical orientation means the electrode planes are perpendicular to the substrate.

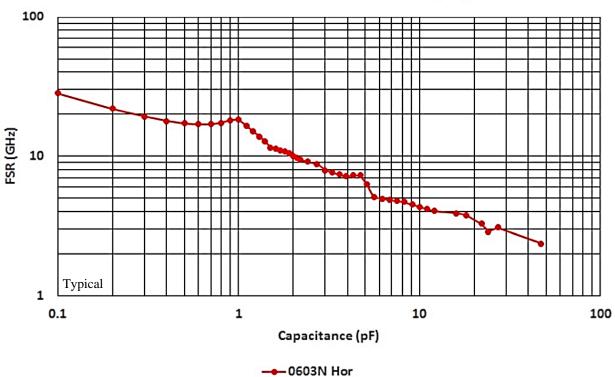
The definitions on the charts are for a capacitor in a series configuration, i.e., mounted across a gap in a microstrip trace with 50-Ohm termination. The measurement conditions are: substrate – Rogers RT/duriod® 5880; substrate dielectric constant = 2.20; substrate thickness (mils) = 10; gap in microstrip trace (mils) = 23.7; microstrip trace width (mils) = 30.0; Reference planes at sample edges.





#### First Series Resonance





#### **Definitions** and Measurement Conditions

The **First Series Resonance**, **FSR**, is defined as the lowest frequency at which the imaginary part of the input impedance, Im[Zin], equals zero. Should Im[Zin] or the real part of the input impedance, Re[Zin], not be monotonic with frequency at frequencies lower than those at which Im[Zin] =0, the FSR shall be considered as undefined (represented as a gap in the plot). FSR is dependent on internal capacitor structure; substrate thickness and dielectric constant; capacitor orientation, as defined alongside the FPR plot; and mounting pad dimensions.

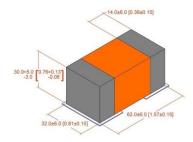
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#### Recommended Land Pattern Dimensions

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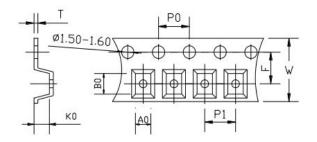




### Tape & Reel Specifications Dimensions: mm

Orientation	Measurement Unit	W	P0	P1	Т	F	Minimum Qty per Reel	Std Qty per Reel	Tape Material
Н	in. mm	0.315 8.00	0.157 4.00	0.157 4.00	0.004 0.10	0.138 3.50	500	4000	Paper





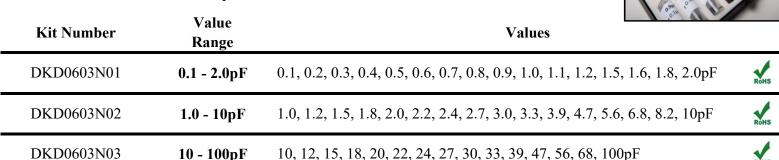
#### $A_0B_0K_0$

- Determined by component size. Typical clearance between the cavity and the component is: .50 (.002) min to .65 (.026) max for 12mm tape.
- The component cannot rotate more than 20° within the determined cavity.

# **Engineering Design Kits**

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 $\overline{0708N}$   $(0.070" \times 0.080")$ 

### **Product Features**

- High Q
- High Power
- Low ESR/ESL
- Low Noise
- High Self-Resonance
- Ultra Stable Performance
- Capacitance Range: 0.1pF to 100pF
- Working Voltage: 500V

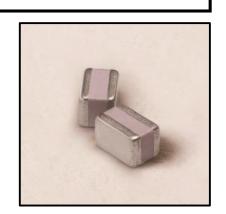
### **÷** Product Applications

### **Typical Functional Applications:**

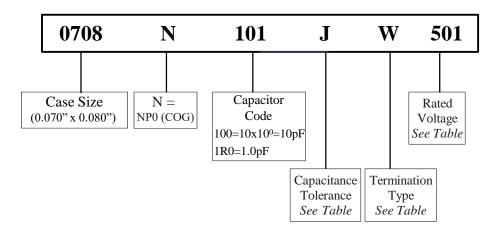
- Tuning Bypass Coupling
- Feedback D.C. Blocking
- Impedance Matching

### **Typical Circuit Applications:**

- UHF/Microwave RF Power Amplifiers
- Mixers Oscillators Filter Networks
- Low Noise Amplifiers Timing Circuits and Delay Lines



# **Part Numbering**



## **Capacitor Dimensions** Unit: inch (millimeter)

Code	Term.	Length	Width	Thickness	Overlap	
		Lc	Wc	Tc	В	
W	Chip	$0.065 \pm 0.006$ $(1.65 \pm 0.15)$	$0.080 \pm 0.006$ $(2.02 \pm 0.15)$	$0.100 \pm 0.008 \\ (2.54 \pm 0.20)$		

## Capacitance Tolerance Codes

Code	В	C	G	J
Tol.	±0.1pF	±0.25pF	±2%	±5%





# **=** Terminations Types and Codes

Termination Code		Termination		
W	RoHS	100% Sn Solder over Nickel Plating		
L		90%Sn10%Pb Tin/Lead		



Voltage	Code
500V	501



# **≠** 0708N Capacitance Values

For special capacitances, tolerances and WVDC, please contact PPI.

Cap. pF	Cap Code	Tol.	Rated WVDC	Cap. pF	Cap Code	Tol.	Rated WVDC	Cap. pF	Cap Code	Tol.	Rated WVDC	Cap. pF	Cap Code	Tol.	Rated WVDC					
1.0	1R0			2.7	2R7			10	100			39	390							
1.1	1R1			3.0	3R0			11	110			43	430							
1.2	1R2			3.3	3R3			12	120			47	470							
1.3	1R3			3.6	3R6			13	130			51	510							
1.4	1R4			3.9	3R9			15	150			56	560							
1.5	1R5			4.3	4R3			16	160			62	620	G,J	500V					
1.6	1R6	B,C	500V	4.7	4R7	B,C 500V	B.C	B.C	B.C	B.C	B.C	B.C	5007	18	<b>18</b> 180 G,J 50	500V	68	680		
1.7	1R7	Б,С	3001	5.1	5R1		20	200	۵,3	3001	75	750								
1.8	1R8			5.6	5R6			22	220			82	820							
1.9	1R9			6.2	6R2			24	240			91	910							
2.0	2R0			6.8	6R8			27	270			100	101							
2.1	2R1			7.5	7R5			30	300											
2.2	2R2			8.2	8R2			33	330											
2.4	2R4			9.1	9R1			36	360											



# **#** Electrical Specifications

Quality Factor (Q)	2,000 at 1 MHz min.
Insulation Resistance (IR)	10 <sup>5</sup> Megaohms min. @ +25°C rated WVDC 10 <sup>4</sup> Megaohms min. @ +125°C rated WVDC
Rated Voltage	500V
Dielectric Withstanding Voltage (WVDC)	250% of Rated Voltage of 5 seconds, Rated Voltage ≤500 VDC
Operating Temperature Range	-55°C to 175°C
Temperature Coefficient (TC)	0±30ppm/°C
Capacitance Drift	$\pm 0.02\%$ or $\pm 0.02$ pF, whichever is greater
Piezoelectric Effects	None

# **#** Environmental Specifications

### **Specification** Test Parameters

	Specification					
Thermal Shock	No mechanical damage  Capacitance Change: ±0.5% or 0.5pF max  IR: >10 G Ohms  Q>500  Breakdown Voltage: 2.5x WVDC	MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 175°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles.				
Humidity (Steady State)	No mechanical damage  Capacitance Change: ±0.5% or 0.5pF max  IR: >1 G Ohms  Q>300  Breakdown Voltage: 2.5x WVDC	MIL-STD-202, Method 106				
Low Voltage Humidity	No mechanical damage	MIL-STD-202, Method 103, Condition A, with 1.5 Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours minimum.				
Life	No mechanical damage  Capacitance Change: ±2.0% or 0.5pF max  IR: >1 G Ohms  Q>500  Breakdown Voltage: 2.5x WVDC	MIL-STD-202, Method 108. For 1000 hours, at 175°C. 200% of Voltage for Capacitors, Rated Voltage ≤ 500VDC				
Terminal Adhesion	Termination should not pull off. Ceramic should remain undamaged	Test per MIL-STD-202, Method 211. Terminations for chips withstand a pull of 5lbs min., 15lbs typical, for 5 seconds in direction perpendicular to the termination surface of the capacitor.				
Resistance to Soldering Heat	No mechanical damage  Capacitance Change: -1.0%~+2.0  IR: >10 G Ohms  Q>500  Breakdown Voltage: 2.5x WVDC	Preheat device to 150°C -180°C for 60 seconds. Dip in 260°C ±5°C solder for 10 ±1 second. Measure after 24± 2 hour cooling period.				

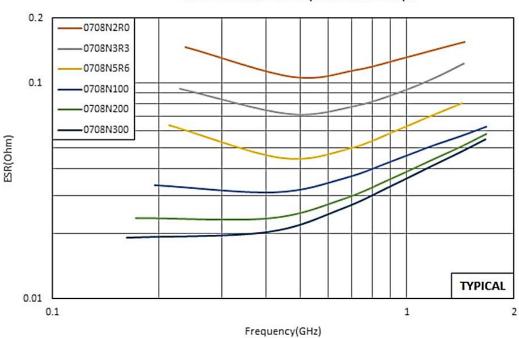
Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.



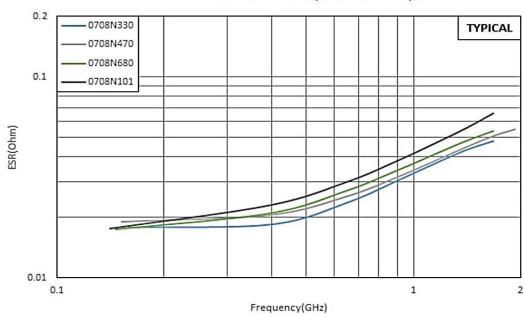


# **ESR** vs. Frequency

# 0708N ESRs for Cap Values ≤ 30 pF



### 0708N ESRs for Cap Values > 30 pF

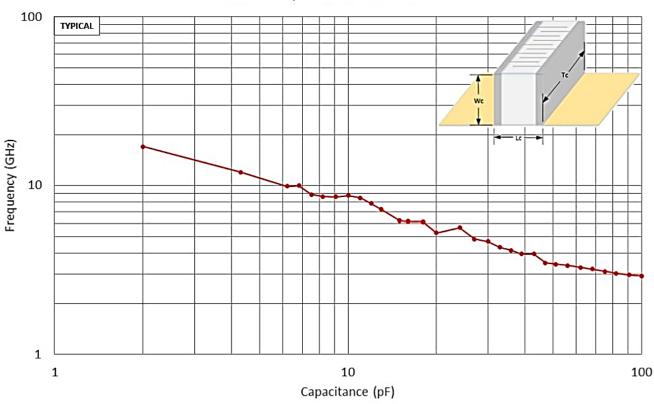






### **First Parallel Resonance**





### **=** Definitions and Measurement Conditions

The **First Parallel Resonance**, **FPR**, is defined as the lowest frequency at which a suckout or notch appears in |S21|. It is generally independent of substrate thickness or dielectric constant, but does depend on capacitor orientation. A vertical orientation means the electrode planes are perpendicular to the substrate.

The definitions on the charts are for a capacitor in a series configuration, i.e., mounted across a gap in a microstrip trace with 50-Ohm termination. The measurement conditions are: substrate – Rogers 3003C; substrate dielectric constant = 3.00; substrate thickness (mils) = 40; gap in microstrip trace (mils) = 28; microstrip trace width (mils) = 100; Reference planes at sample edges.





### **First Series Resonance**

0708N FSR, Vertical Orientation



#### **Definitions** and Measurement Conditions

The **First Series Resonance**, **FSR**, is defined as the lowest frequency at which the imaginary part of the input impedance, Im[Zin], equals zero. Should Im[Zin] or the real part of the input impedance, Re[Zin], not be monotonic with frequency at frequencies lower than those at which Im[Zin] =0, the FSR shall be considered as undefined (represented as a gap in the plot). FSR is dependent on internal capacitor structure; substrate thickness and dielectric constant; capacitor orientation, as defined alongside the FPR plot; and mounting pad dimensions.

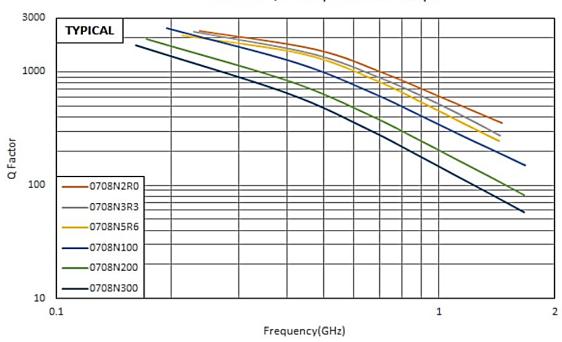
The definitions on the charts are for a capacitor in a series configuration, i.e., mounted across a gap in a microstrip trace with 50-Ohm termination. The measurement conditions are: substrate – Rogers 3003C; substrate dielectric constant = 3.00; substrate thickness (mils) = 40; gap in microstrip trace (mils) = 28; microstrip trace width (mils) = 100; Reference planes at sample edges.



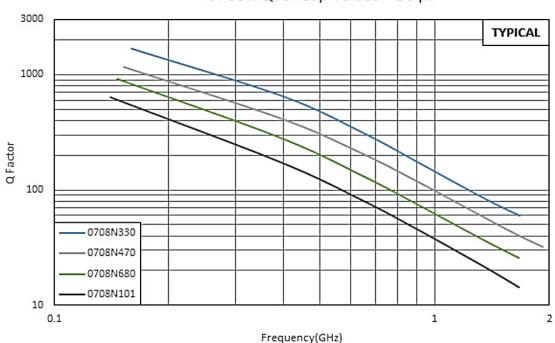


# **≠** Q vs. Capacitance

0708N Q for Cap Values ≤ 30 pF



0708N Q for Cap Values > 30 pF



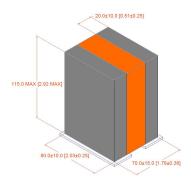




 $\overline{0708N}$  (0.070" x  $\underline{0.080}$ ")

### **†** Capacitor Application Program

PPI's brand new online Capacitor Application Program (C.A.P.) helps Engineers and Designers select capacitors according to parameters such as cap value and frequency. C.A.P. allows engineers to insert capacitors requirements (Cap value, Frequency), producing Scattering Matrices (S2P) Charts while providing options (Case Size, Terminations, Mounting), and parameters (ESR, Q, Impedance) along with Datasheets. Once engineers have determined their capacitor requirements, C.A.P. also includes online Requests For Quotes (RFQs) and/or sample requests.



## **≠** Modelithics Vendor Program

PPI offers design engineers a Free 90-Day Trial license for the Modelithics PPI Component Library. This program provides engineers access to extremely accurate scalable simulation models for Passive Plus capacitors with advanced features that enable a more precise and rapid design process.

Microwave Global Models include every part value in a series and permit users to input substrate thickness, dielectric constant, and loss tangent, as well as mounting pad layout dimensions. Selected models also include capacitor orientation – vertical or horizontal – as an input. Engineers can request FREE use of the models by visiting the https://www.modelithics.com/MVP/PPI.



### **Recommended Land Pattern Dimensions**

Regarding Landing Patterns, please refer to IPC-7351B (table 3-5, 3-6).

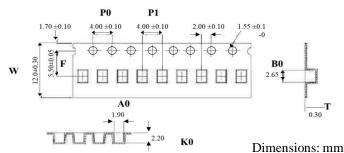




### **†** Tape & Reel Specifications – Vertical Orientation

	Orientation	Measurement Unit	W	Р0	P1	Т	F	Minimum Qty per Reel	Std Qty per Reel	Tape Material
•	V	in. mm	0.472 12.00	0.157 4.00	0.157 4.00	0.012 0.30	0.217 5.50	500	1500	Plastic





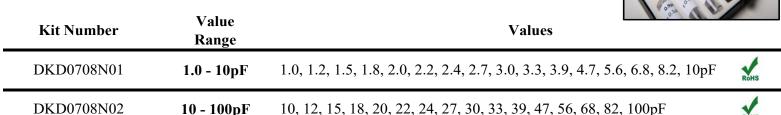
#### $A_0B_0K_0$

- Determined by component size. Typical clearance between the cavity and the component is: .50 (.002) min to .65 (.026) max for 12mm tape.
- The component cannot rotate more than 20° within the determined cavity.

### Engineering Design Kits

PPI offers Design Kits for engineers who are building and testing prototypes. Each kit contains 16 values;10 pieces per value.

Kits are 100% RoHS compliant.











 $0805N (0.080^{\circ} \times 0.050^{\circ})$ 

### **Product Features**

- High Q
- High Power
- Low ESR/ESL
- Low Noise
- High Self-Resonance
- Ultra Stable Performance
- Capacitance Range: 0.1pF to 220pF
- Working Voltage: 250V

### **†** Product Applications

#### **Typical Functional Applications:**

- Tuning Bypass Coupling
- Feedback D.C. Blocking
- Impedance Matching

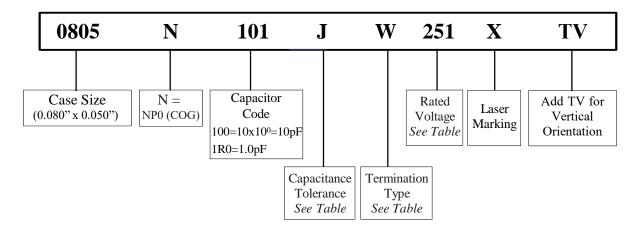
### **Typical Circuit Applications:**

- UHF/Microwave RF Power Amplifiers
- Mixers Oscillators Filter Networks
- Low Noise Amplifiers Timing Circuits and Delay Lines



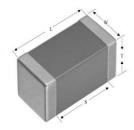
Marking shown for illustration purposes only. Actual marking may

## **Part Numbering**



#### **Capacitor Dimensions** Unit: inch (millimeter)

Code	Term.	Length	Width	Thickness	Overlap
		Lc	Wc	Tc	В
W	Chip	$0.080 \pm 0.008$ (2.03±0.20)	$0.050 \pm 0.008$ $(1.27 \pm 0.20)$		0.020±0.010 (0.50±0.25)



# **Capacitance Tolerance Codes**

Code	A	В	C	D	F	G	J	K
Tol.	±0.05pF	±0.1pF	±0.25pF	±0.5pF	±1%	±2%	±5%	±10%





0805N (0.080" x 0.050")

# **‡** Terminations Types and Codes

Terminat Code	ion	Termination
W	RoHS	100% Tin Solder over Nickel Barrier
L		90%Tin/10%Lead Solder over Nickel Barrier

# **≠** Voltage Code

Voltage	Code
250V	251



# **≠** 0805N Capacitance Values

For special capacitances, tolerances and WVDC, please contact PPI.

Cap. pF	Cap Code	Tol.	Rated WVDC	Cap. pF	Cap Code	Tol.	Rated WVDC	Cap. pF	Cap Code	Tol.	Rated WVDC	Cap. pF	Cap Code	Tol.	Rated WVDC
0.1	OR1			2.1	2R1			13	130			91	910		
0.2	OR2			2.2	2R2			15	150			100	101		
0.3	OR3			2.4	2R4			16	160			110	111		
0.4	0R4			2.7	2R7			18	180			120	121		
0.5	0R5			3.0	3R0			20	200			130	131	F,G,J,K	250V
0.6	OR6			3.3	3R3	A D		22	220			150	151	1,0,3,10	2501
0.7	OR7			3.6	3R6	A,B, C,D	250V	24	240			160	161		
0.8	OR8			3.9	3R9	ŕ		27	270			180	181		
0.9	OR9			4.3	4R3			30	300			200	201		
1.0	1R0	A,B,	250V	4.7	4R7			33	330	F,G,	250V	220	221		
1.1	1R1	C,D	2301	5.1	5R1			36	360	J,K	2301				
1.2	1R2			5.6	5R6			39	390						
1.3	1R3			6.2	6R2			43	430						
1.4	1R4			6.8	6R8			47	470						
1.5	1R5			7.5	7R5	B,C	250V	51	510						
1.6	1R6			8.2	8R2	2,0		56	560						
1.7	1R7			9.1	9R1			62	620						
1.8	1R8			10	100	F,G,		68	680						
1.9	1R9			11	110	J,K	250V	75	750						
2.0	2R0			12	120			82	820						





0805N (0.080" x 0.050")

# **#** Electrical Specifications

Quality Factor (Q)	2,000 at 1 MHz min.
Insulation Resistance (IR)	10 <sup>5</sup> Megaohms min. @ +25°C rated WVDC 10 <sup>4</sup> Megaohms min. @ +125°C rated WVDC
Rated Voltage	250V
Dielectric Withstanding Voltage (WVDC)	250% of Rated Voltage of 5 seconds
Operating Temperature Range	-55°C to 175°C
Temperature Coefficient (TC)	0±30ppm/°C
Capacitance Drift	$\pm 0.02\%$ or $\pm 0.02$ pF, whichever is greater
Piezoelectric Effects	None

# **=** Environmental Specifications

		_
C-	ecifica	4100
.711	14.11.14.2	4116)11

#### **Test Parameters**

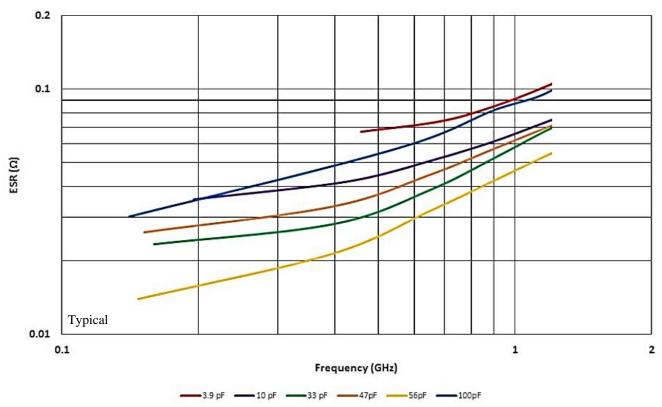
	Specification	1 est 1 at atheters
Thermal Shock	No mechanical damage  Capacitance Change: ±0.5% or 0.5pF max  IR: >10 G Ohms  Q>2000  Breakdown Voltage: 2.5x WVDC	MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 175°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles.
Humidity (Steady State)	No mechanical damage  Capacitance Change: ±0.5% or 0.5pF max  IR: >1 G Ohms  Q>300  Breakdown Voltage: 2.5x WVDC	MIL-STD-202, Method 106
Life	No mechanical damage  Capacitance Change: ±2.0% or 0.5pF max  IR: >1 G Ohms  Q>500  Breakdown Voltage: 2.5x WVDC	MIL-STD-202, Method 108. For 1000 hours, at 175°C. 200% of Voltage for Capacitors, Rated Voltage ≤ 500VDC; 120% of Voltage for Capacitors, 500VDC< Rated Voltage ≤1250VDC; 100% for Voltage for Capacitors, Rated Voltage >1250VDC
Terminal Adhesion	Termination should not pull off. Ceramic should remain undamaged	Linear pull force exerted on axial leads soldered to each terminal. 2.0lbs.
Resistance to Soldering Heat	No mechanical damage  Capacitance Change: -1.0%~+2.0%  IR: >10 G Ohms  Q>500  Breakdown Voltage: 2.5x WVDC	Preheat device to 150°C -180°C for 60 seconds.  Dip in 260°C ±5°C solder for 10±1 second.  Measure after 24± 2 hour cooling period.

Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.





# ESR vs. Frequency 3.9pF to 100pF

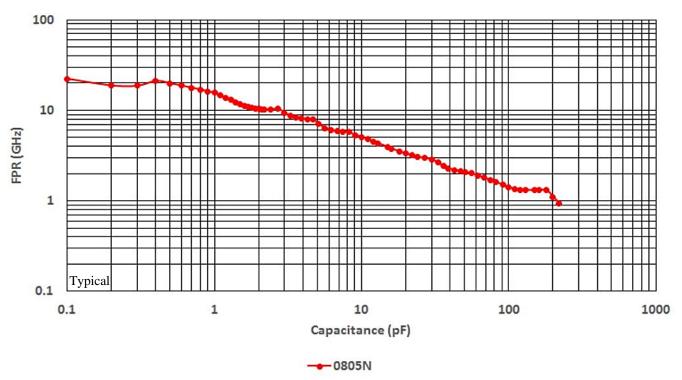




0805N (0.080" x 0.050")



#### **First Parallel Resonance**



#### **Definitions and Measurement Conditions**

The First Parallel Resonance, FPR, is defined as the lowest frequency at which a suckout or notch appears in |S21|. It is generally independent of substrate thickness or dielectric constant, but does depend on capacitor orientation. A horizontal orientation means the capacitor electrode planes are parallel to the plane of the substrate; a vertical orientation means the electrode planes are perpendicular to the substrate.

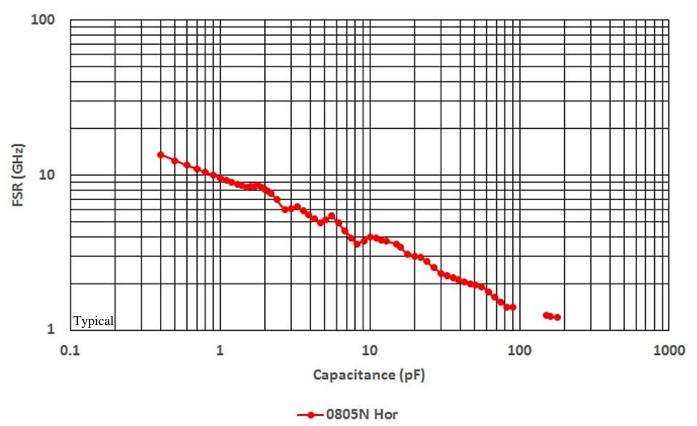
The definitions on the charts are for a capacitor in a series configuration, i.e., mounted across a gap in a microstrip trace with 50-Ohm termination. The measurement conditions are: substrate – Rogers RO3003; substrate dielectric constant = 3.00; substrate thickness (mils) = 23; gap in microstrip trace (mils) = 23.6; microstrip trace width (mils) = 57.1; Reference planes at sample edges.



0805N (0.080" x 0.050")



#### **First Series Resonance**



#### **Definitions and Measurement Conditions**

The First Series Resonance, FSR, is defined as the lowest frequency at which the imaginary part of the input impedance, Im[Zin], equals zero. Should Im[Zin] or the real part of the input impedance, Re[Zin], not be monotonic with frequency at frequencies lower than those at which Im[Zin] =0, the FSR shall be considered as undefined (represented as a gap in the plot). FSR is dependent on internal substrate thickness and dielectric constant; capacitor orientation, as defined capacitor structure; alongside the FPR plot; and mounting pad dimensions.

The definitions on the charts are for a capacitor in a series configuration, i.e., mounted across a gap in a microstrip trace with 50-Ohm termination. The measurement conditions are: substrate – Rogers RO3003; substrate dielectric constant = 3.00; substrate thickness (mils) = 23; gap in microstrip trace (mils) = 23.6; microstrip trace width (mils) = 57.1; Reference planes at sample edges.

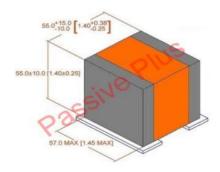
All data has been derived from electrical models created by Modelithics, Inc., a specialty vendor contracted by PPI. The models are derived from measurements on a large number of parts disposed on several different substrates.





#### **Capacitor Application Program**

PPI's brand new online Capacitor Application Program (C.A.P.) helps Engineers and Designers select capacitors according to parameters such as cap value and frequency. C.A.P. allows engineers to insert capacitors requirements (Cap value, Frequency), producing Scattering Matrices (S2P) Charts while providing options (Case Size, Terminations, Mounting), and parameters (ESR, Q, Impedance) along with Datasheets. Once engineers have determined their capacitor requirements, C.A.P. also includes online Requests For Quotes (RFQs) and/or sample requests.



## **Modelithics Vendor Program**

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Microwave Global Models include every part value in a series and permit users to input substrate thickness, dielectric constant, and loss tangent, as well as mounting pad layout dimensions. Selected models also include capacitor orientation – vertical or horizontal – as an input. Engineers can request FREE use of the models by visiting the https://www.modelithics.com/MVP/PPI.

### ##Modelithics®

#### **Recommended Land Pattern Dimensions**

Regarding Landing Patterns, please refer to IPC-7351B (table 3-5, 3-6).



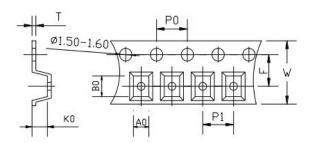


## 0805N (0.080" x 0.050"

#### Tape & Reel Specifications Dimensions: mm

Orientation	Measurement Unit	W	P0	P1	T	F	Minimum Qty per Reel	Std Qty per Reel	Tape Material
Н	in.	0.315	0.157	0.157	0.009	0.138	500	3000	Plastic
	mm	8.00	4.00	4.00	0.22	3.50	300	3000	Tiastic
V	in.	0.315	0.157	0.157	0.009	0.138	500	1000	Plastic
V	mm	8.00	4.00	4.00	0.22	3.50	300	1000	riastic





#### $A_0B_0K_0$

- Determined by component size. Typical clearance between the cavity and the component is: .50 (.002) min to .65 (.026) max for 12mm tape.
- The component cannot rotate more than 20° within the determined cavity.

### **Engineering Design Kits**

PPI offers Design Kits for engineers who are building and testing prototypes. Each kit contains 16 values;10 pieces per value.

Kits are 100% RoHS compliant.

Kit Number	Value Range	Values
DKD0805N01	0.1 - 2.0pF	0.1, 0.2, 0.3, 0.4, 0.5, 0.6, 0.7, 0.8, 0.9, 1.0, 1.2, 1.5, 1.6, 1.8, 2.0pF
DKD0805N02	1.0 - 10pF	1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7, 3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2, 10pF



DKD0805N04

DKD0805N03

10 - 220pF

10 - 100 pF

10, 15, 18, 20, 24, 27, 30, 39, 47, 56, 68, 82, 100, 120, 150, 180, 220pF

10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 82, 100pF















#### **Product Features**

- High Q
- High Power
- Low ESR/ESL
- Low Noise
- High Self-Resonance
- Ultra Stable Performance
- Capacitance Range: 0.2pF to 1000pF
- Working Voltage: 500V

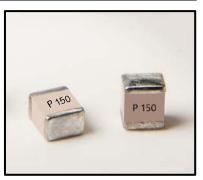
#### **Product Applications**

#### **Typical Functional Applications:**

- Tuning Bypass Coupling
- Feedback D.C. Blocking
- Impedance Matching

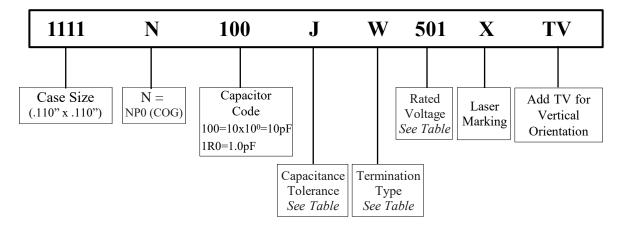
#### **Typical Circuit Applications:**

- UHF/Microwave RF Power Amplifiers
- Mixers Oscillators Filter Networks
- Low Noise Amplifiers Timing Circuits and Delay Lines



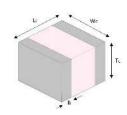
Marking shown for illustration purposes only. Actual marking may differ.

## **Part Numbering**



# Capacitor Dimensions Unit: incn (mm)

C	ode	Le	ngth	Width	Thickness	Overlap
		-	Lc	Wc	Tc	В
W	Chin	0.11	+0.020 -0.010	$0.110 \pm 0.015$	0.10 max	0.015 max
VV	Chip	(2.79	+0.51 -0.25 )	$(2.79 \pm 0.38)$	(2.60 max)	(0.025 max)



## **Capacitance Tolerance Codes**

Code	A	В	C	D	F	G	J	K
Tol.	±0.05pF	±0.1pF	±0.25pF	±0.5pF	±1%	±2%	±5%	±10%



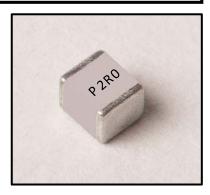


## **†** Terminations Types and Codes

Terminati Code	on	Termination
W	RoHS	100% Tin Solder over Nickel Barrier
L		90%Tin/10%Lead Solder over Nickel Barrier

## **≠** Voltage Code

Voltage	Code
100V	101
200V	201
500V	501
1000V	102



Marking shown for illustration purposes only. Actual marking may differ.

## † 1111N Capacitance Values

For special capacitances, tolerances and WVDC, please contact PPI.

Cap.	Сар		Rated	WVDC	Cap.	Сар		Rated	WVDC	Cap.	Сар		Rated	WVDC	Cap.	Сар		Rated	WVDC
pF	Code	Tol.	Std.	Ext.	pF	Code	Tol.	Std.	Ext.	pF	Code	Tol.	Std.	Ext.	pF	Code	Tol.	Std.	Ext.
0.2	OR2				2.7	2R7				22	220				180	181	F,G,	500V	1000V
0.3	OR3				3.0	3R0				24	240				200	201	J,K	3004	10000
0.4	OR4				3.3	3R3				27	270				220	221			
0.5	OR5				3.6	3R6	A,B, C,D	500V	1000V	30	300				240	241			
0.6	OR6				3.9	3R9	С,В			33	330				270	271			
0.7	0R7				4.3	4R3				36	360				300	301	F,G, J,K	200V	500V
0.8	OR8				4.7	4R7				39	390				330	331	3,10		
0.9	OR9				5.1	5R1				43	430				360	361			
1.0	1R0				5.6	5R6				47	470				390	391			
1.1	1R1				6.2	6R2				51	510				430	431	G,J,	200V	F00\/
1.2	1R2	A,B,	E00\/	1000\/	6.8	6R8	B,C, D	500V	1000V	56	560	F,G,	500V	1000\/	470	471	K	200V	500V
1.3	1R3	C,D	500V	1000V	7.5	7R5	D			62	620	J,K	500V	1000V	510	511			
1.4	1R4				8.2	8R2				68	680				560	561	G,J, K	100V	500V
1.5	1R5				9.1	9R1				75	750				620	621	K		
1.6	1R6				10	100				82	820				680	681			
1.7	1R7				11	110				91	910				750	751			
1.8	1R8				12	120				100	101				820	821	G,J, K	50V	N/A
1.9	1R9				13	130	F,G,	5001	40001	110	111				910	911	K		
2.0	2R0				15	150	J,K	500V	1000V	120	121				1000	102			
2.1	2R1				16	160				130	131								
2.2	2R2				18	180				150	151								
2.4	2R4				20	200				160	161								



## **#** Electrical Specifications

Quality Factor (Q)	2,000 at 1 MHz min.
Insulation Resistance (IR)	10 <sup>5</sup> Megaohms min. @ +25°C rated WVDC 10 <sup>4</sup> Megaohms min. @ +125°C rated WVDC
Rated Voltage	See Rated Voltage Table
Dielectric Withstanding Voltage (WVDC)	250% of Rated Voltage of 5 seconds, Rated Voltage ≤ 500VDC 150% of Voltage for 5 seconds, 500VDC <rated 1250="" vdc<br="" voltage="" ≤="">120% of Voltage for 5 seconds, Rated Voltage &gt; 1250 VDC</rated>
Operating Temperature Range	-55°C to 175°C
Temperature Coefficient (TC)	0±30ppm/°C
Capacitance Drift	$\pm 0.02\%$ or $\pm 0.02$ pF, whichever is greater
Piezoelectric Effects	None

## **÷** Environmental Specifications

#### **Specification** Test Parameters

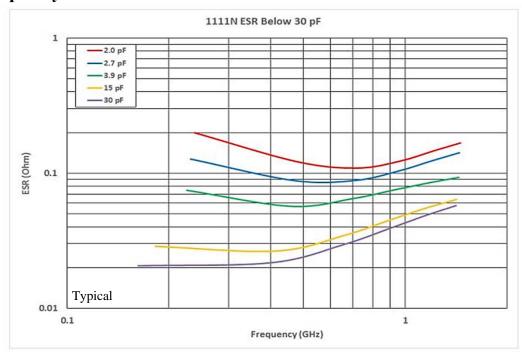
Thermal Shock  Moisture Resistance	No mechanical damage  Capacitance Change: ±0.5% or 0.5pF max  IR: >1 G Ohms  Q>500  Breakdown Voltage: 2.5x WVDC	MIL-STD-202, Method 107, Condition A. At the maximum rated temperature (-55°C and 175°C) stay 30 minutes, the time of removing shall not be more than 3 minutes. Perform five cycles.  MIL-STD-202, Method 106
Humidity (Steady State)	No mechanical damage  Capacitance Change: ±0.5% or 0.5pF max  IR: >1 G Ohms  Q>300  Breakdown Voltage: 2.5x WVDC	MIL-STD-202, Method 103, Condition A With 1.5Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours minimum.
Life	No mechanical damage  Capacitance Change: ±2.0% or 0.5pF max  IR: >1 G Ohms  Q>500  Breakdown Voltage: 2.5x WVDC	MIL-STD-202, Method 108. For 1000 hours, at 175°C. 200% of Voltage for Capacitors, Rated Voltage ≤ 500VDC; 120% of Voltage for Capacitors, 500VDC< Rated Voltage ≤1250VDC; 100% for Voltage for Capacitors, Rated Voltage >1250VDC
Terminal Adhesion	Termination should not pull off. Ceramic should remain undamaged	Linear pull force exerted on axial leads soldered to each terminal. 2.0lbs.
Resistance to Soldering Heat	No mechanical damage  Capacitance Change: -1.0%~+2.0  IR: >1 G Ohms  Q>500  Breakdown Voltage: 2.5x WVDC	Preheat device to 150°C -180°C for 60 seconds.  Dip in 260°C ±5C solder for 10 ±1 second.  Measure after 24± 2 hour cooling period.

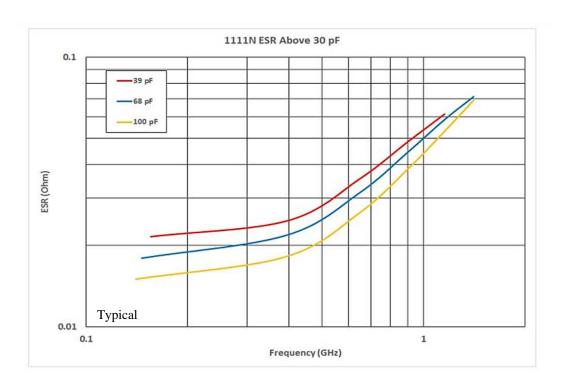
Capacitors are designed and manufactured to meet the requirements of MIL-PRF-55681 and MIL-PRF-123.





## **≠** ESR vs. Frequency

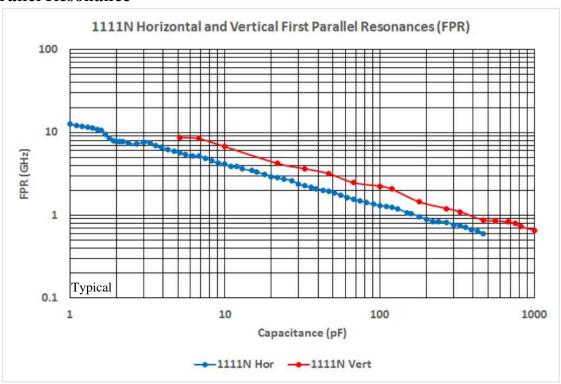








#### **First Parallel Resonance**



#### **Definitions** and Measurement Conditions

The **First Parallel Resonance**, **FPR**, is defined as the lowest frequency at which a suckout or notch appears in |S21|. It is generally independent of substrate thickness or dielectric constant, but does depend on capacitor orientation. A horizontal orientation means the capacitor electrode planes are parallel to the plane of the substrate; a vertical orientation means the electrode planes are perpendicular to the substrate.

The definitions on the carts are for a capacitor in a series configuration, i.e., mounted across a gap in a microstrip trace with a 50-Ohm termination. The measurement conditions are: substrate – Rogers RO4350; substrate dielectric constant = 3.48; horizontal mount substrate thickness (mils) = 55; vertical mount substrate thickness (mils) = 45; gap in microstrip trace (mils) = 61.1; horizontal mount microstrip trace width (mils) = 123.7; vertical mount microstrip trace width (mils) = 101.0. Reference planes at sample edges.

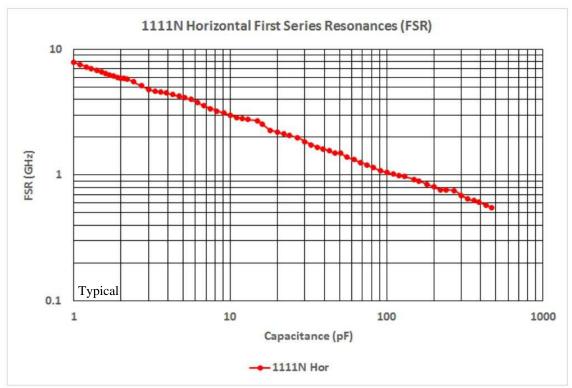
All data has been derived from electrical models created by Modelithics, Inc., a specialty vendor contracted by PPI. The models are derived from measurements on a large number of parts disposed on several different substrates.





1111N (0.110" x 0.11<u>0"</u>)

#### **First Series Resonance**



#### **Definitions and Measurement Conditions**

The **First Series Resonance**, **FSR**, is defined as the lowest frequency at which the imaginary part of the input impedance, Im[Zin], equals zero. Should Im[Zin] or the real part of the input impedance, Re[Zin], not be monotonic with frequency at frequencies lower than those at which Im[Zin] =0, the FSR shall be considered as undefined (represented as a gap in the plot). FSR is dependent on internal capacitor structure; substrate thickness and dielectric constant; capacitor orientation, as defined alongside the FPR plot; and mounting pad dimensions.

The definitions on the carts are for a capacitor in a series configuration, i.e., mounted across a gap in a microstrip trace with a 50-Ohm termination. The measurement conditions are: substrate – Rogers RO4350; substrate dielectric constant = 3.48; horizontal mount substrate thickness (mils) = 55; vertical mount substrate thickness (mils) = 45; gap in microstrip trace (mils) = 61.1; horizontal mount microstrip trace width (mils) = 123.7; vertical mount microstrip trace width (mils) = 101.0. Reference planes at sample edges.

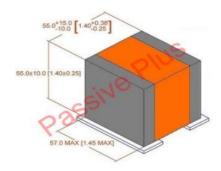
All data has been derived from electrical models created by Modelithics, Inc., a specialty vendor contracted by PPI. The models are derived from measurements on a large number of parts disposed on several different substrates.





#### **#** Capacitor Application Program

PPI's brand new online Capacitor Application Program (C.A.P.) helps Engineers and Designers select capacitors according to parameters such as cap value and frequency. C.A.P. allows engineers to insert capacitors requirements (Cap value, Frequency), producing Scattering Matrices (S2P) Charts while providing options (Case Size, Terminations, Mounting), and parameters (ESR, Q, Impedance) along with Datasheets. Once engineers have determined their capacitor requirements, C.A.P. also includes online Requests For Quotes (RFQs) and/or sample requests.



### **≠** Modelithics Vendor Program

PPI offers design engineers a Free 90-Day Trial license for the Modelithics PPI Component Library. This program provides engineers access to extremely accurate scalable simulation models for Passive Plus capacitors with advanced features that enable a more precise and rapid design process.

Microwave Global Models include every part value in a series and permit users to input substrate thickness, dielectric constant, and loss tangent, as well as mounting pad layout dimensions. Selected models also include capacitor orientation – vertical or horizontal – as an input. Engineers can request FREE use of the models by visiting the https://www.modelithics.com/MVP/PPI.



#### Recommended Land Pattern Dimensions

Regarding Landing Patterns, please refer to IPC-7351B (table 3-5, 3-6).

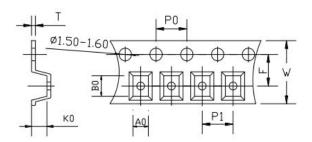




### **Tape & Reel Specifications**

Orientation	Measurement Unit	W	Р0	P1	T	F	Minimum Qty per Reel	Std Qty per Reel	Tape Material
Н	in.	0.315	0.157	0.157	0.010	0.138	500	2000	
	mm	8.00	4.00	4.00	0.25	3.50	300	2000	Plastic
V	in.	0.472	0.157	0.157	0.016	0.217	500	1500	1 lastic
v	mm	12.00	4.00	4.00	0.40	5.50	300	1300	





#### $A_0B_0K_0$

- Determined by component size. Typical clearance between the cavity and the component is: .50 (.002) min to .65 (.026) max for 12mm tape.
- The component cannot rotate more than 20° within the determined cavity.

#### **Engineering Design Kits**

PPI offers Design Kits for engineers who are building and testing prototypes. Each kit contains 16 values; 10 pieces per value.

Kits are 100% Ro	HS compliant.	
17:4 Nh	Value	
Kit Number	_	

Range

Values



DKD1111N01 <b>1.0 - 10pF</b>	1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7, 3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2, 10pF
------------------------------	---



DKD1111N02 10 - 100pF 10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 82, 100pF



DKD1111N03 100 - 1000pF 100, 120, 150, 180, 200, 220, 240, 270, 300, 330, 390, 470, 560, 680, 820, 1000pF

sales@passiveplus.com

PPI1111NDATA010324RevA





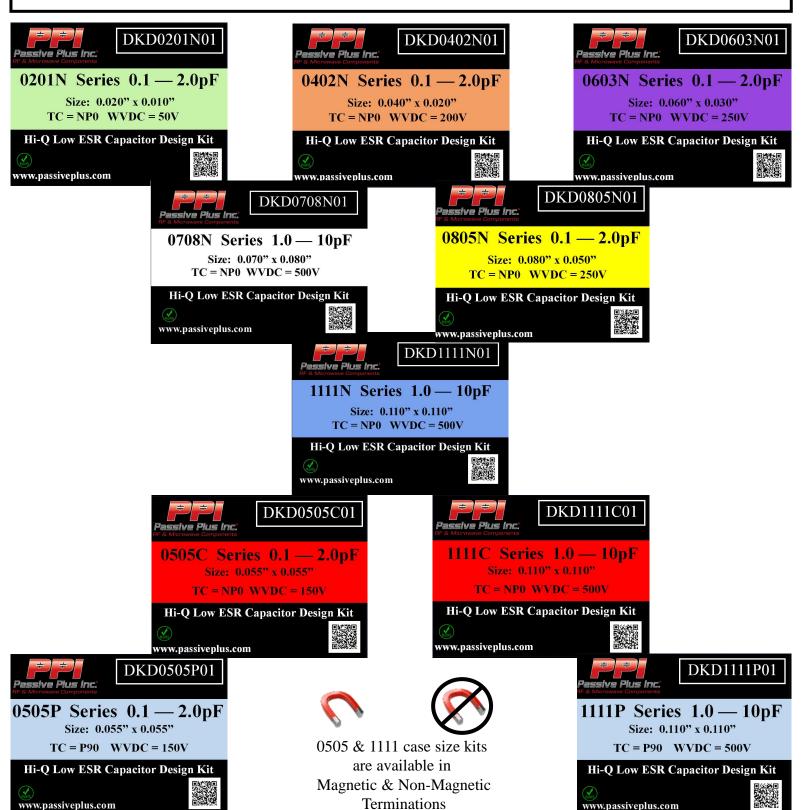








## **Standard Design Kits**





# **Standard Design Kits**

## **#** High Q Capacitor Design Kits

According to the customer's demand, PPI can provide many kinds of tool kits for engineers to design and debug the circuit. All of our products satisfy the requirement of RoHS instruction.



PPI also offers kits for Non-Magnetic MRI applications. Engineering design kits are also available in multiple sizes as well. All kits are RoHS Compliant.

Standard Values updated in 2022.

	Kit Number				Values				
Magnetic	Non-Magnetic	Range							
DKD0505C01	DKD0505C05	0.1 - 2.0pF	0.1, 0.2, 0.3, 0.4, 0.5, 0.6, 0.7, 0.8, 0.9, 1.0, 1.2, 1.5, 1.6, 1.8, 2.0pF						
DKD0505P01	DKD0505P05	011 210P1							
DKD0505C02	DKD0505C06	1 10mE	10 12 15 19 20 22 24 27 20 22 20 47 56 69 92 10mE						
DKD0505P02	DKD0505P06	1 - 10pF	1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7, 3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2, 10pF						
DKD0505C03	DKD0505C07	40 400 F	10 10 15 10 00 00 04 07 00 00 47 57 70 00 100 F						
DKD0505P03	DKD0505P07	10 - 100pF	10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 82, 100pF						
DKD0505C04	DKD0505C08	100 - 1000pF	100, 120, 150, 180, 200, 220, 240, 270, 300, 330, 390, 470, 560, 680, 820, 1000pF						
DKD1111C01	DKD1111C05								
		1.0 - 10pF	1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7, 3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2, 10pF						
DKD1111P01	DKD1111P05								
DKD1111C02	DKD1111C06	10 - 100pF	10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 82, 100pF						
DKD1111P02	DKD1111P06								
DKD1111C03	DKD1111C07	100 - 1000pF							
DKD1111P03	DKD1111P07	100 - 1000pr	100, 120, 150, 180, 200, 220, 240, 270, 300, 330, 390, 470, 560, 680, 820, 1000pF						
DKD1111C04	DKD1111C08	1000 10000-E	1000, 1100, 1200, 1500, 1800, 2000, 2200, 2700, 3000, 3300, 3900, 4700, 5100,						
DKD1111P04	DKD1111P08	1000 - 10000pF	5600, 10000pF						



# **Standard Design Kits**

## **=** EIA Low ESR Design Kits

Kit Number	Value Range	Values
DKD0201N01	0.1 - 2.0pF	0.1, 0.2, 0.3, 0.5, 0.7, 0.8, 0.9, 1.0, 1.3, 1.5, 1.7, 1.9, 2.0pF
DKD0201N02	1.0 - 10pF	1.0, 1.3, 1.5, 1.7, 1.9, 2.0, 2.2, 2.7, 3.0, 3.9, 4.7, 5.6, 6.8, 7.5, 8.2, 10pF
DKD0201N03	10 - 47pF	10, 13, 15, 18, 20, 22, 27, 30, 39, 47pF
DKD0402N01	0.1 - 2.0pF	0.1, 0.2, 0.3, 0.4, 0.5, 0.6, 0.7, 0.8, 0.9, 1.0, 1.2, 1.5, 1.6, 1.8, 2.0pF
DKD0402N02	1.0 - 10pF	1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7, 3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2, 10pF
DKD0402N03	10 - 33pF	10, 12, 13, 15, 16, 18, 20, 22, 24, 27, 30, 33pF
DKD0603N01	0.1 - 2.0pF	0.1, 0.2, 0.3, 0.4, 0.5, 0.6, 0.7, 0.8, 0.9, 1.0, 1.1, 1.2, 1.5, 1.6, 1.8, 2.0pF
DKD0603N02	1.0 - 10pF	1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7, 3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2, 10pF
DKD0603N03	10 - 100pF	10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 100pF
DKD0708N01	1.0 - 10pF	1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7, 3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2, 10pF
DKD0708N02	10 - 100pF	10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 82, 100pF
DKD0805N01	0.1 - 2.0pF	0.1, 0.2, 0.3, 0.4, 0.5, 0.6, 0.7, 0.8, 0.9, 1.0, 1.2, 1.5, 1.6, 1.8, 2.0pF
DKD0805N02	1.0 - 10pF	1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7, 3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2, 10pF
DKD0805N03	10 - 100pF	10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 82, 100pF
DKD0805N04	10 - 220pF	10, 15, 18, 20, 24, 27, 30, 39, 47, 56, 68, 82, 100, 120, 150, 180, 220pF
DKD1111N01	1.0 - 10pF	1.0, 1.2, 1.5, 1.8, 2.0, 2.2, 2.4, 2.7, 3.0, 3.3, 3.9, 4.7, 5.6, 6.8, 8.2, 10pF
DKD1111N02	10 - 100pF	10, 12, 15, 18, 20, 22, 24, 27, 30, 33, 39, 47, 56, 68, 82, 100pF
DKD1111N03	100 - 1000pF	100, 120, 150, 180, 200, 220, 240, 270, 300, 330, 390, 470, 560, 680, 820, 1000pF







#### Custom Kits

According to the customer's demand, PPI can provide many kinds of tool kits for engineers to design and debug the circuit. All our products satisfy the requirement of RoHS instruction.

Passive Plus will develop a custom kit using the engineer's specific requirements for the engineer's projects (case size, temperature coefficient, value range, tolerances, voltages, and quantities per value). Once these requirements are determined, PPI will then provide customer with a price. Please contact PPI directly to start this process.

All kits are RoHS Compliant.











# **Custom Kits**















# 0505X (0.055" x 0.055")

#### **Product Features**

- High Q
- High Power
- Low ESR/ESL
- Low Noise
- High Self-Resonance
- Ultra Stable Performance
- Capacitance Range: 470pF to 10000pF
- Working Voltage: 50V

### **†** Product Applications

#### **Typical Functional Applications:**

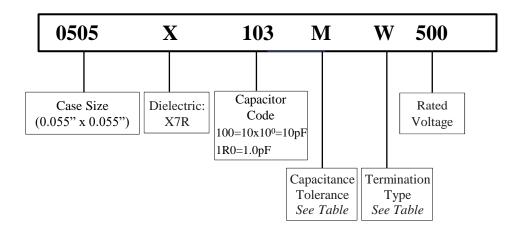
- Tuning Bypass Coupling
- Feedback D.C. Blocking
- Impedance Matching

#### **Typical Circuit Applications:**

- UHF/Microwave RF Power Amplifiers
- Mixers Oscillators Filter Networks
- Low Noise Amplifiers Timing Circuits and Delay Lines

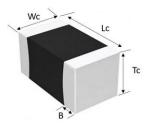


### Part Numbering



# **Capacitor Dimensions** Unit: inch (mm)

Le	ngth	Width	Thickness	Overlap
	Lc Wc T		Tc	В
0.055	+0.015 -0.010	$0.055 \pm 0.010$	0.057	$0.014 \pm 0.006$
(1.40	+0.38 -0.25 )	$(1.40 \pm 0.25)$	(1.45 max)	$(0.356 \pm 0.152)$







0505X (0.055" x 0.055")

## **‡** Capacitance Tolerance Codes

Code	K	M
Tol.	±10%	±20%

## **†** Termination Types

Termination Cod	le Termination
W	100% Tin Solder over Nickel Barrier
L	90%Tin/10%Lead Solder over Nickel Barrier
P (Non-Magnetic)	Solder over Copper Barrier
С	100% Silver Solder over Palladium Barrier

Note: "Non-Magnetic" means no magnetic materials.

## **≠** 0505X Capacitance Values

Special capacitances, tolerances and WVDC are available. Please contact PPI.

Cap. pF	Cap Code	Tol.	Rated WVDC	Cap. pF	Cap Code	Tol.	Rated WVDC	Cap. pF	Cap Code	Tol.	Rated WVDC
470	471			1500	152			4700	472		
560	561			1800	182			5000	502		
680	681	K,M	50V	2200	222	K,M	50V	5600	562	K,M	50V
820	821	19.71	301	2700	272	1,9.11		6800	682	,	30.
1000	102			3300	332			8200	822		
1200	122			3900	392			10000	103		





0505X (0.055" x 0.055")

## **#** Electrical Specifications

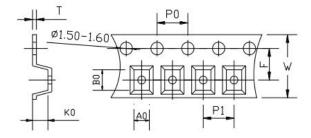
Operating Temperature Range	-55°C to +125°C
Insulation Resistance (IR)	Insulation Resistance @ $+25^{\circ}C > 1000\Omega F$ Insulation Resistance @ $+125^{\circ}C > 100\Omega F$
Temperature Voltage Coefficient	+15/-25% ΔC (-55°C to +125°C)
Dielectric Withstanding Voltage (DWV)	2.5x WVDC, 5 seconds
Max Dissipation Factor	0.025 (2.5%) max
Test Parameters	1kHz, 1.0 VRMS, 25°C

### **‡** Recommended Land Pattern Dimensions

Regarding Landing Patterns, please refer to IPC-7351B (table 3-5, 3-6).

## **‡** Tape & Reel Specifications

Orientation	Measurement Unit	W	Р0	P1	Т	F	Min. Qty per Reel	Std. Qty per Reel	Tape Material
ш	in.	0.32	0.16	0.16	0.01	0.14	500	4000	Dlastic
Н	mm	8.00	4.00	4.00	0.30	3.50	300	4000	Plastic



#### $\mathrm{A}_0\mathrm{B}_0\mathrm{K}_0$

- $\bullet$  Determined by component size. Typical clearance between the cavity and the component is: .50 (.002) min to .65 (.026) max for 12mm tape.
- $\bullet$  The component cannot rotate more than  $20^\circ$  within the determined cavity.





#### **†** Product Features

- High Q
- High Power
- Low ESR/ESL
- Low Noise
- High Self-Resonance
- Ultra Stable Performance
- Capacitance Range: 470pF to 10nF
- Working Voltage: 50V

#### **†** Product Applications

#### **Typical Functional Applications:**

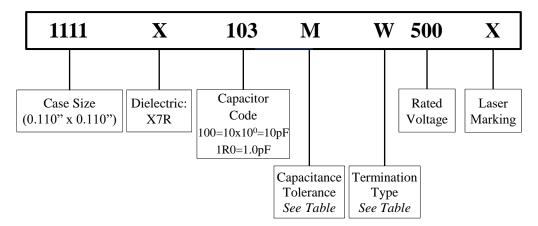
- Tuning Bypass Coupling
- Feedback D.C. Blocking
- Impedance Matching

#### **Typical Circuit Applications:**

- UHF/Microwave RF Power Amplifiers
- Mixers Oscillators Filter Networks
- Low Noise Amplifiers Timing Circuits and Delay Lines

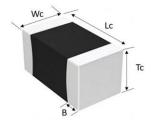


## **#** Part Numbering



# **‡** Capacitor Dimensions Unit: inch (mm)

Length		Width	Thickness	Overlap
	Lc	Wc	Tc	В
0.11	+0.025 -0.010	$0.110 \pm 0.015$	0.102 max	$0.020 \pm 0.010$
(2.79	+0.64 -0.25 )	$(2.79 \pm 0.38)$	(2.59 max)	$(0.508 \pm 0.250)$







## **÷** Capacitance Tolerance Codes

## **‡** Termination Types

Code	K	M
Tol.	±10%	±20%

Termination Code	Termination
W	100% Tin Solder over Nickel Barrier
L	90%Tin/10%Lead Solder over Nickel Barrier
P (Non-Magnetic)	100% Tin Solder over Copper Barrier
C	100% Silver Solder over Palladium Barrier

Note: "Non-Magnetic" means no magnetic materials.

## **≠** 1111X Capacitance Values

Special capacitances, tolerances and WVDC are available. Please contact PPI.

Cap. pF	Cap Code	Tol.	Rated WVDC	Cap. pF	Cap Code	Tol.	Rated WVDC	Cap. pF	Cap Code	Tol.	Rated WVDC	
4700	472			15000	153			47000	473			
5600	562			18000	183			50000	503			
6800	682	K,M	50V	22000	223	K,M	50V	56000	563	K,M	50V	
8200	822	K)IVI	19.17.		27000	273	10,101	301	68000	683	10,101	
10000	103			33000	333			82000	823			
12000	123			39000	393			100000	104			





## **Electrical Specifications**

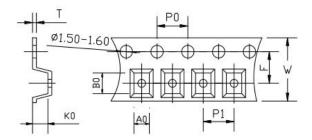
Operating Temperature Range	-55°C to +125°C
Insulation Resistance (IR)	Insulation Resistance @ $+25^{\circ}C > 1000\Omega F$ Insulation Resistance @ $+125^{\circ}C > 100\Omega F$
Temperature Voltage Coefficient	+15/-25% ΔC (-55°C to +125°C)
Dielectric Withstanding Voltage (DWV)	2.5x WVDC, 5 seconds
Max Dissipation Factor	0.025 (2.5%) max
Test Parameters	1kHz, 1.0 VRMS, 25°C

#### **Recommended Land Pattern Dimensions**

Regarding Landing Patterns, please refer to IPC-7351B (table 3-5, 3-6).

### **Tape & Reel Specifications (mm)**

Orientation	Measurement Unit	W	Р0	P1	T	F	Min. Qty per Reel	Std. Qty per Reel	Tape Material
11	in.	0.32	0.16	0.16	0.01	0.14	500	2000	Dlastic
Н	mm	8.00	4.00	4.00	0.30	3.50	500	2000	Plastic



#### $A_0B_0K_0$

- Determined by component size. Typical clearance between the cavity and the component is: .50 (.002) min to .65 (.026) max for 12mm tape.
- The component cannot rotate more than 20° within the determined cavity.





# 2225X (0.220" x 0.250")

#### Product Features

- High Q
- High RF Current/Voltage
- Ultra Stable Performance
- Capacitance Range: 10nF to 1µF
- Working Voltage: 300V

## **÷** Product Applications

#### **Typical Functional Applications:**

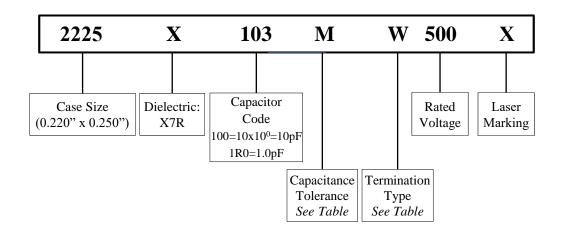
- Tuning Bypass Coupling
- D.C. Blocking Impedance Matching

#### **Typical Circuit Applications**

- UHF/Microwave RF Power Amplifiers
- Antenna Tuning Plasma Chambers
- Medical Equipment

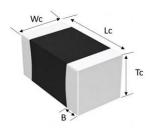


### **#** Part Numbering



# **†** Capacitor Dimensions Unit: inch (mm)

Length		Width	Thickness	Overlap	
Lc		Wc	Tc	В	
0.230	+0.020 -0.012	$0.250 \pm 0.015$	0.165 max	$0.030 \pm 0.015$	
(5.84	+0.51 -0.30 )	$(6.35 \pm 0.38)$	(4.19 max)	$(0.762 \pm 0.380)$	







2225X (0.220" x 0.250")

### **‡** Capacitance Tolerance Codes

## **‡** Termination Types

Code	K	M
Tol.	±10%	±20%

## **≠** Voltage Codes

Voltage	Code
100V	101
150V	151
200V	201
250V	251
300V	301

<b>Termination Code</b>	Termination
W	100% Tin Solder over Nickel Barrier
L	90%Tin/10%Lead Solder over Nickel Barrier
P (Non-Magnetic)	100% Tin Solder over Copper Barrier
С	100% Silver Solder over Palladium Barrier

Note: "Non-Magnetic" means no magnetic materials.

## **≠** 2225X Capacitance Values

Special capacitances, tolerances and WVDC are available. Please contact PPI.

Cap. uF	Cap Code	Tol.	Rated WVDC	Cap. uF	Cap Code	Tol.	Rated WVDC	Cap. uF	Cap Code	Tol.	Rated WVDC
0.010	103			0.082	823			0.560	564	K,M	150V
0.012	123	K,M	300V	0.100	104			0.680	684	17,171	1501
0.015	153	1,101	3000	0.120	124	K,M	200V	0.820	824	K,M	100V
0.022	223			0.150	154			1.000	105	13,141	1001
0.033	333			0.220	224						
0.047	473	K,M	250V	0.330	334	K,M	150V				
0.068	683			0.470	474	13,101	1300				





2225X (0.220" x 0.250")

## **#** Electrical Specifications

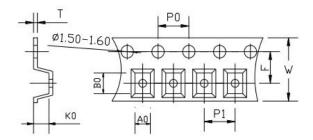
Operating Temperature Range	-55°C to +125°C				
Insulation Resistance (IR)	Insulation Resistance @ $+25^{\circ}C > 1000\Omega F$ Insulation Resistance @ $+125^{\circ}C > 100\Omega F$				
Temperature Voltage Coefficient	± 15% Maximum				
Dielectric Withstanding Voltage (DWV)	2.5x WVDC, 5 seconds				
Max Dissipation Factor	0.025 (2.5%) max				
Test Parameters	1kHz, 1.0 VRMS, 25°C				

#### **‡** Recommended Land Pattern Dimensions

Regarding Landing Patterns, please refer to IPC-7351B (table 3-5, 3-6).

## **≠** Tape & Reel Specifications (mm)

Orientation	Measurement Unit	W	Р0	P1	T	F	Min. Qty per Reel	Std. Qty per Reel	Tape Material
ш	in.	0.47	0.16	0.16	0.02	0.22	500	4000	Dlagtic
Н	mm	12.00	4.00	4.00	0.40	5.50	300	4000	Plastic



#### $A_0B_0K_0$

- Determined by component size. Typical clearance between the cavity and the component is: .50 (.002) min to .65 (.026) max for 12mm tape.
- The component cannot rotate more than 20° within the determined cavity.





#### **+** Hand Soldering Chip Capacitors

Among the most common reasons multilayer ceramic chip capacitors (MLCCs) fail is improper hand soldering to printed circuit boards. Typically, one or more hairline cracks develop in the ceramic, defects that may even have an imperceptible effect on initial performance, but that manifest with time, circuit board flexure, or temperature excursions. Herein are a few tips, suggestions, and caveats to be aware of in performing a reliable hand soldering attachment.

**Solders**. Before selecting a solder, one should know the metallization on the chip. Starting at the component ceramic surface from which the electrodes protrude (typically < 1 mil), a contacting "termination" is applied that most often contains silver (Ag) or nickel (Ni). Over this is plated a barrier metal, typically nickel or copper (for non-magnetic applications), followed by a finishing metallization of tin (Sn) or lead (Pb)-tin. Other finishes may include palladium- silver (Pd/Ag), Ag, or gold (Au).

For finishes that include Ag, a silver bearing solder such as Sn62 is recommended to combat leaching of the component's silver into the solder joint. Silver bearing solders also improve resistance to thermal fatigue. For finishes that include Au, a solder such as In50 is suggested to avoid gold scavenging that may cause embrittlement (which occurs when gold comprises approximately 3% or greater by weight of the solder joint). For finishes that do not contain noble metals, SN63 is often used, or Sn95.5 or Sn96 where there is a no-lead, e.g. ROHS, requirement.

<u>Fluxes</u>. An appropriate flux helps to clean the surfaces to be soldered and facilitates solder spread; it may also remove oxidation. Check with the solder manufacturer for a recommended flux. Rosin based fluxes are most common but require post solder cleaning.

Fluxes are available both separately as pastes and as internal cores within wire solder. Each form has advantages and disadvantages. Use of an external flux permits precise placement in exact quantities, but consideration must be given to the activation temperature of the flux, which will be lower than that of the solder liquidus, and the time spent at this temperature. Too long at the latter will result in boiling off the flux and reducing its effectiveness. Flux core solder is easy and convenient to use but may require more solder than desirable to have sufficient flux for good coverage.

In practice, external flux seems to work best for parts of size 0603 or 0505 and below, while flux core solder appears satisfactory for larger component sizes.

<u>Soldering iron</u>. A temperature-controlled iron of suitable wattage is strongly recommended. The iron temperature should typically be set 20-30°C above the solder liquidus temperature. Tip size is important; it should be about the same size as the part. Too small a tip (corresponding to an iron of insufficient wattage) will take too long to heat the printed circuit board land and part, while too large a tip (too high a wattage iron) may damage the board or component.





### **÷** Soldering Procedure

The initial consideration is which end of the capacitor to solder first. The choice can generally be decided by recognizing that it is desirable to minimize the heat flowing directly through the component. Thus, it is best to start from the end that has the poorest heat conduction (equals highest thermal resistance) to a heat sink. (Were one to start from the opposite end, a good heat path would have been <u>created</u> through the capacitor to the heat sink when one soldered the second joint.) If it is not apparent which land has the poorer connection to a heat sink, begin with the one having the smallest area.

#### Follow these steps in soldering:

- 1. Pre-heat the substrate. Where possible, it is very desirable to gradually pre-heat the substrate, e.g. on a hotplate, to about 30°C below the solder liquidus temperature. Two steps are usually sufficient: Start the hotplate at a temperature about halfway to the desired pre-heat temperature, place the board on it and wait till the board temperature stabilizes, then increase the hotplate temperature to the desired final pre-heat value.
- <u>2. Pre-" tin" the traces</u>. Select one of the PC board lands and clean it with isopropyl alcohol. If the solder you are using does not contain its own flux, place a small quantity of flux on the land, and a small amount of solder into the flux. (A razor may be used to cut a tiny custom preform from solid wire.) Place the iron on the printed circuit trace adjacent to the flux (but not touching) and heat the land until the solder melts into a flat, shallow pool. Remove the iron, then clean off any remaining flux with isopropyl alcohol. Repeat the procedure for the second land, then add fresh flux and a fresh solder preform (if not using flux-core solder) to each tinned land. (The preform should have sufficient mass to create a proper fillet see step 5 on the component.)
- 3. Pick up the component with either a hand tweezer or vacuum tweezer. (Stainless steel or ceramic- tipped tweezers are preferred.)
- 4. Place the component so that it straddles the circuit board lands, and make sure it lies flat on the board. As shown in **Fig. 1**, **Do not touch the component directly with the soldering iron**. Rather, touch the iron to the land adjacent to the capacitor until the solder begins to flow; then move the iron slowly toward the component.





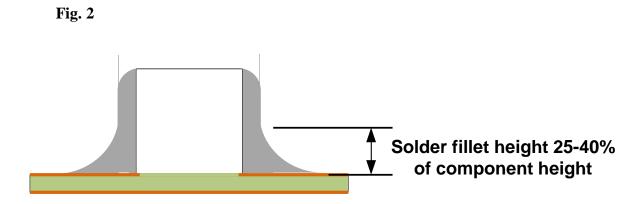
RECOMMENDED

soldering iron

PC board

PC board

- 5. When a fillet forms, remove the iron. As shown in **Fig. 2**, solder fillets should occupy about 25-40% of the component's height, have a concave profile, and be free of peaks and voids.
- 6. Repeat steps 1-5 for the second joint, then let the board cool gradually to room temperature. Use isopropyl alcohol to remove any residual flux from each joint.







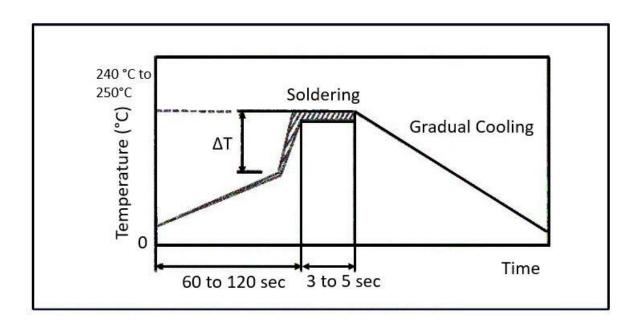
## **#** Wave Soldering

When sudden heat is applied to the elements, the mechanical strength of the components should decrease because remarkable temperature change can cause deformity of components inside. Also, long soldering time or high soldering temperatures, result in leaching by the external electrodes, causing poor adhesion or a reduction in capacitance value due to loss of contact between electrodes and end termination.

In order to avoid mechanical damage in the elements, preheating should be requested for both of the components and the PCB board. Preheating conditions are given in the table below. It is requested to keep the temperature gap between the soldering and the elements surface (.T) as small as possible.

When elements are submerged in solvent after mounting, be sure to maintain the temperature gas (.T) between the element and solvent within the range shown in the table below.

Do not apply the flow soldering to capacitors not listed in the table below.



Chip Capacitor	01005/0201/0402/0603/0505/0805	
Preheating	ΔT≤150°C	

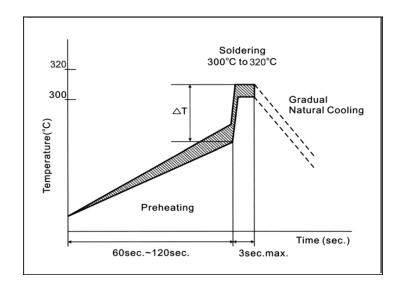
PPI does not recommend flow soldering for its 1111P/1111C, 2225P/2225C, 3838P/3838C.





## Soldering Iron

When sudden heat is given to the elements by soldering iron, the mechanical strength of the components should weaken because sharp temperature change can cause deformity of components inside. In order to avoid mechanical damage in the elements, preheating should be requested for both of the components and the PCB board. Preheating conditions are given in the below table. It is requested to keep the temperature gap between the soldering and the elements surface ( $\Delta T$ ) as small as possible. After the soldering, it should not be allowed to cool down suddenly.



Size	Soldering Iron	Temperature	Soldering Iron head Size	Solder		
0505/0805	70W Thermostat Iron	330°C				
1111		350°C		63Sn/37Pb, 95.5Sn/3.8Ag		
2225	70 W Thermostat non	370°C	17	/0.7Cu		
3838		370°C	15			

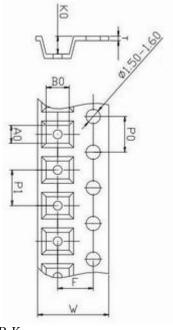




# **High-Q Low ESR Capacitors**

## **High-Q Low ESR Capacitor Tape & Reel Specifications**

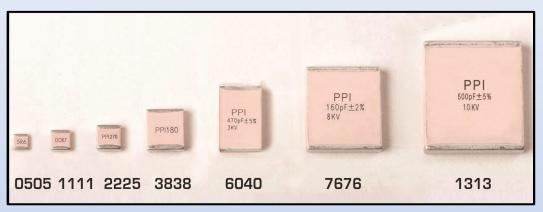
Case Size	Orientation	Measurement Unit	W	P0	P1	T	F	Minimum Qty per Reel	Std Qty per Reel	Tape Material
0201N	Н	in.	0.315	0.157	0.079	0.017	0.138	1000	15000	Paper
020111	11	mm	8.00	4.00	2.00	0.42	3.50	1000	13000	Tuper
0402N	Н	in.	0.315	0.157	0.079	0.003	0.138	1000	10000	Paper
0 10211		mm	8.00	4.00	2.00	0.07	3.50	1000	10000	Тарст
0603N	Н	in.	0.315	0.157	0.157		0.138	500	4000	Paper
		mm	8.00	4.00	4.00	0.10	3.50			
0708N	V	in.	0.472	0.157	0.157		0.217 500	1500	Plastic	
		mm	12.00	4.00	4.00	0.30	5.50			
	Н	in.		0.157	0.157			<del></del>	3000	Plastic
0805N		mm	8.00	4.00	4.00	0.22	3.50			
	V	in.	0.315	0.157	0.157		0.138	500	1000	Plastic
		mm	8.00	4.00	4.00	0.22	3.50			
	Н	ın.	0.315	0.157		0.010		500	2000	- Plastic
1111N ·		mm ·	8.00	4.00	4.00	0.25	3.50			
	V	in.	0.472	0.157	0.157	0.016		500	1500	
		mm	12.00	4.00	4.00	0.40	5.50			
	H V	in.		0.157			0.138	<del></del>	3000	
0505CP		mm ·	8.00	4.00	4.00	0.22	3.50			Plastic
		in.				0.012		500	2000	
		mm :	12.00	4.00	4.00	0.30	5.50			
	H	1n.		0.157 4.00	0.157 4.00	0.009	0.138 3.50	500	2000	
	V	in	8.00 0.315	0.157	0.157	0.22	0.138			i
1111CP		ın.	8.00	4.00	4.00	0.009	3.50	500	1500	Plastic
•		in.	0.472	0.157	0.157	0.22				
	V	mm	12.00	4.00	4.00	0.40	5.50	500	1500	
		in.		0.157						
	H	mm	16.00	4.00	12.00	0.30	7.50	500	500	Plastic
2225CP		in.		0.157						
	V	mm	16.00		8.00	0.50	7.50	300	300	Plastic
		in.		0.157		0.012				
3838CP	Н	mm		4.00	16.00	0.30	7.50	50	200	Plastic
	_	in.		0.157	0.157					
0505X	Н	mm	8.00	4.00	4.00	0.30	3.50	500	4000	Plastic
		in.	0.315	0.157		0.012				
1111X	Н	mm	8.00	4.00	4.00	0.30	3.50	500	2000	Plastic
		in.		0.157		0.016			_	
2225X	Н	mm		4.00	4.00	0.40	5.50	500	500	Plastic



#### $A_0B_0K_0$

- Determined by component size. Typical clearance between the cavity and the component is: .50 (.002) min to .65 (.026) max for 12mm tape.
- The component cannot rotate more than  $20^{\circ}$  within the determined cavity.





Marking shown for illustration purposes only. Actual marking may differ.





